

## 8-bit Microcontrollers

CMOS

# F<sup>2</sup>MC-8FX MB95120MB series

**MB95128MB/F124MB/F124NB/F124JB/F126MB/F126NB/  
MB95F126JB/F128MB/F128NB/F128JB/FV100D-103**

### ■ DESCRIPTION

The MB95120MB series is general-purpose, single-chip microcontrollers. In addition to a compact instruction set, the microcontrollers contain a variety of peripheral functions.

Note : F<sup>2</sup>MC is the abbreviation of FUJITSU Flexible Microcontroller.

### ■ FEATURE

- F<sup>2</sup>MC-8FX CPU core
  - Instruction set optimized for controllers
    - Multiplication and division instructions
    - 16-bit arithmetic operations
    - Bit test branch instruction
    - Bit manipulation instructions etc.
- Clock
  - Main clock
  - Main PLL clock
  - Sub clock
  - Sub PLL clock
- Timer
  - 8/16-bit compound timer × 2 channels
    - Can be used to interval timer, PWC timer, PWM timer and input capture.
  - 16-bit reload timer × 1 channel
  - 8/16-bit PPG × 2 channels
  - 16-bit PPG × 2 channels

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Be sure to refer to the "Check Sheet" for the latest cautions on development.

"Check Sheet" is seen at the following support page  
URL : <http://edevice.fujitsu.com/micom/en-support/>

"Check Sheet" lists the minimal requirement items to be checked to prevent problems beforehand in system development.

# MB95120MB Series

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- Timebase timer × 1 channel
- Watch prescaler × 1 channel
- LIN-UART × 1 channel
  - LIN function, clock asynchronous (UART) or clock synchronous (SIO) serial data transfer capable
  - Full duplex double buffer
- UART/SIO × 1 channel
  - Clock asynchronous (UART) or clock synchronous (SIO) serial data transfer capable
  - Full duplex double buffer
- I<sup>2</sup>C\* × 1 channel
  - Built-in wake-up function
- External interrupt × 12 channels
  - Interrupt by edge detection (rising, falling, or both edges can be selected)
  - Can be used to recover from low-power consumption (standby) modes.
- 8/10-bit A/D converter × 12 channels
  - 8-bit or 10-bit resolution can be selected
- LCD controller (LCDC)
  - 40 SEG × 4 COM (Max 160 pixels)
  - With blinking function
- Low-power consumption (standby) mode
  - Stop mode
  - Sleep mode
  - Watch mode
  - Timebase timer mode
- I/O port
  - The number of maximum ports : Max 87
  - Port configuration
    - General-purpose I/O ports (N-ch open drain) : 2 ports
    - General-purpose I/O ports (CMOS) : 85 ports
- Programmable input voltage levels of port  
Automotive input level / CMOS input level / hysteresis input level
- Dual operation Flash memory
  - Erase/write and read can be executed in the different bank (Upper Bank/Lower Bank) at the same time.
- Flash memory security function  
Protects the content of Flash memory (Flash memory device only)

\* : Purchase of Fujitsu I<sup>2</sup>C components conveys a license under the Philips I<sup>2</sup>C Patent Rights to use, these components in an I<sup>2</sup>C system provided that the system conforms to the I<sup>2</sup>C Standard Specification as defined by Philips.

# MB95120MB Series

## MEMORY LINEUP

|            | Flash memory | RAM       |
|------------|--------------|-----------|
| MB95F124MB | 16 Kbytes    | 512 bytes |
| MB95F124NB |              |           |
| MB95F124JB |              |           |
| MB95F126MB | 32 Kbytes    | 1 Kbyte   |
| MB95F126NB |              |           |
| MB95F126JB |              |           |
| MB95F128MB | 60 Kbytes    | 2 Kbytes  |
| MB95F128NB |              |           |
| MB95F128JB |              |           |



# MB95120MB Series

## ■ PRODUCT LINEUP

| Part number                          |   | MB95128MB   | MB95F124MB<br>MB95F126MB<br>MB95F128MB | MB95F124NB<br>MB95F126NB<br>MB95F128NB | MB95F124JB<br>MB95F126JB<br>MB95F128JB |
|--------------------------------------|---|---|--|--|--|
| Parameter                            |   |   |  |  |  |
| Type                                 |   | MASK ROM product  | Flash memory product                   |  |  |
| ROM capacity*1                       |   | 60 Kbytes (Max)   |  |  |  |
| RAM capacity*1                       |   | 2 Kbytes (Max)  |  |  |  |
| Reset output                         |   | Yes/No  | Yes                                    |  | No                                     |
| Option*2                             | Clock system                                | Dual clock  |  |  |  |
|                                      | Low voltage detection reset                 | Yes/No  | No                                     | Yes                                    |  |
|                                      | Clock supervisor                            | Yes/No  | No                                     |  | Yes                                    |
| CPU functions                        |   | Number of basic instructions : 136<br>Instruction bit length : 8 bits<br>Instruction length : 1 to 3 bytes<br>Data bit length : 1, 8, and 16 bits<br>Minimum instruction execution time : 61.5 ns (at machine clock frequency 16.25 MHz)<br>Interrupt processing time : 0.6 μs (at machine clock frequency 16.25 MHz)   |  |  |  |
| Peripheral functions                 | Ports (Max 87 ports)                        | General-purpose I/O port (N-ch open drain) : 2 ports<br>General-purpose I/O port (CMOS) : 85 ports<br>Programmable input voltage levels of port :<br>Automotive input level / CMOS input level / hysteresis input level   |  |  |  |
|                                      | Timebase timer (1 channel)                  | Interrupt cycle : 0.5 ms, 2.1 ms, 8.2 ms, 32.8 ms (at main oscillation clock 4 MHz)   |  |  |  |
|                                      | Watchdog timer                              | Reset generated cycle<br>At main oscillation clock 10 MHz : Min 105 ms<br>At sub oscillation clock 32.768 kHz : Min 250 ms  |  |  |  |
|                                      | Wild register                               | Capable of replacing 3 bytes of ROM data  |  |  |  |
|                                      | I <sup>2</sup> C (1 channel)                | Master/slave sending and receiving<br>Bus error function and arbitration function<br>Detecting transmitting direction function<br>Start condition repeated generation and detection functions<br>Built-in wake-up function  |  |  |  |
|                                      | UART/SIO (1 channel)                        | Data transfer capable in UART/SIO<br>Full duplex double buffer<br>Variable data length (5/6/7/8-bit), built-in baud rate generator<br>NRZ type transfer format, error detected function<br>LSB-first or MSB-first can be selected.<br>Clock asynchronous (UART) or clock synchronous (SIO) serial data transfer capable |  |  |  |
|                                      | LIN-UART (1 channel)                        | Dedicated reload timer allowing a wide range of communication speeds to be set.<br>Full duplex double buffer.<br>Clock asynchronous (UART) or clock synchronous (SIO) serial data transfer capable<br>LIN functions available as the LIN master or LIN slave.   |  |  |  |
| 8/10-bit A/D converter (12 channels) | 8-bit or 10-bit resolution can be selected. |   |  |  |  |

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# MB95120MB Series

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| Part number          | MB95128MB  | MB95F124MB<br>MB95F126MB<br>MB95F128MB  | MB95F124NB<br>MB95F126NB<br>MB95F128NB | MB95F124JB<br>MB95F126JB<br>MB95F128JB |
|----------------------|--|---|--|--|
| Parameter            |  |   |  |  |
| Peripheral functions | LCD controller (LCDC)  | COM output : 4 (Max)<br>SEG output : 40 (Max)<br>LCD drive power supply (bias) pin : 4 (Max)<br>40 SEG × 4 COM : 160 pixels can be displayed.<br>Duty LCD mode<br>Operable in LCD standby mode<br>With blinking function<br>Built-in division resistance for LCD drive        |  |  |
|                      | 16-bit reload timer (1 channel)  | Two clock modes and two counter operating modes can be selected.<br>Square waveform output<br>Count clock : 7 internal clocks and external clock can be selected.<br>Counter operating mode : reload mode or one-shot mode can be selected.                                   |  |  |
|                      | 8/16-bit compound timer (2 channels)   | Each channel of the timer can be used as “8-bit timer × 2 channels” or “16-bit timer × 1 channel”.<br>Built-in timer function, PWC function, PWM function, capture function and square waveform output<br>Count clock : 7 internal clocks and external clock can be selected. |  |  |
|                      | 16-bit PPG (2 channels)  | PWM mode or one-shot mode can be selected.<br>Counter operating clock : Eight selectable clock sources<br>Support for external trigger start  |  |  |
|                      | 8/16-bit PPG (2 channels)  | Each channel of the PPG can be used as “8-bit PPG × 2 channels” or “16-bit PPG × 1 channel”.<br>Counter operating clock : Eight selectable clock sources  |  |  |
|                      | Watch counter  | Count clock : Four selectable clock sources (125 ms, 250 ms, 500 ms, or 1 s)<br>Counter value can be set from 0 to 63 (Capable of counting for 1 minute when selecting clock source 1 second and setting counter value to 60) .   |  |  |
|                      | Watch prescaler (1 channel)  | 4 selectable interval times (125 ms, 250 ms, 500 ms, or 1 s)  |  |  |
|                      | External interrupt (12 channels)   | Interrupt by edge detection (rising, falling, or both edges can be selected.)<br>Can be used to recover from standby modes.   |  |  |
| Flash memory         | Supports automatic programming, Embedded Algorithm™ *3<br>Write/Erase/Erased-Suspend/Resume commands<br>A flag indicating completion of the algorithm<br>Number of write/erase cycles (Minimum) : 10000 times<br>Data retention time : 20 years<br>Erase can be performed on each block<br>Block protection with external programming voltage<br>Dual operation Flash memory<br>Flash Security Feature for protecting the content of the Flash |   |  |  |
| Standby mode         | Sleep, stop, watch, and timebase timer   |   |  |  |

\*1 : For ROM capacitance and RAM capacitance, refer to “■ MEMORY LINEUP”.

\*2 : For details of option, refer to “■ MASK OPTION”.

\*3 : Embedded Algorithm is a trade mark of Advanced Micro Devices Inc.

Note : Part number of evaluation product in MB95120MB series is MB95FV100D-103. When using it, the MCU board (MB2146-303A) is required.

# MB95120MB Series

## ■ OSCILLATION STABILIZATION WAIT TIME

The initial value of the main clock oscillation stabilization wait time is fixed to the maximum value. The maximum value is shown as follows.

| Oscillation stabilization wait time | Remarks   |
|-------------------------------------|---|
| $(2^{14}-2) / F_{CH}$               | Approx. 4.10 ms (at main oscillation clock 4 MHz) |

## ■ PACKAGES AND CORRESPONDING PRODUCTS

| Part number<br>Package | MB95128MB | MB95F124MB/F124NB/F124JB<br>MB95F126MB/F126NB/F126JB<br>MB95F128MB/F128NB/F128JB | MB95FV100D-103 |
|------------------------|-----------|--|----------------|
| FPT-100P-M20           | ○         | ○  | ×              |
| FPT-100P-M06           | ○         | ○  | ×              |
| BGA-224P-M08           | ×         | ×  | ○              |

- : Available  
 × : Unavailable



# MB95120MB Series

## ■ DIFFERENCES AMONG PRODUCTS AND NOTES ON SELECTING PRODUCTS

### • Notes on Using Evaluation Products

The Evaluation product has not only the functions of the MB95120MB series but also those of other products to support software development for multiple series and models of the F<sup>2</sup>MC-8FX family. The I/O addresses for peripheral resources not used by the MB95120MB series are therefore access-barred. Read/write access to these access-barred addresses may cause peripheral resources supposed to be unused to operate, resulting in unexpected malfunctions of hardware or software.

Particularly, do not use word access to odd numbered byte address in the prohibited areas (If these access are used, the address may be read or written unexpectedly).

Also, as the read values of prohibited addresses on the evaluation product are different to the values on the Flash memory and MASK ROM products, do not use these values in the program.

The Evaluation product do not support the functions of some bits in single-byte registers. Read/write access to these bits does not cause hardware malfunctions. Since the Evaluation, Flash memory product, and MASK ROM product are designed to behave completely the same way in terms of hardware and software.

### • Difference of Memory Spaces

If the amount of memory on the Evaluation product is different from that of the Flash memory product or MASK ROM product, carefully check the difference in the amount of memory from the model to be actually used when developing software.

For details of memory space, refer to “■ CPU CORE”.

### • Current Consumption

- The current consumption of Flash memory product is typically greater than for MASK ROM product.
- For details of current consumption, refer to “■ ELECTRICAL CHARACTERISTICS”.

### • Package

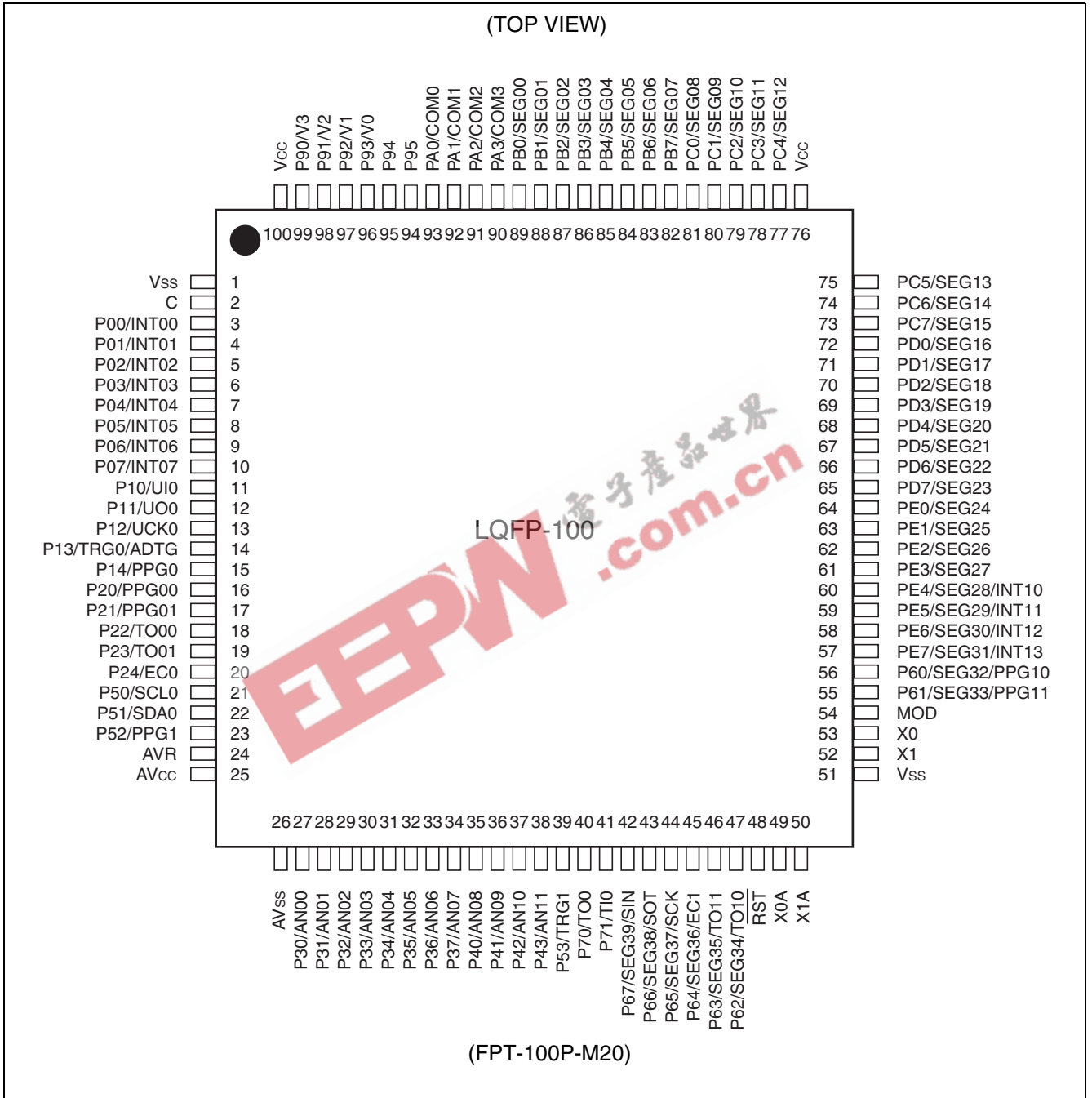
For details of information on each package, refer to “■ PACKAGES AND CORRESPONDING PRODUCTS” and “■ PACKAGE DIMENSIONS”.

### • Operating voltage

The operating voltage are different between the Evaluation, Flash memory products, and MASK ROM product. For details of operating voltage, refer to “■ ELECTRICAL CHARACTERISTICS”.

# MB95120MB Series

## ■ PIN ASSIGNMENT

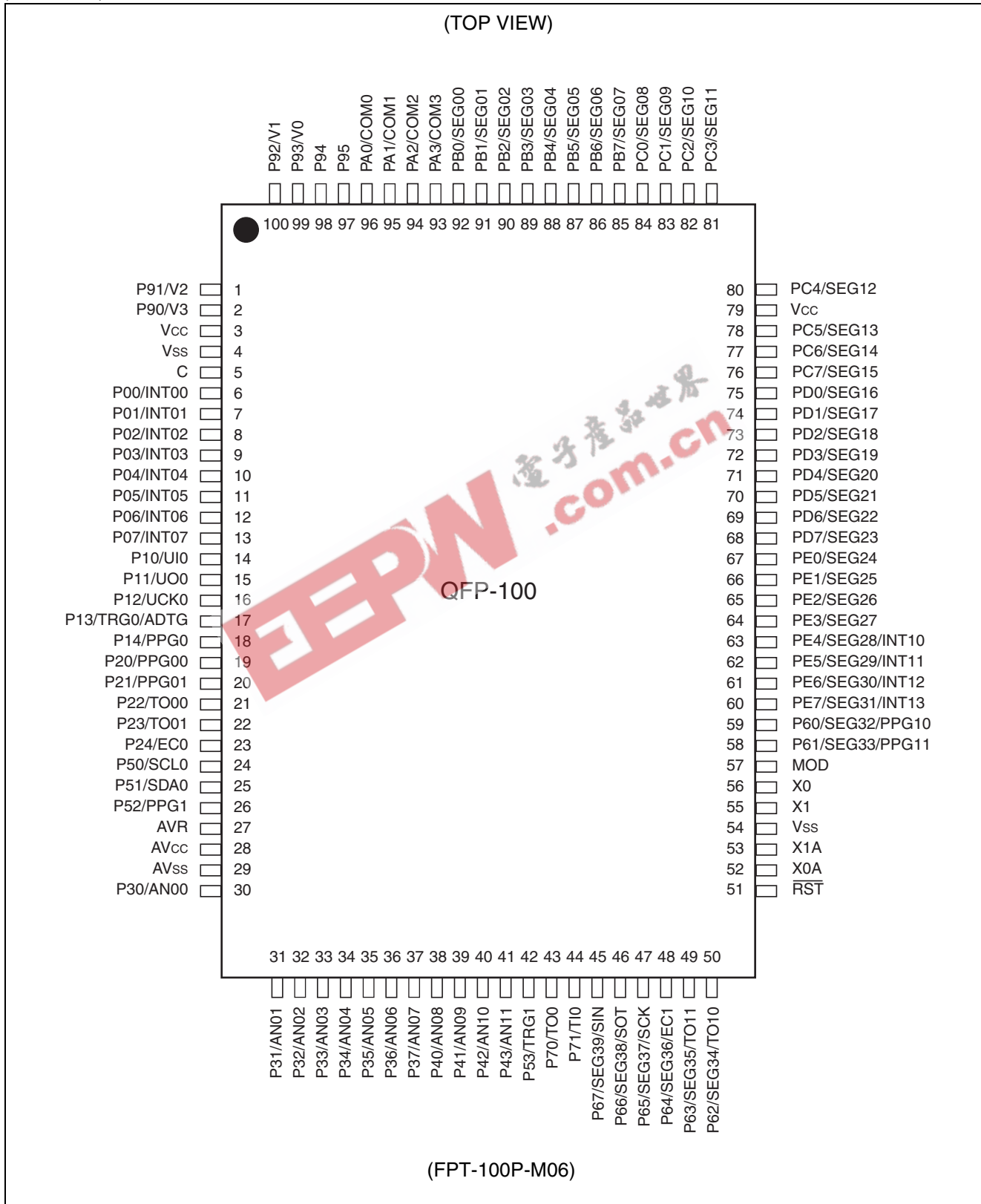


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# MB95120MB Series

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# MB95120MB Series

## ■ PIN DESCRIPTION

| Pin no. |        | Pin name          | I/O circuit type*3  | Function   |   |  |   |
|---------|--------|-------------------|---|--|---|--|---|
| LQFP *1 | QFP *2 |                   |   |  |   |  |   |
| 1       | 4      | V <sub>SS</sub>   | —   | Power supply pin (GND)   |   |  |   |
| 2       | 5      | C                 | —   | Capacitor connection pin   |   |  |   |
| 3       | 6      | P00/INT00         | C   | General-purpose I/O port<br>The pins are shared with external interrupt input. Large current port. |   |  |   |
| 4       | 7      | P01/INT01         |   |  |   |  |   |
| 5       | 8      | P02/INT02         |   |  |   |  |   |
| 6       | 9      | P03/INT03         |   |  |   |  |   |
| 7       | 10     | P04/INT04         |   |  |   |  |   |
| 8       | 11     | P05/INT05         |   |  |   |  |   |
| 9       | 12     | P06/INT06         |   |  |   |  |   |
| 10      | 13     | P07/INT07         |   |  |   |  |   |
| 11      | 14     | P10/UI0           |   |  | G   | General-purpose I/O port<br>The pin is shared with UART/SIO ch.0 data input.                 |   |
| 12      | 15     | P11/UO0           |   |  | H   | General-purpose I/O port<br>The pin is shared with UART/SIO ch.0 data output.                |   |
| 13      | 16     | P12/UCK0          | General-purpose I/O port<br>The pin is shared with UART/SIO ch.0 clock I/O.   |  |   |  |   |
| 14      | 17     | P13/TRG0/<br>ADTG | General-purpose I/O port<br>The pin is shared with 16-bit PPG ch.0 trigger input (TRG0) and A/D converter trigger input (ADTG). |  |   |  |   |
| 15      | 18     | P14/PPG0          | General-purpose I/O port<br>The pin is shared with 16-bit PPG ch.0 output.  |  |   |  |   |
| 16      | 19     | P20/PPG00         | H   | General-purpose I/O port<br>The pins are shared with 8/16-bit PPG ch.0 output.                     |   |  |   |
| 17      | 20     | P21/PPG01         |   | H  | General-purpose I/O port<br>The pins are shared with 8/16-bit compound timer ch.0 output. |  |   |
| 18      | 21     | P22/TO00          |   |  | H   | General-purpose I/O port<br>The pin is shared with 8/16-bit compound timer ch.0 clock input. |   |
| 19      | 22     | P23/TO01          |   |  |   | I  | General-purpose I/O port<br>The pin is shared with I <sup>2</sup> C ch.0 clock I/O. |
| 20      | 23     | P24/EC0           |   |  |   |  | General-purpose I/O port<br>The pin is shared with I <sup>2</sup> C ch.0 data I/O.  |
| 21      | 24     | P50/SCL0          | I   | General-purpose I/O port<br>The pin is shared with 16-bit PPG ch.1 output.                         |   |  |   |
| 22      | 25     | P51/SDA0          |   |  |   |  |   |
| 23      | 26     | P52/PPG1          | H   | General-purpose I/O port<br>The pin is shared with 16-bit PPG ch.1 output.                         |   |  |   |
| 24      | 27     | AVR               | —   | A/D converter reference input pin  |   |  |   |
| 25      | 28     | AV <sub>CC</sub>  | —   | A/D converter power supply pin   |   |  |   |

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# MB95120MB Series

| Pin no. |        | Pin name                | I/O circuit type*3 | Function  |
|---------|--------|-------------------------|--------------------|---|
| LQFP *1 | QFP *2 |                         |                    |   |
| 26      | 29     | AV <sub>SS</sub>        | —                  | A/D converter power supply pin (GND)  |
| 27      | 30     | P30/AN00                | J                  | General-purpose I/O port<br>The pins are shared with A/D converter analog input.  |
| 28      | 31     | P31/AN01                |                    |   |
| 29      | 32     | P32/AN02                |                    |   |
| 30      | 33     | P33/AN03                |                    |   |
| 31      | 34     | P34/AN04                |                    |   |
| 32      | 35     | P35/AN05                |                    |   |
| 33      | 36     | P36/AN06                |                    |   |
| 34      | 37     | P37/AN07                |                    |   |
| 35      | 38     | P40/AN08                | J                  | General-purpose I/O port<br>The pins are shared with A/D converter analog input.  |
| 36      | 39     | P41/AN09                |                    |   |
| 37      | 40     | P42/AN10                |                    |   |
| 38      | 41     | P43/AN11                |                    |   |
| 39      | 42     | P53/TRG1                | H                  | General-purpose I/O port<br>The pin is shared with 16-bit PPG ch.1 trigger input.   |
| 40      | 43     | P70/TO0                 | H                  | General-purpose I/O port<br>The pin is shared with 16-bit reload timer ch.0 output.   |
| 41      | 44     | P71/TI0                 |                    | General-purpose I/O port<br>The pin is shared with 16-bit reload timer ch.0 input.  |
| 42      | 45     | P67/SEG39/<br>SIN       | N                  | General-purpose I/O port<br>The pin is shared with LCD SEG output (SEG39) and LIN-<br>UART data input (SIN) .                                   |
| 43      | 46     | P66/SEG38/<br>SOT       | M                  | General-purpose I/O port<br>The pin is shared with LCD SEG output (SEG38) and LIN-<br>UART data output (SOT) .                                  |
| 44      | 47     | P65/SEG37/<br>SCK       |                    | General-purpose I/O port<br>The pin is shared with LCD SEG output (SEG37) and LIN-<br>UART clock I/O (SCK) .                                    |
| 45      | 48     | P64/SEG36/<br>EC1       |                    | General-purpose I/O port<br>The pin is shared with LCD SEG output (SEG36) and<br>8/16-bit compound timer ch.1 clock input (EC1) .               |
| 46      | 49     | P63/SEG35/<br>TO11      |                    | General-purpose I/O port<br>The pins are shared with LCD SEG output (SEG34,<br>SEG35) and 8/16-bit compound timer ch.1 output (TO10,<br>TO11) . |
| 47      | 50     | P62/SEG34/<br>TO10      |                    |   |
| 48      | 51     | $\overline{\text{RST}}$ | B'                 | Reset pin   |
| 49      | 52     | X0A                     | A                  | Sub clock oscillation pin (32 kHz)  |
| 50      | 53     | X1A                     |                    |   |
| 51      | 54     | V <sub>SS</sub>         | —                  | Power supply pin (GND)  |

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# MB95120MB Series

| Pin no. |        | Pin name            | I/O circuit type*3 | Function  |
|---------|--------|---------------------|--------------------|---|
| LQFP *1 | QFP *2 |                     |                    |   |
| 52      | 55     | X1                  | A                  | Main clock oscillation pin  |
| 53      | 56     | X0                  |                    |   |
| 54      | 57     | MOD                 | B                  | An operating mode designation pin   |
| 55      | 58     | P61/SEG33/<br>PPG11 | M                  | General-purpose I/O port<br>The pins are shared with LCDC SEG output (SEG32, SEG33) and 8/16-bit PPG ch.1 output (PPG10, PPG11) .     |
| 56      | 59     | P60/SEG32/<br>PPG10 |                    |   |
| 57      | 60     | PE7/SEG31/<br>INT13 | Q                  | General-purpose I/O port<br>The pins are shared with LCDC SEG output (SEG28 to SEG31) and external interrupt input (INT10 to INT13) . |
| 58      | 61     | PE6/SEG30/<br>INT12 |                    |   |
| 59      | 62     | PE5/SEG29/<br>INT11 |                    |   |
| 60      | 63     | PE4/SEG28/<br>INT10 |                    |   |
| 61      | 64     | PE3/SEG27           | M                  | General-purpose I/O port<br>The pins are shared with LCDC SEG output (SEG24 to SEG27) .   |
| 62      | 65     | PE2/SEG26           |                    |   |
| 63      | 66     | PE1/SEG25           |                    |   |
| 64      | 67     | PE0/SEG24           |                    |   |
| 65      | 68     | PD7/SEG23           | M                  | General-purpose I/O port<br>The pins are shared with LCDC SEG output (SEG16 to SEG23) .   |
| 66      | 69     | PD6/SEG22           |                    |   |
| 67      | 70     | PD5/SEG21           |                    |   |
| 68      | 71     | PD4/SEG20           |                    |   |
| 69      | 72     | PD3/SEG19           |                    |   |
| 70      | 73     | PD2/SEG18           |                    |   |
| 71      | 74     | PD1/SEG17           |                    |   |
| 72      | 75     | PD0/SEG16           |                    |   |
| 73      | 76     | PC7/SEG15           | M                  | General-purpose I/O port<br>The pins are shared with LCDC SEG output (SEG13 to SEG15) .   |
| 74      | 77     | PC6/SEG14           |                    |   |
| 75      | 78     | PC5/SEG13           |                    |   |
| 76      | 79     | V <sub>CC</sub>     | —                  | Power supply pin  |

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# MB95120MB Series

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| Pin no. |        | Pin name        | I/O circuit type*3 | Function  |
|---------|--------|-----------------|--------------------|---|
| LQFP *1 | QFP *2 |                 |                    |   |
| 77      | 80     | PC4/SEG12       | M                  | General-purpose I/O port<br>The pins are shared with LCDC SEG output (SEG08 to SEG12) . |
| 78      | 81     | PC3/SEG11       |                    |   |
| 79      | 82     | PC2/SEG10       |                    |   |
| 80      | 83     | PC1/SEG09       |                    |   |
| 81      | 84     | PC0/SEG08       |                    |   |
| 82      | 85     | PB7/SEG07       | M                  | General-purpose I/O port<br>The pins are shared with LCDC SEG output (SEG00 to SEG07) . |
| 83      | 86     | PB6/SEG06       |                    |   |
| 84      | 87     | PB5/SEG05       |                    |   |
| 85      | 88     | PB4/SEG04       |                    |   |
| 86      | 89     | PB3/SEG03       |                    |   |
| 87      | 90     | PB2/SEG02       |                    |   |
| 88      | 91     | PB1/SEG01       |                    |   |
| 89      | 92     | PB0/SEG00       | M                  | General-purpose I/O port<br>The pins are shared with LCDC COM output (COM0 to COM3) .   |
| 90      | 93     | PA3/COM3        |                    |   |
| 91      | 94     | PA2/COM2        |                    |   |
| 92      | 95     | PA1/COM1        |                    |   |
| 93      | 96     | PA0/COM0        | M                  | General-purpose I/O port  |
| 94      | 97     | P95             |                    |   |
| 95      | 98     | P94             | R                  | General-purpose I/O port<br>The pins are shared with power supply pins for LCDC drive.  |
| 96      | 99     | P93/V0          |                    |   |
| 97      | 100    | P92/V1          |                    |   |
| 98      | 1      | P91/V2          |                    |   |
| 99      | 2      | P90/V3          |                    |   |
| 100     | 3      | V <sub>CC</sub> | —                  | Power supply pin  |

\*1 : FPT-100P-M20

\*2 : FPT-100P-M06

\*3 : For the I/O circuit type, refer to “■ I/O CIRCUIT TYPE”.

# MB95120MB Series

## ■ I/O CIRCUIT TYPE

| Type | Circuit | Remarks   |
|------|---------|---|
| A    |         | <ul style="list-style-type: none"> <li>• Oscillation circuit</li> <li>• High-speed side<br/>Feedback resistance : approx. 1 MΩ</li> <li>• Low-speed side<br/>Feedback resistance : approx. 10 MΩ</li> </ul> |
| B    |         | <ul style="list-style-type: none"> <li>• Only for input</li> <li>• Hysteresis input</li> </ul>  |
| B'   |         | <ul style="list-style-type: none"> <li>• Reset output</li> <li>• Hysteresis input</li> </ul>  |
| C    |         | <ul style="list-style-type: none"> <li>• CMOS output</li> <li>• Hysteresis input</li> <li>• Automotive input</li> </ul>   |
| G    |         | <ul style="list-style-type: none"> <li>• CMOS output</li> <li>• CMOS input</li> <li>• Hysteresis input</li> <li>• With pull-up control</li> <li>• Automotive input</li> </ul>                               |

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# MB95120MB Series

| Type | Circuit | Remarks   |
|------|---------|---|
| H    |         | <ul style="list-style-type: none"> <li>• CMOS output</li> <li>• Hysteresis input</li> <li>• With pull-up control</li> <li>• Automotive input</li> </ul>                         |
| I    |         | <ul style="list-style-type: none"> <li>• N-ch open drain output</li> <li>• CMOS input</li> <li>• Hysteresis input</li> <li>• Automotive input</li> </ul>                        |
| J    |         | <ul style="list-style-type: none"> <li>• CMOS output</li> <li>• Hysteresis input</li> <li>• Analog input</li> <li>• With pull-up control</li> <li>• Automotive input</li> </ul> |
| M    |         | <ul style="list-style-type: none"> <li>• CMOS output</li> <li>• LCD output</li> <li>• Hysteresis input</li> <li>• Automotive input</li> </ul>                                   |

(Continued)

# MB95120MB Series

(Continued)

| Type | Circuit   | Remarks   |
|------|---|---|
| N    | <p>                     P-ch — Digital output<br/>                     N-ch — Digital output<br/>                     LCD output<br/>                     CMOS input<br/>                     Hysteresis input<br/>                     Automotive input<br/>                     LCD control<br/>                     Standby control                 </p>                 | <ul style="list-style-type: none"> <li>• CMOS output</li> <li>• LCD output</li> <li>• CMOS input</li> <li>• Hysteresis input</li> <li>• Automotive input</li> </ul> |
| Q    | <p>                     P-ch — Digital output<br/>                     N-ch — Digital output<br/>                     LCD output<br/>                     Hysteresis input<br/>                     Automotive input<br/>                     LCD control<br/>                     Standby control<br/>                     External interrupt control                 </p> | <ul style="list-style-type: none"> <li>• CMOS output</li> <li>• LCD output</li> <li>• Hysteresis input</li> <li>• Automotive input</li> </ul>                       |
| R    | <p>                     P-ch — Digital output<br/>                     N-ch — Digital output<br/>                     LCD built-in division resistance I/O<br/>                     Hysteresis input<br/>                     Automotive input<br/>                     LCD control<br/>                     Standby control                 </p>                           | <ul style="list-style-type: none"> <li>• CMOS output</li> <li>• LCD power supply</li> <li>• Hysteresis input</li> <li>• Automotive input</li> </ul>                 |



## ■ HANDLING DEVICES

### • Preventing Latch-up

Care must be taken to ensure that maximum voltage ratings are not exceeded when they are used.

Latch-up may occur on CMOS ICs if voltage higher than  $V_{CC}$  or lower than  $V_{SS}$  is applied to input and output pins other than medium- and high-withstand voltage pins or if higher than the rating voltage is applied between  $V_{CC}$  pin and  $V_{SS}$  pin.

When latch-up occurs, power supply current increases rapidly and might thermally damage elements.

Also, take care to prevent the analog power supply voltage ( $AV_{CC}$ ,  $AVR$ ) and analog input voltage from exceeding the digital power supply voltage ( $V_{CC}$ ) when the analog system power supply is turned on or off.

### • Stable Supply Voltage

Supply voltage should be stabilized.

A sudden change in power-supply voltage may cause a malfunction even within the guaranteed operating range of the  $V_{CC}$  power-supply voltage.

For stabilization, in principle, keep the variation in  $V_{CC}$  ripple (p-p value) in a commercial frequency range (50/60 Hz) not to exceed 10% of the standard  $V_{CC}$  value and suppress the voltage variation so that the transient variation rate does not exceed 0.1 V/ms during a momentary change such as when the power supply is switched.

### • Precautions for Use of External Clock

Even when an external clock is used, oscillation stabilization wait time is required for power-on reset, wake-up from sub clock mode or stop mode.

## PIN CONNECTION

### • Treatment of Unused Pin

Leaving unused input pins unconnected can cause abnormal operation or latch-up, leaving to permanent damage.

Unused input pins should always be pulled up or down through resistance of at least 2 k $\Omega$ . Any unused input/output pins may be set to output mode and left open, or set to input mode and treated the same as unused input pins. If there is unused output pin, make it open.

### • Treatment of Power Supply Pins on A/D Converter

Connect to be  $AV_{CC} = V_{CC}$  and  $AV_{SS} = AVR = V_{SS}$  even if the A/D converter is not in use.

Noise riding on the  $AV_{CC}$  pin may cause accuracy degradation. So, connect approx. 0.1  $\mu$ F ceramic capacitor as a bypass capacitor between  $AV_{CC}$  and  $AV_{SS}$  pins in the vicinity of this device.

### • Power Supply Pins

In products with multiple  $V_{CC}$  or  $V_{SS}$  pins, the pins of the same potential are internally connected in the device to avoid abnormal operations including latch-up. However, you must connect the pins to external power supply and a ground line to lower the electro-magnetic emission level, to prevent abnormal operation of strobe signals caused by the rise in the ground level, and to conform to the total output current rating.

Moreover, connect the current supply source with the  $V_{CC}$  and  $V_{SS}$  pins of this device at the low impedance.

It is also advisable to connect a ceramic bypass capacitor of approximately 0.1  $\mu$ F between  $V_{CC}$  and  $V_{SS}$  near this device.

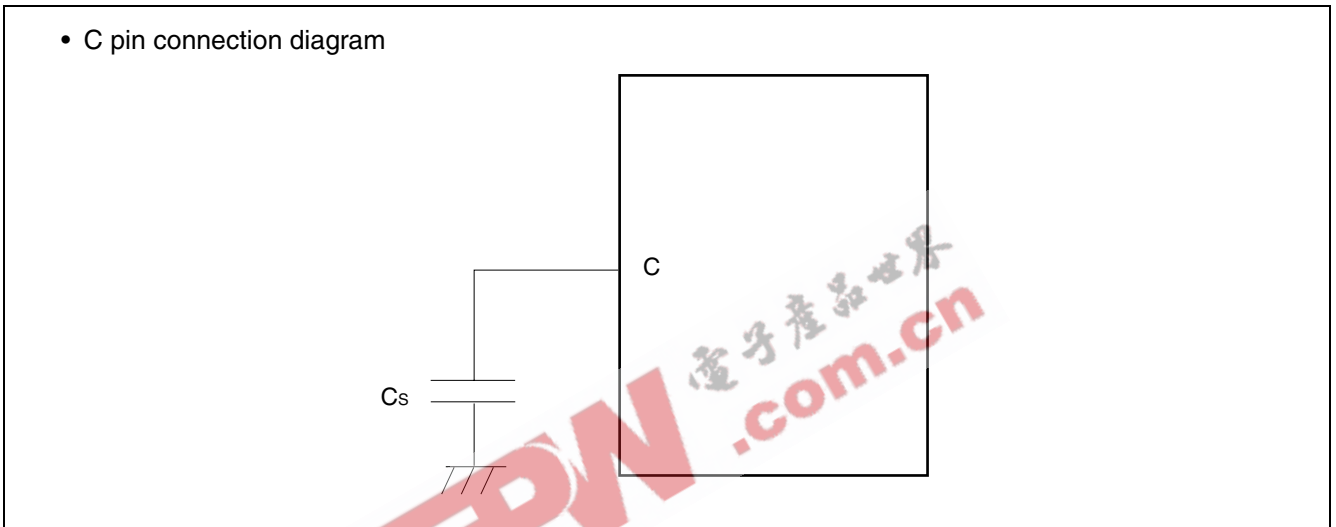
# MB95120MB Series

- Mode Pin (MOD)

Connect the MOD pin directly to  $V_{CC}$  or  $V_{SS}$  pins.

To prevent the device unintentionally entering test mode due to noise, lay out the printed circuit board so as to minimize the distance from the MOD pins to  $V_{CC}$  or  $V_{SS}$  pins and to provide a low-impedance connection.

Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. A bypass capacitor of  $V_{CC}$  pin must have a capacitance value higher than  $C_s$ . For connection of smoothing capacitor  $C_s$ , refer to the diagram below.



- Analog Power Supply

Always set the same potential to  $AV_{CC}$  and  $V_{CC}$  pins. When  $V_{CC} > AV_{CC}$ , the current may flow through the AN00 to AN11 pins.

# MB95120MB Series

## PROGRAMMING FLASH MEMORY MICROCONTROLLERS USING PARALLEL PROGRAMMER

### Supported Parallel Programmers and Adapters

The following table lists supported parallel programmers and adapters.

| Package      | Applicable adapter model | Parallel programmers   |
|--------------|--------------------------|--|
| FPT-100P-M20 | TEF110-95F128HSPFV       | AF9708 (Ver 02.35G or more)<br>AF9709/B (Ver 02.35G or more)<br>AF9723+AF9834 (Ver 02.08E or more) |
| FPT-100P-M06 | TEF110-95F128HSPF        |  |

Note : For information on applicable adapter models and parallel programmers, contact the following:  
Flash Support Group, Inc. TEL: +81-53-428-8380

### Sector Configuration

The individual sectors of Flash memory correspond to addresses used for CPU access and programming by the parallel programmer as follows:

| Flash memory    | CPU address       | Programmer address* |
|-----------------|-------------------|---------------------|
| SA1 (4 Kbytes)  | 1000 <sub>H</sub> | 71000 <sub>H</sub>  |
|                 | 1FFF <sub>H</sub> | 71FFF <sub>H</sub>  |
| SA2 (4 Kbytes)  | 2000 <sub>H</sub> | 72000 <sub>H</sub>  |
|                 | 2FFF <sub>H</sub> | 72FFF <sub>H</sub>  |
| SA3 (4 Kbytes)  | 3000 <sub>H</sub> | 73000 <sub>H</sub>  |
|                 | 3FFF <sub>H</sub> | 73FFF <sub>H</sub>  |
| SA4 (16 Kbytes) | 4000 <sub>H</sub> | 74000 <sub>H</sub>  |
|                 | 7FFF <sub>H</sub> | 77FFF <sub>H</sub>  |
| SA5 (16 Kbytes) | 8000 <sub>H</sub> | 78000 <sub>H</sub>  |
|                 | BFFF <sub>H</sub> | 7BFFF <sub>H</sub>  |
| SA6 (4 Kbytes)  | C000 <sub>H</sub> | 7C000 <sub>H</sub>  |
|                 | CFFF <sub>H</sub> | 7CFFF <sub>H</sub>  |
| SA7 (4 Kbytes)  | D000 <sub>H</sub> | 7D000 <sub>H</sub>  |
|                 | DFFF <sub>H</sub> | 7DFFF <sub>H</sub>  |
| SA8 (4 Kbytes)  | E000 <sub>H</sub> | 7E000 <sub>H</sub>  |
|                 | EFFF <sub>H</sub> | 7EFFF <sub>H</sub>  |
| SA9 (4 Kbytes)  | F000 <sub>H</sub> | 7F000 <sub>H</sub>  |
|                 | FFF <sub>H</sub>  | 7FFF <sub>H</sub>   |

Lower bank

Upper bank

\*: Programmer addresses are corresponding to CPU addresses, used when the parallel programmer programs data into Flash memory.  
These programmer addresses are used for the parallel programmer to program or erase data in Flash memory.

### Programming Method

- 1) Set the type code of the parallel programmer to 17222.
- 2) Load program data to programmer addresses 71000<sub>H</sub> to 7FFF<sub>H</sub>.
- 3) Programmed by parallel programmer

# MB95120MB Series

## • MB95F126MB/F126NB/F126JB (32 Kbytes)

| Flash memory    | CPU address       | Programmer address* |
|-----------------|-------------------|---------------------|
| SA5 (16 Kbytes) | 8000 <sub>H</sub> | 78000 <sub>H</sub>  |
| SA6 (4 Kbytes)  | BFFF <sub>H</sub> | 7BFFF <sub>H</sub>  |
|                 | C000 <sub>H</sub> | 7C000 <sub>H</sub>  |
| SA7 (4 Kbytes)  | CFFF <sub>H</sub> | 7CFFF <sub>H</sub>  |
|                 | D000 <sub>H</sub> | 7D000 <sub>H</sub>  |
| SA8 (4 Kbytes)  | DFFF <sub>H</sub> | 7DFFF <sub>H</sub>  |
|                 | E000 <sub>H</sub> | 7E000 <sub>H</sub>  |
| SA9 (4 Kbytes)  | FFFF <sub>H</sub> | 7FFFF <sub>H</sub>  |
|                 | F000 <sub>H</sub> | 7F000 <sub>H</sub>  |

\*: Programmer addresses are corresponding to CPU addresses, used when the parallel programmer programs data into Flash memory. These programmer addresses are used for the parallel programmer to program or erase data in Flash memory.

### • Programming Method

- 1) Set the type code of the parallel programmer to 17222.
- 2) Load program data to programmer addresses 78000<sub>H</sub> to 7FFFF<sub>H</sub>.
- 3) Programmed by parallel programmer

## • MB95F124MB/F124NB/F124JB (16 Kbytes)

| Flash memory   | CPU address       | Programmer address* |
|----------------|-------------------|---------------------|
| SA6 (4 Kbytes) | C000 <sub>H</sub> | 7C000 <sub>H</sub>  |
|                | CFFF <sub>H</sub> | 7CFFF <sub>H</sub>  |
| SA7 (4 Kbytes) | D000 <sub>H</sub> | 7D000 <sub>H</sub>  |
|                | DFFF <sub>H</sub> | 7DFFF <sub>H</sub>  |
| SA8 (4 Kbytes) | E000 <sub>H</sub> | 7E000 <sub>H</sub>  |
|                | EFFF <sub>H</sub> | 7EFFF <sub>H</sub>  |
| SA9 (4 Kbytes) | F000 <sub>H</sub> | 7F000 <sub>H</sub>  |
|                | FFFF <sub>H</sub> | 7FFFF <sub>H</sub>  |

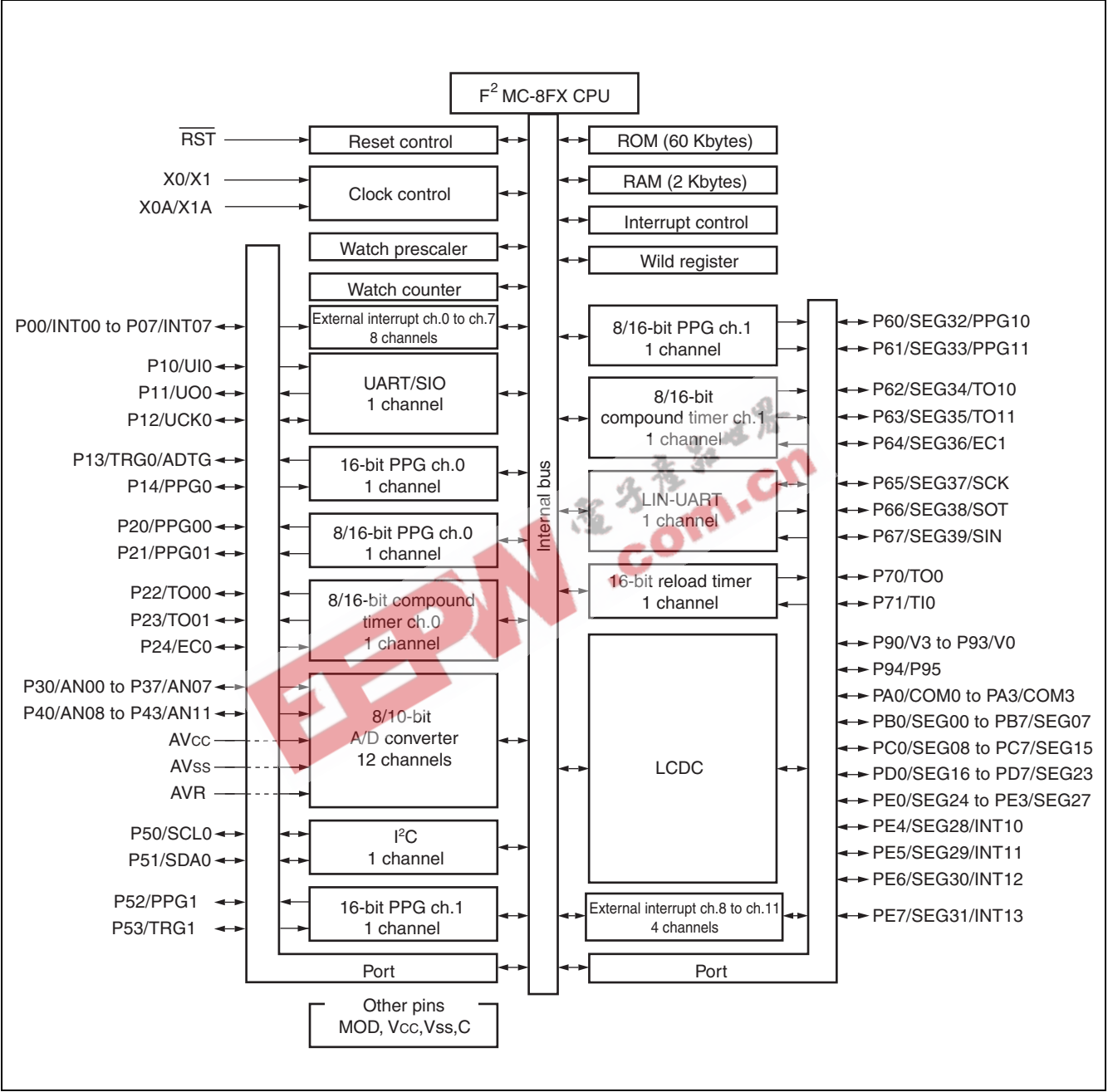
\*: Programmer addresses are corresponding to CPU addresses, used when the parallel programmer programs data into Flash memory. These programmer addresses are used for the parallel programmer to program or erase data in Flash memory.

### • Programming Method

- 1) Set the type code of the parallel programmer to 17222.
- 2) Load program data to programmer addresses 7C000<sub>H</sub> to 7FFFF<sub>H</sub>.
- 3) Programmed by parallel programmer

# MB95120MB Series

## ■ BLOCK DIAGRAM

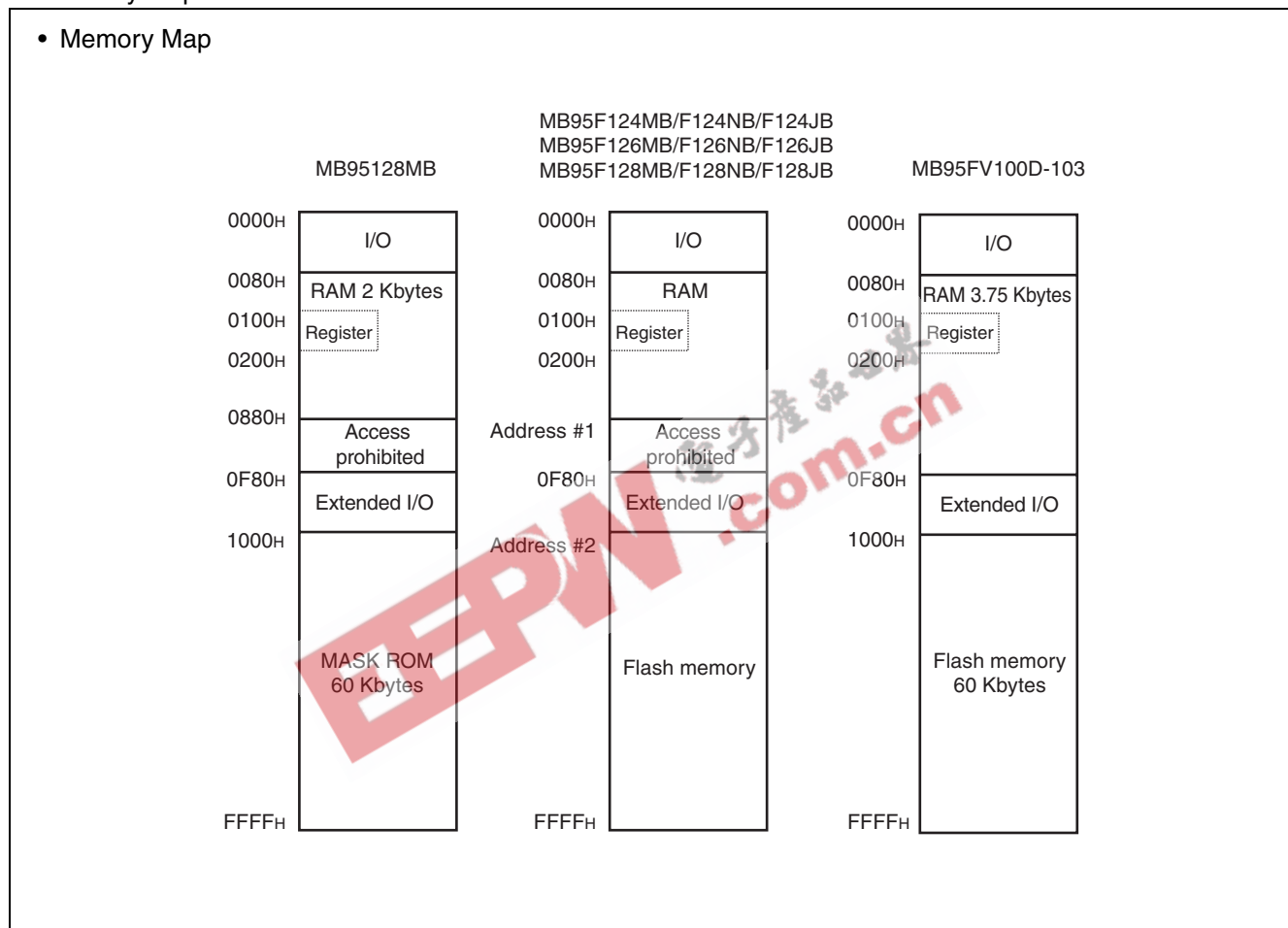


# MB95120MB Series

## ■ CPU CORE

### 1. Memory space

Memory space of the MB95120MB series is 64 Kbytes and consists of I/O area, data area, and program area. The memory space includes special - purpose areas such as the general - purpose registers and vector table. Memory map of the MB95120MB series is shown below.



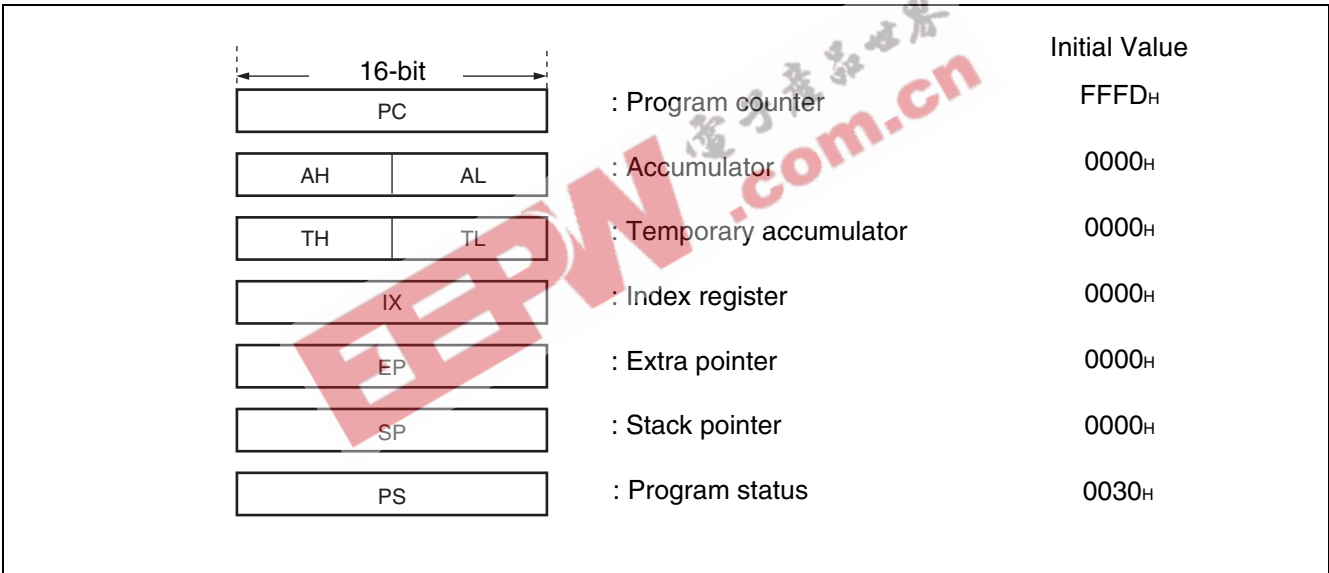
|            | Flash memory | RAM       | Address #1 | Address #2 |
|------------|--------------|-----------|------------|------------|
| MB95F124MB | 16 Kbytes    | 512 bytes | 0280H      | C000H      |
| MB95F124NB |              |           |            |            |
| MB95F124JB |              |           |            |            |
| MB95F126MB | 32 Kbytes    | 1 Kbyte   | 0480H      | 8000H      |
| MB95F126NB |              |           |            |            |
| MB95F126JB |              |           |            |            |
| MB95F128MB | 60 Kbytes    | 2 Kbytes  | 0880H      | 1000H      |
| MB95F128NB |              |           |            |            |
| MB95F128JB |              |           |            |            |

# MB95120MB Series

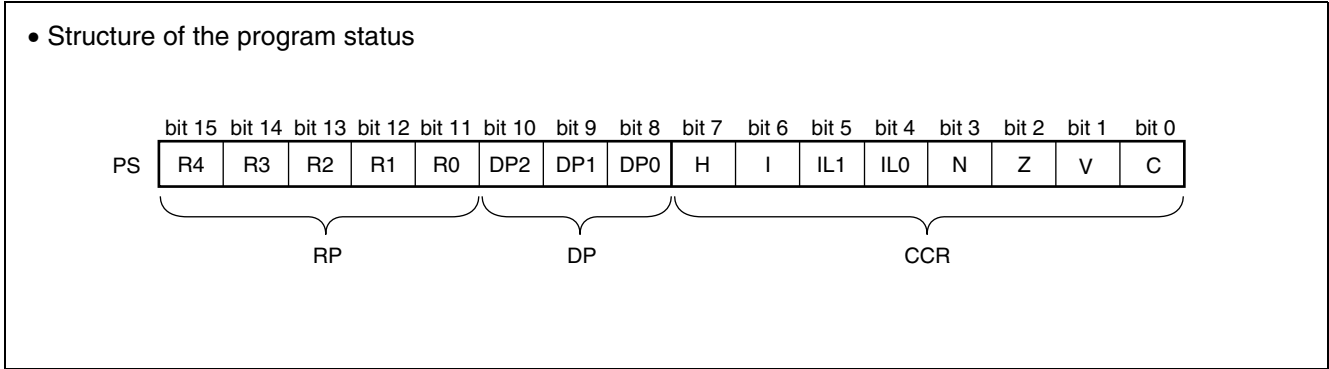
## 2. Register

The MB95120MB series has two types of registers; dedicated registers in the CPU and general-purpose registers in the memory. The dedicated registers are as follows:

- Program counter (PC) : A 16-bit register to indicate locations where instructions are stored.
- Accumulator (A) : A 16-bit register for temporary storage of arithmetic operations. In the case of an 8-bit data processing instruction, the lower 1 byte is used.
- Temporary accumulator (T) : A 16-bit register which performs arithmetic operations with the accumulator. In the case of an 8-bit data processing instruction, the lower 1 byte is used.
- Index register (IX) : A 16-bit register for index modification
- Extra pointer (EP) : A 16-bit pointer to point to a memory address.
- Stack pointer (SP) : A 16-bit register to indicate a stack area.
- Program status (PS) : A 16-bit register for storing a register bank pointer, a direct bank pointer, and a condition code register



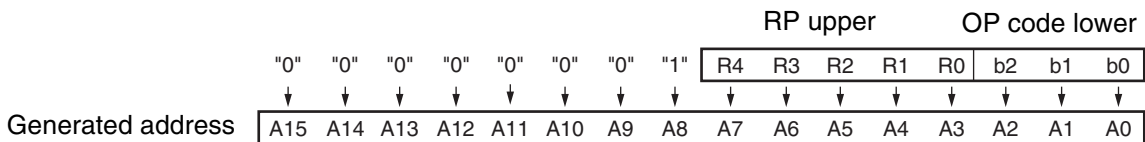
The PS can further be divided into higher 8 bits for use as a register bank pointer (RP) and a direct bank pointer (DP) and the lower 8 bits for use as a condition code register (CCR) . (Refer to the diagram below.)



# MB95120MB Series

The RP indicates the address of the register bank currently being used. The relationship between the content of RP and the real address conforms to the conversion rule illustrated below:

- Rule for Conversion of Actual Addresses in the General-purpose Register Area



The DP specifies the area for mapping instructions (16 different instructions such as MOV A, dir) using direct addresses to 0080H to 00FFH.

| Direct bank pointer (DP2 to DP0)        | Specified address area                 | Mapping area   |
|---|--|--|
| XXX <sub>B</sub> (no effect to mapping) | 0000 <sub>H</sub> to 007F <sub>H</sub> | 0000 <sub>H</sub> to 007F <sub>H</sub> (without mapping) |
| 000 <sub>B</sub> (initial value)        | 0080 <sub>H</sub> to 00FF <sub>H</sub> | 0080 <sub>H</sub> to 00FF <sub>H</sub> (without mapping) |
| 001 <sub>B</sub>                        |  | 0100 <sub>H</sub> to 017F <sub>H</sub>                   |
| 010 <sub>B</sub>                        |  | 0180 <sub>H</sub> to 01FF <sub>H</sub>                   |
| 011 <sub>B</sub>                        |  | 0200 <sub>H</sub> to 027F <sub>H</sub>                   |
| 100 <sub>B</sub>                        |  | 0280 <sub>H</sub> to 02FF <sub>H</sub>                   |
| 101 <sub>B</sub>                        |  | 0300 <sub>H</sub> to 037F <sub>H</sub>                   |
| 110 <sub>B</sub>                        |  | 0380 <sub>H</sub> to 03FF <sub>H</sub>                   |
| 111 <sub>B</sub>                        |  | 0400 <sub>H</sub> to 047F <sub>H</sub>                   |

The CCR consists of the bits indicating arithmetic operation results or transfer data contents and the bits that control CPU operations at interrupt.

- H flag : Set to "1" when a carry or a borrow from bit 3 to bit 4 occurs as a result of an arithmetic operation. Cleared to "0" otherwise. This flag is for decimal adjustment instructions.
- I flag : Interrupt is enabled when this flag is set to "1". Interrupt is disabled when this flag is set to "0". The flag is cleared to "0" when reset.
- IL1, IL0 : Indicates the level of the interrupt currently enabled. Processes an interrupt only if its request level is higher than the value indicated by these bits.

| IL1 | IL0 | Interrupt level | Priority                                |
|-----|-----|-----------------|---|
| 0   | 0   | 0               | High<br>↑<br>↓<br>Low (no interruption) |
| 0   | 1   | 1               |   |
| 1   | 0   | 2               |   |
| 1   | 1   | 3               |   |

- N flag : Set to "1" if the MSB is set to "1" as the result of an arithmetic operation. Cleared to "0" when the bit is set to "0".
- Z flag : Set to "1" when an arithmetic operation results in "0". Cleared to "0" otherwise.
- V flag : Set to "1" if the complement on 2 overflows as a result of an arithmetic operation. Cleared to "0" otherwise.
- C flag : Set to "1" when a carry or a borrow from bit 7 occurs as a result of an arithmetic operation. Cleared to "0" otherwise. Set to the shift-out value in the case of a shift instruction.



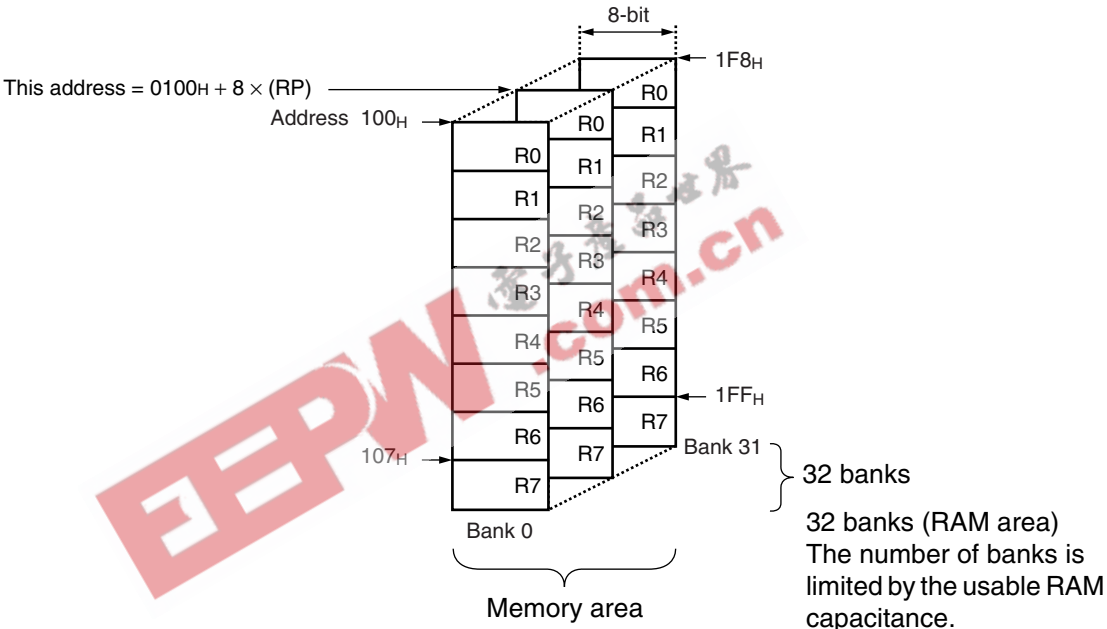
# MB95120MB Series

The following general-purpose registers are provided:

General-purpose registers: 8-bit data storage registers

The general-purpose registers are 8 bits and located in the register banks on the memory. 1-bank contains 8 registers. Up to a total of 32 banks can be used on the MB95120MB series. The bank currently in use is indicated by the register bank pointer (RP). 8-register. Up to a total of 32 banks can be used on the MB95120MB series. The bank currently in use is specified by the register bank pointer (RP), and the lower 3 bits of OP code indicates the general-purpose register 0 (R0) to general-purpose register 7 (R7).

- Register Bank Configuration



# MB95120MB Series

## ■ I/O MAP

| Address                                  | Register abbreviation | Register name  | R/W | Initial value         |
|--|-----------------------|--|-----|-----------------------|
| 0000 <sub>H</sub>                        | PDR0                  | Port 0 data register                                 | R/W | 00000000 <sub>B</sub> |
| 0001 <sub>H</sub>                        | DDR0                  | Port 0 direction register                            | R/W | 00000000 <sub>B</sub> |
| 0002 <sub>H</sub>                        | PDR1                  | Port 1 data register                                 | R/W | 00000000 <sub>B</sub> |
| 0003 <sub>H</sub>                        | DDR1                  | Port 1 direction register                            | R/W | 00000000 <sub>B</sub> |
| 0004 <sub>H</sub>                        | —                     | (Disabled)   | —   | —                     |
| 0005 <sub>H</sub>                        | WATR                  | Oscillation stabilization wait time setting register | R/W | 11111111 <sub>B</sub> |
| 0006 <sub>H</sub>                        | PLLC                  | PLL control register                                 | R/W | 00000000 <sub>B</sub> |
| 0007 <sub>H</sub>                        | SYCC                  | System clock control register                        | R/W | 1010X011 <sub>B</sub> |
| 0008 <sub>H</sub>                        | STBC                  | Standby control register                             | R/W | 00000000 <sub>B</sub> |
| 0009 <sub>H</sub>                        | RSRR                  | Reset source register                                | R/W | XXXXXXXX <sub>B</sub> |
| 000A <sub>H</sub>                        | TBTC                  | Timebase timer control register                      | R/W | 00000000 <sub>B</sub> |
| 000B <sub>H</sub>                        | WPCR                  | Watch prescaler control register                     | R/W | 00000000 <sub>B</sub> |
| 000C <sub>H</sub>                        | WDTC                  | Watchdog timer control register                      | R/W | 00000000 <sub>B</sub> |
| 000D <sub>H</sub>                        | —                     | (Disabled)   | —   | —                     |
| 000E <sub>H</sub>                        | PDR2                  | Port 2 data register                                 | R/W | 00000000 <sub>B</sub> |
| 000F <sub>H</sub>                        | DDR2                  | Port 2 direction register                            | R/W | 00000000 <sub>B</sub> |
| 0010 <sub>H</sub>                        | PDR3                  | Port 3 data register                                 | R/W | 00000000 <sub>B</sub> |
| 0011 <sub>H</sub>                        | DDR3                  | Port 3 direction register                            | R/W | 00000000 <sub>B</sub> |
| 0012 <sub>H</sub>                        | PDR4                  | Port 4 data register                                 | R/W | 00000000 <sub>B</sub> |
| 0013 <sub>H</sub>                        | DDR4                  | Port 4 direction register                            | R/W | 00000000 <sub>B</sub> |
| 0014 <sub>H</sub>                        | PDR5                  | Port 5 data register                                 | R/W | 00000000 <sub>B</sub> |
| 0015 <sub>H</sub>                        | DDR5                  | Port 5 direction register                            | R/W | 00000000 <sub>B</sub> |
| 0016 <sub>H</sub>                        | PDR6                  | Port 6 data register                                 | R/W | 00000000 <sub>B</sub> |
| 0017 <sub>H</sub>                        | DDR6                  | Port 6 direction register                            | R/W | 00000000 <sub>B</sub> |
| 0018 <sub>H</sub>                        | PDR7                  | Port 7 data register                                 | R/W | 00000000 <sub>B</sub> |
| 0019 <sub>H</sub>                        | DDR7                  | Port 7 direction register                            | R/W | 00000000 <sub>B</sub> |
| 001A <sub>H</sub> ,<br>001B <sub>H</sub> | —                     | (Disabled)   | —   | —                     |
| 001C <sub>H</sub>                        | PDR9                  | Port 9 data register                                 | R/W | 00000000 <sub>B</sub> |
| 001D <sub>H</sub>                        | DDR9                  | Port 9 direction register                            | R/W | 00000000 <sub>B</sub> |
| 001E <sub>H</sub>                        | PDRA                  | Port A data register                                 | R/W | 00000000 <sub>B</sub> |
| 001F <sub>H</sub>                        | DDRA                  | Port A direction register                            | R/W | 00000000 <sub>B</sub> |
| 0020 <sub>H</sub>                        | PDRB                  | Port B data register                                 | R/W | 00000000 <sub>B</sub> |
| 0021 <sub>H</sub>                        | DDRB                  | Port B direction register                            | R/W | 00000000 <sub>B</sub> |
| 0022 <sub>H</sub>                        | PDRC                  | Port C data register                                 | R/W | 00000000 <sub>B</sub> |

(Continued)

# MB95120MB Series

| Address                                      | Register abbreviation | Register name   | R/W | Initial value         |
|--|-----------------------|---|-----|-----------------------|
| 0023 <sub>H</sub>                            | DDRC                  | Port C direction register                                     | R/W | 00000000 <sub>B</sub> |
| 0024 <sub>H</sub>                            | PDRD                  | Port D data register  | R/W | 00000000 <sub>B</sub> |
| 0025 <sub>H</sub>                            | DDRD                  | Port D direction register                                     | R/W | 00000000 <sub>B</sub> |
| 0026 <sub>H</sub>                            | PDRE                  | Port E data register  | R/W | 00000000 <sub>B</sub> |
| 0027 <sub>H</sub>                            | DDRE                  | Port E direction register                                     | R/W | 00000000 <sub>B</sub> |
| 0028 <sub>H</sub><br>to<br>002C <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 002D <sub>H</sub>                            | PUL1                  | Port 1 pull-up register                                       | R/W | 00000000 <sub>B</sub> |
| 002E <sub>H</sub>                            | PUL2                  | Port 2 pull-up register                                       | R/W | 00000000 <sub>B</sub> |
| 002F <sub>H</sub>                            | PUL3                  | Port 3 pull-up register                                       | R/W | 00000000 <sub>B</sub> |
| 0030 <sub>H</sub>                            | PUL4                  | Port 4 pull-up register                                       | R/W | 00000000 <sub>B</sub> |
| 0031 <sub>H</sub>                            | PUL5                  | Port 5 pull-up register                                       | R/W | 00000000 <sub>B</sub> |
| 0032 <sub>H</sub>                            | PUL7                  | Port 7 pull-up register                                       | R/W | 00000000 <sub>B</sub> |
| 0033 <sub>H</sub><br>to<br>0035 <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0036 <sub>H</sub>                            | T01CR1                | 8/16-bit compound timer 01 control status register 1 ch.0     | R/W | 00000000 <sub>B</sub> |
| 0037 <sub>H</sub>                            | T00CR1                | 8/16-bit compound timer 00 control status register 1 ch.0     | R/W | 00000000 <sub>B</sub> |
| 0038 <sub>H</sub>                            | T11CR1                | 8/16-bit compound timer 11 control status register 1 ch.1     | R/W | 00000000 <sub>B</sub> |
| 0039 <sub>H</sub>                            | T10CR1                | 8/16-bit compound timer 10 control status register 1 ch.1     | R/W | 00000000 <sub>B</sub> |
| 003A <sub>H</sub>                            | PC01                  | 8/16-bit PPG1 control register ch.0                           | R/W | 00000000 <sub>B</sub> |
| 003B <sub>H</sub>                            | PC00                  | 8/16-bit PPG0 control register ch.0                           | R/W | 00000000 <sub>B</sub> |
| 003C <sub>H</sub>                            | PC11                  | 8/16-bit PPG1 control register ch.1                           | R/W | 00000000 <sub>B</sub> |
| 003D <sub>H</sub>                            | PC10                  | 8/16-bit PPG0 control register ch.1                           | R/W | 00000000 <sub>B</sub> |
| 003E <sub>H</sub>                            | TMCSRH0               | 16-bit reload timer control status register (upper byte) ch.0 | R/W | 00000000 <sub>B</sub> |
| 003F <sub>H</sub>                            | TMCSRL0               | 16-bit reload timer control status register (lower byte) ch.0 | R/W | 00000000 <sub>B</sub> |
| 0040 <sub>H</sub> ,<br>0041 <sub>H</sub>     | —                     | (Disabled)  | —   | —                     |
| 0042 <sub>H</sub>                            | PCNTH0                | 16-bit PPG status control register (upper byte) ch.0          | R/W | 00000000 <sub>B</sub> |
| 0043 <sub>H</sub>                            | PCNTL0                | 16-bit PPG status control register (lower byte) ch.0          | R/W | 00000000 <sub>B</sub> |
| 0044 <sub>H</sub>                            | PCNTH1                | 16-bit PPG status control register (upper byte) ch.1          | R/W | 00000000 <sub>B</sub> |
| 0045 <sub>H</sub>                            | PCNTL1                | 16-bit PPG status control register (lower byte) ch.1          | R/W | 00000000 <sub>B</sub> |
| 0046 <sub>H</sub> ,<br>0047 <sub>H</sub>     | —                     | (Disabled)  | —   | —                     |
| 0048 <sub>H</sub>                            | EIC00                 | External interrupt circuit control register ch.0/ch.1         | R/W | 00000000 <sub>B</sub> |
| 0049 <sub>H</sub>                            | EIC10                 | External interrupt circuit control register ch.2/ch.3         | R/W | 00000000 <sub>B</sub> |

(Continued)

# MB95120MB Series

| Address                                      | Register abbreviation | Register name   | R/W | Initial value         |
|--|-----------------------|---|-----|-----------------------|
| 004A <sub>H</sub>                            | EIC20                 | External interrupt circuit control register ch.4/ch.5   | R/W | 00000000 <sub>B</sub> |
| 004B <sub>H</sub>                            | EIC30                 | External interrupt circuit control register ch.6/ch.7   | R/W | 00000000 <sub>B</sub> |
| 004C <sub>H</sub>                            | EIC01                 | External interrupt circuit control register ch.8/ch.9   | R/W | 00000000 <sub>B</sub> |
| 004D <sub>H</sub>                            | EIC11                 | External interrupt circuit control register ch.10/ch.11 | R/W | 00000000 <sub>B</sub> |
| 004E <sub>H</sub> ,<br>004F <sub>H</sub>     | —                     | (Disabled)  | —   | —                     |
| 0050 <sub>H</sub>                            | SCR                   | LIN-UART serial control register                        | R/W | 00000000 <sub>B</sub> |
| 0051 <sub>H</sub>                            | SMR                   | LIN-UART serial mode register                           | R/W | 00000000 <sub>B</sub> |
| 0052 <sub>H</sub>                            | SSR                   | LIN-UART serial status register                         | R/W | 00001000 <sub>B</sub> |
| 0053 <sub>H</sub>                            | RDR/TDR               | LIN-UART reception/transmission data register           | R/W | 00000000 <sub>B</sub> |
| 0054 <sub>H</sub>                            | ESCR                  | LIN-UART extended status control register               | R/W | 00000100 <sub>B</sub> |
| 0055 <sub>H</sub>                            | ECCR                  | LIN-UART extended communication control register        | R/W | 000000XX <sub>B</sub> |
| 0056 <sub>H</sub>                            | SMC10                 | UART/SIO serial mode control register 1 ch.0            | R/W | 00000000 <sub>B</sub> |
| 0057 <sub>H</sub>                            | SMC20                 | UART/SIO serial mode control register 2 ch.0            | R/W | 00100000 <sub>B</sub> |
| 0058 <sub>H</sub>                            | SSR0                  | UART/SIO serial status register ch.0                    | R/W | 00000001 <sub>B</sub> |
| 0059 <sub>H</sub>                            | TDR0                  | UART/SIO serial output data register ch.0               | R/W | 00000000 <sub>B</sub> |
| 005A <sub>H</sub>                            | RDR0                  | UART/SIO serial input data register ch.0                | R   | 00000000 <sub>B</sub> |
| 005B <sub>H</sub><br>to<br>005F <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0060 <sub>H</sub>                            | IBCR00                | I <sup>2</sup> C bus control register 0 ch.0            | R/W | 00000000 <sub>B</sub> |
| 0061 <sub>H</sub>                            | IBCR10                | I <sup>2</sup> C bus control register 1 ch.0            | R/W | 00000000 <sub>B</sub> |
| 0062 <sub>H</sub>                            | IBSR0                 | I <sup>2</sup> C bus status register ch.0               | R   | 00000000 <sub>B</sub> |
| 0063 <sub>H</sub>                            | IDDR0                 | I <sup>2</sup> C data register ch.0                     | R/W | 00000000 <sub>B</sub> |
| 0064 <sub>H</sub>                            | IAAR0                 | I <sup>2</sup> C address register ch.0                  | R/W | 00000000 <sub>B</sub> |
| 0065 <sub>H</sub>                            | ICCR0                 | I <sup>2</sup> C clock control register ch.0            | R/W | 00000000 <sub>B</sub> |
| 0066 <sub>H</sub><br>to<br>006B <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 006C <sub>H</sub>                            | ADC1                  | 8/10-bit A/D converter control register 1               | R/W | 00000000 <sub>B</sub> |
| 006D <sub>H</sub>                            | ADC2                  | 8/10-bit A/D converter control register 2               | R/W | 00000000 <sub>B</sub> |
| 006E <sub>H</sub>                            | ADDH                  | 8/10-bit A/D converter data register (upper byte)       | R/W | 00000000 <sub>B</sub> |
| 006F <sub>H</sub>                            | ADDL                  | 8/10-bit A/D converter data register (lower byte)       | R/W | 00000000 <sub>B</sub> |
| 0070 <sub>H</sub>                            | WCSR                  | Watch counter status register                           | R/W | 00000000 <sub>B</sub> |
| 0071 <sub>H</sub>                            | —                     | (Disabled)  | —   | —                     |
| 0072 <sub>H</sub>                            | FSR                   | Flash memory status register                            | R/W | 000X0000 <sub>B</sub> |

(Continued)

# MB95120MB Series

| Address                                      | Register abbreviation | Register name  | R/W | Initial value         |
|--|-----------------------|--|-----|-----------------------|
| 0073 <sub>H</sub>                            | SWRE0                 | Flash memory sector writing control register 0                     | R/W | 00000000 <sub>B</sub> |
| 0074 <sub>H</sub>                            | SWRE1                 | Flash memory sector writing control register 1                     | R/W | 00000000 <sub>B</sub> |
| 0075 <sub>H</sub>                            | —                     | (Disabled)   | —   | —                     |
| 0076 <sub>H</sub>                            | WREN                  | Wild register address compare enable register                      | R/W | 00000000 <sub>B</sub> |
| 0077 <sub>H</sub>                            | WROR                  | Wild register data test setting register                           | R/W | 00000000 <sub>B</sub> |
| 0078 <sub>H</sub>                            | —                     | Register bank pointer (RP) ,<br>Mirror of direct bank pointer (DP) | —   | —                     |
| 0079 <sub>H</sub>                            | ILR0                  | Interrupt level setting register 0                                 | R/W | 11111111 <sub>B</sub> |
| 007A <sub>H</sub>                            | ILR1                  | Interrupt level setting register 1                                 | R/W | 11111111 <sub>B</sub> |
| 007B <sub>H</sub>                            | ILR2                  | Interrupt level setting register 2                                 | R/W | 11111111 <sub>B</sub> |
| 007C <sub>H</sub>                            | ILR3                  | Interrupt level setting register 3                                 | R/W | 11111111 <sub>B</sub> |
| 007D <sub>H</sub>                            | ILR4                  | Interrupt level setting register 4                                 | R/W | 11111111 <sub>B</sub> |
| 007E <sub>H</sub>                            | ILR5                  | Interrupt level setting register 5                                 | R/W | 11111111 <sub>B</sub> |
| 007F <sub>H</sub>                            | —                     | (Disabled)   | —   | —                     |
| 0F80 <sub>H</sub>                            | WRARH0                | Wild register address setting register (upper byte) ch.0           | R/W | 00000000 <sub>B</sub> |
| 0F81 <sub>H</sub>                            | WRARL0                | Wild register address setting register (lower byte) ch.0           | R/W | 00000000 <sub>B</sub> |
| 0F82 <sub>H</sub>                            | WRDR0                 | Wild register data setting register ch.0                           | R/W | 00000000 <sub>B</sub> |
| 0F83 <sub>H</sub>                            | WRARH1                | Wild register address setting register (upper byte) ch.1           | R/W | 00000000 <sub>B</sub> |
| 0F84 <sub>H</sub>                            | WRARL1                | Wild register address setting register (lower byte) ch.1           | R/W | 00000000 <sub>B</sub> |
| 0F85 <sub>H</sub>                            | WRDR1                 | Wild register data setting register ch.1                           | R/W | 00000000 <sub>B</sub> |
| 0F86 <sub>H</sub>                            | WRARH2                | Wild register address setting register (upper byte) ch.2           | R/W | 00000000 <sub>B</sub> |
| 0F87 <sub>H</sub>                            | WRARL2                | Wild register address setting register (lower byte) ch.2           | R/W | 00000000 <sub>B</sub> |
| 0F88 <sub>H</sub>                            | WRDR2                 | Wild register data setting register ch.2                           | R/W | 00000000 <sub>B</sub> |
| 0F89 <sub>H</sub><br>to<br>0F91 <sub>H</sub> | —                     | (Disabled)   | —   | —                     |
| 0F92 <sub>H</sub>                            | T01CR0                | 8/16-bit compound timer 01 control status register 0 ch.0          | R/W | 00000000 <sub>B</sub> |
| 0F93 <sub>H</sub>                            | T00CR0                | 8/16-bit compound timer 00 control status register 0 ch.0          | R/W | 00000000 <sub>B</sub> |
| 0F94 <sub>H</sub>                            | T01DR                 | 8/16-bit compound timer 01 data register ch.0                      | R/W | 00000000 <sub>B</sub> |
| 0F95 <sub>H</sub>                            | T00DR                 | 8/16-bit compound timer 00 data register ch.0                      | R/W | 00000000 <sub>B</sub> |
| 0F96 <sub>H</sub>                            | TMCR0                 | 8/16-bit compound timer 00/01 timer mode control register<br>ch.0  | R/W | 00000000 <sub>B</sub> |
| 0F97 <sub>H</sub>                            | T11CR0                | 8/16-bit compound timer 11 control status register 0 ch.1          | R/W | 00000000 <sub>B</sub> |
| 0F98 <sub>H</sub>                            | T10CR0                | 8/16-bit compound timer 10 control status register 0 ch.1          | R/W | 00000000 <sub>B</sub> |
| 0F99 <sub>H</sub>                            | T11DR                 | 8/16-bit compound timer 11 data register ch.1                      | R/W | 00000000 <sub>B</sub> |
| 0F9A <sub>H</sub>                            | T10DR                 | 8/16-bit compound timer 10 data register ch.1                      | R/W | 00000000 <sub>B</sub> |

(Continued)

# MB95120MB Series

| Address                                      | Register abbreviation | Register name   | R/W | Initial value         |
|--|-----------------------|---|-----|-----------------------|
| 0F9B <sub>H</sub>                            | TMCR1                 | 8/16-bit compound timer 10/11 timer mode control register ch.1        | R/W | 00000000 <sub>B</sub> |
| 0F9C <sub>H</sub>                            | PPS01                 | 8/16-bit PPG1 cycle setting buffer register ch.0                      | R/W | 11111111 <sub>B</sub> |
| 0F9D <sub>H</sub>                            | PPS00                 | 8/16-bit PPG0 cycle setting buffer register ch.0                      | R/W | 11111111 <sub>B</sub> |
| 0F9E <sub>H</sub>                            | PDS01                 | 8/16-bit PPG1 duty setting buffer register ch.0                       | R/W | 11111111 <sub>B</sub> |
| 0F9F <sub>H</sub>                            | PDS00                 | 8/16-bit PPG0 duty setting buffer register ch.0                       | R/W | 11111111 <sub>B</sub> |
| 0FA0 <sub>H</sub>                            | PPS11                 | 8/16-bit PPG1 cycle setting buffer register ch.1                      | R/W | 11111111 <sub>B</sub> |
| 0FA1 <sub>H</sub>                            | PPS10                 | 8/16-bit PPG0 cycle setting buffer register ch.1                      | R/W | 11111111 <sub>B</sub> |
| 0FA2 <sub>H</sub>                            | PDS11                 | 8/16-bit PPG1 duty setting buffer register ch.1                       | R/W | 11111111 <sub>B</sub> |
| 0FA3 <sub>H</sub>                            | PDS10                 | 8/16-bit PPG0 duty setting buffer register ch.1                       | R/W | 11111111 <sub>B</sub> |
| 0FA4 <sub>H</sub>                            | PPGS                  | 8/16-bit PPG start register   | R/W | 00000000 <sub>B</sub> |
| 0FA5 <sub>H</sub>                            | REVC                  | 8/16-bit PPG output inversion register                                | R/W | 00000000 <sub>B</sub> |
| 0FA6 <sub>H</sub>                            | TMRH0/<br>TMRLRH0     | 16-bit reload timer timer/reload register (upper byte) ch.0           | R/W | 00000000 <sub>B</sub> |
| 0FA7 <sub>H</sub>                            | TMRL0/<br>TMRLRL0     | 16-bit reload timer timer/reload register (lower byte) ch.0           | R/W | 00000000 <sub>B</sub> |
| 0FA8 <sub>H</sub> ,<br>0FA9 <sub>H</sub>     | —                     | (Disabled)  | —   | —                     |
| 0FAA <sub>H</sub>                            | PDCRH0                | 16-bit PPG down counter register (upper byte) ch.0                    | R   | 00000000 <sub>B</sub> |
| 0FAB <sub>H</sub>                            | PDCRL0                | 16-bit PPG down counter register (lower byte) ch.0                    | R   | 00000000 <sub>B</sub> |
| 0FAC <sub>H</sub>                            | PCSRH0                | 16-bit PPG cycle setting buffer register (upper byte) ch.0            | R/W | 11111111 <sub>B</sub> |
| 0FAD <sub>H</sub>                            | PCSRL0                | 16-bit PPG cycle setting buffer register (lower byte) ch.0            | R/W | 11111111 <sub>B</sub> |
| 0FAE <sub>H</sub>                            | PDUTH0                | 16-bit PPG duty setting buffer register (upper byte) ch.0             | R/W | 11111111 <sub>B</sub> |
| 0FAF <sub>H</sub>                            | PDUTL0                | 16-bit PPG duty setting buffer register (lower byte) ch.0             | R/W | 11111111 <sub>B</sub> |
| 0FB0 <sub>H</sub>                            | PDCRH1                | 16-bit PPG down counter register (upper byte) ch.1                    | R   | 00000000 <sub>B</sub> |
| 0FB1 <sub>H</sub>                            | PDCRL1                | 16-bit PPG down counter register (lower byte) ch.1                    | R   | 00000000 <sub>B</sub> |
| 0FB2 <sub>H</sub>                            | PCSRH1                | 16-bit PPG cycle setting buffer register (upper byte) ch.1            | R/W | 11111111 <sub>B</sub> |
| 0FB3 <sub>H</sub>                            | PCSRL1                | 16-bit PPG cycle setting buffer register (lower byte) ch.1            | R/W | 11111111 <sub>B</sub> |
| 0FB4 <sub>H</sub>                            | PDUTH1                | 16-bit PPG duty setting buffer register (upper byte) ch.1             | R/W | 11111111 <sub>B</sub> |
| 0FB5 <sub>H</sub>                            | PDUTL1                | 16-bit PPG duty setting buffer register (lower byte) ch.1             | R/W | 11111111 <sub>B</sub> |
| 0FB6 <sub>H</sub><br>to<br>0FBB <sub>H</sub> | —                     | (Disabled)  | —   | —                     |
| 0FBC <sub>H</sub>                            | BGR1                  | LIN-UART baud rate generator register 1                               | R/W | 00000000 <sub>B</sub> |
| 0FBD <sub>H</sub>                            | BGR0                  | LIN-UART baud rate generator register 0                               | R/W | 00000000 <sub>B</sub> |
| 0FBE <sub>H</sub>                            | PSSR0                 | UART/SIO dedicated baud rate generator prescaler select register ch.0 | R/W | 00000000 <sub>B</sub> |

(Continued)

# MB95120MB Series

| Address              | Register abbreviation | Register name   | R/W | Initial value         |
|----------------------|-----------------------|---|-----|-----------------------|
| 0FBFH                | BRSR0                 | UART/SIO dedicated baud rate generator<br>baud rate setting register ch.0 | R/W | 00000000 <sub>B</sub> |
| 0FC0H,<br>0FC1H      | —                     | (Disabled)  | —   | —                     |
| 0FC2H                | AIDRH                 | A/D input disable register (upper byte)                                   | R/W | 00000000 <sub>B</sub> |
| 0FC3H                | AIDRL                 | A/D input disable register (lower byte)                                   | R/W | 00000000 <sub>B</sub> |
| 0FC4H                | LCDCC                 | LCDC control register   | R/W | 00010000 <sub>B</sub> |
| 0FC5H                | LCDCE1                | LCDC enable register 1  | R/W | 00110000 <sub>B</sub> |
| 0FC6H                | LCDCE2                | LCDC enable register 2  | R/W | 00000000 <sub>B</sub> |
| 0FC7H                | LCDCE3                | LCDC enable register 3  | R/W | 00000000 <sub>B</sub> |
| 0FC8H                | LCDCE4                | LCDC enable register 4  | R/W | 00000000 <sub>B</sub> |
| 0FC9H                | LCDCE5                | LCDC enable register 5  | R/W | 00000000 <sub>B</sub> |
| 0FCAH                | LCDCE6                | LCDC enable register 6  | R/W | 00000000 <sub>B</sub> |
| 0FCBH                | LCDCB1                | LCDC blinking setting register 1  | R/W | 00000000 <sub>B</sub> |
| 0FCH                 | LCDCB2                | LCDC blinking setting register 2  | R/W | 00000000 <sub>B</sub> |
| 0FCDH<br>to<br>0FE0H | LCDRAM                | LCDC display RAM  | R/W | 00000000 <sub>B</sub> |
| 0FE1H,<br>0FE2H      | —                     | (Disabled)  | —   | —                     |
| 0FE3H                | WCDR                  | Watch counter data register   | R/W | 00111111 <sub>B</sub> |
| 0FE4H,<br>0FE5H      | —                     | (Disabled)  | —   | —                     |
| 0FE6H                | ILSR3                 | Input level select register 3   | R/W | 00000000 <sub>B</sub> |
| 0FE7H                | ILSR2                 | Input level select register 2   | R/W | 00000000 <sub>B</sub> |
| 0FE8H,<br>0FE9H      | —                     | (Disabled)  | —   | —                     |
| 0FEAH                | CSVCR                 | Clock supervisor control register   | R/W | 00011100 <sub>B</sub> |
| 0FEBH<br>to<br>0FEDH | —                     | (Disabled)  | —   | —                     |
| 0FEEH                | ILSR                  | Input level select register   | R/W | 00000000 <sub>B</sub> |
| 0FEFH                | WICR                  | Interrupt pin select circuit control register                             | R/W | 01000000 <sub>B</sub> |
| 0FF0H<br>to<br>0FFFH | —                     | (Disabled)  | —   | —                     |

(Continued)

# MB95120MB Series

*(Continued)*

- R/W access symbols

R/W : Readable/Writable

R : Read only

W : Write only

- Initial value symbols

0 : The initial value of this bit is "0".

1 : The initial value of this bit is "1".

X : The initial value of this bit is undefined.


Note : Do not write to the " (Disabled) ". Reading the " (Disabled) " returns an undefined value.

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# MB95120MB Series

## ■ INTERRUPT SOURCE TABLE

| Interrupt source                     | Interrupt request number | Vector table address |                   | Bit name of interrupt level setting register | Same level priority order (at simultaneous occurrence)  |
|--------------------------------------|--------------------------|----------------------|-------------------|--|---|
|                                      |                          | Upper                | Lower             |  |   |
| External interrupt ch.0              | IRQ0                     | FFFA <sub>H</sub>    | FFFB <sub>H</sub> | L00 [1 : 0]                                  | High<br><br>Low |
| External interrupt ch.4              |                          |                      |                   |  |   |
| External interrupt ch.1              | IRQ1                     | FFF8 <sub>H</sub>    | FFF9 <sub>H</sub> | L01 [1 : 0]                                  |   |
| External interrupt ch.5              |                          |                      |                   |  |   |
| External interrupt ch.2              | IRQ2                     | FFF6 <sub>H</sub>    | FFF7 <sub>H</sub> | L02 [1 : 0]                                  |   |
| External interrupt ch.6              |                          |                      |                   |  |   |
| External interrupt ch.3              | IRQ3                     | FFF4 <sub>H</sub>    | FFF5 <sub>H</sub> | L03 [1 : 0]                                  |   |
| External interrupt ch.7              |                          |                      |                   |  |   |
| UART/SIO ch.0                        | IRQ4                     | FFF2 <sub>H</sub>    | FFF3 <sub>H</sub> | L04 [1 : 0]                                  |   |
| 8/16-bit compound timer ch.0 (Lower) | IRQ5                     | FFF0 <sub>H</sub>    | FFF1 <sub>H</sub> | L05 [1 : 0]                                  |   |
| 8/16-bit compound timer ch.0 (Upper) | IRQ6                     | FFEE <sub>H</sub>    | FFEF <sub>H</sub> | L06 [1 : 0]                                  |   |
| LIN-UART (reception)                 | IRQ7                     | FFEC <sub>H</sub>    | FFED <sub>H</sub> | L07 [1 : 0]                                  |   |
| LIN-UART (transmission)              | IRQ8                     | FFEA <sub>H</sub>    | FFEB <sub>H</sub> | L08 [1 : 0]                                  |   |
| 8/16-bit PPG ch.1 (Lower)            | IRQ9                     | FFE8 <sub>H</sub>    | FFE9 <sub>H</sub> | L09 [1 : 0]                                  |   |
| 8/16-bit PPG ch.1 (Upper)            | IRQ10                    | FFE6 <sub>H</sub>    | FFE7 <sub>H</sub> | L10 [1 : 0]                                  |   |
| 16-bit reload timer ch.0             | IRQ11                    | FFE4 <sub>H</sub>    | FFE5 <sub>H</sub> | L11 [1 : 0]                                  |   |
| 8/16-bit PPG ch.0 (Upper)            | IRQ12                    | FFE2 <sub>H</sub>    | FFE3 <sub>H</sub> | L12 [1 : 0]                                  |   |
| 8/16-bit PPG ch.0 (Lower)            | IRQ13                    | FFE0 <sub>H</sub>    | FFE1 <sub>H</sub> | L13 [1 : 0]                                  |   |
| 8/16-bit compound timer ch.1 (Upper) | IRQ14                    | FFDE <sub>H</sub>    | FFDF <sub>H</sub> | L14 [1 : 0]                                  |   |
| 16-bit PPG ch.0                      | IRQ15                    | FFDC <sub>H</sub>    | FFDD <sub>H</sub> | L15 [1 : 0]                                  |   |
| 1°C ch.0                             | IRQ16                    | FFDA <sub>H</sub>    | FFDB <sub>H</sub> | L16 [1 : 0]                                  |   |
| 16-bit PPG ch.1                      | IRQ17                    | FFD8 <sub>H</sub>    | FFD9 <sub>H</sub> | L17 [1 : 0]                                  |   |
| 8/10-bit A/D converter               | IRQ18                    | FFD6 <sub>H</sub>    | FFD7 <sub>H</sub> | L18 [1 : 0]                                  |   |
| Timebase timer                       | IRQ19                    | FFD4 <sub>H</sub>    | FFD5 <sub>H</sub> | L19 [1 : 0]                                  |   |
| Watch prescaler/watch counter        | IRQ20                    | FFD2 <sub>H</sub>    | FFD3 <sub>H</sub> | L20 [1 : 0]                                  |   |
| External interrupt ch.8              | IRQ21                    | FFD0 <sub>H</sub>    | FFD1 <sub>H</sub> | L21 [1 : 0]                                  |   |
| External interrupt ch.9              |                          |                      |                   |  |   |
| External interrupt ch.10             |                          |                      |                   |  |   |
| External interrupt ch.11             |                          |                      |                   |  |   |
| 8/16-bit compound timer ch.1 (Lower) | IRQ22                    | FFCE <sub>H</sub>    | FFCF <sub>H</sub> | L22 [1 : 0]                                  |   |
| Flash memory                         | IRQ23                    | FFCC <sub>H</sub>    | FFCD <sub>H</sub> | L23 [1 : 0]                                  |   |

# MB95120MB Series

## ■ ELECTRICAL CHARACTERISTICS

### 1. Absolute Maximum Ratings

| Parameter                              | Symbol                              | Rating                |                       | Unit | Remarks   |
|--|-------------------------------------|-----------------------|-----------------------|------|---|
|  |                                     | Min                   | Max                   |      |   |
| Power supply voltage*1                 | V <sub>CC</sub><br>AV <sub>CC</sub> | V <sub>SS</sub> - 0.3 | V <sub>SS</sub> + 6.0 | V    | *2  |
|  | AVR                                 | V <sub>SS</sub> - 0.3 | V <sub>SS</sub> + 6.0 |      | *2  |
| Power supply voltage for LCD           | V <sub>0</sub> to V <sub>3</sub>    | V <sub>SS</sub> - 0.3 | V <sub>SS</sub> + 6.0 | V    | *3  |
| Input voltage*1                        | V <sub>I</sub>                      | V <sub>SS</sub> - 0.3 | V <sub>SS</sub> + 6.0 | V    | *4  |
| Output voltage*1                       | V <sub>O</sub>                      | V <sub>SS</sub> - 0.3 | V <sub>SS</sub> + 6.0 | V    | *4  |
| Maximum clamp current                  | I <sub>CLAMP</sub>                  | - 2.0                 | + 2.0                 | mA   | Applicable to pins*5  |
| Total maximum clamp current            | Σ I <sub>CLAMP</sub>                | —                     | 20                    | mA   | Applicable to pins*5  |
| “L” level maximum output current       | I <sub>OL1</sub>                    | —                     | 15                    | mA   | Other than P00 to P07   |
|  | I <sub>OL2</sub>                    |                       | 15                    |      | P00 to P07  |
| “L” level average current              | I <sub>OLAV1</sub>                  | —                     | 4                     | mA   | Other than P00 to P07<br>Average output current =<br>operating current × operating ratio<br>(1 pin) |
|  | I <sub>OLAV2</sub>                  |                       | 12                    |      | P00 to P07<br>Average output current =<br>operating current × operating ratio<br>(1 pin)            |
| “L” level total maximum output current | ΣI <sub>OL</sub>                    | —                     | 100                   | mA   |   |
| “L” level total average output current | ΣI <sub>OLAV</sub>                  | —                     | 50                    | mA   | Total average output current =<br>operating current × operating ratio<br>(Total of pins)            |
| “H” level maximum output current       | I <sub>OH1</sub>                    | —                     | - 15                  | mA   | Other than P00 to P07   |
|  | I <sub>OH2</sub>                    |                       | - 15                  |      | P00 to P07  |
| “H” level average current              | I <sub>OHAV1</sub>                  | —                     | - 4                   | mA   | Other than P00 to P07<br>Average output current =<br>operating current × operating ratio<br>(1 pin) |
|  | I <sub>OHAV2</sub>                  |                       | - 8                   |      | P00 to P07<br>Average output current =<br>operating current × operating ratio<br>(1 pin)            |
| “H” level total maximum output current | ΣI <sub>OH</sub>                    | —                     | - 100                 | mA   |   |
| “H” level total average output current | ΣI <sub>OHAV</sub>                  | —                     | - 50                  | mA   | Total average output current =<br>operating current × operating ratio<br>(Total of pins)            |

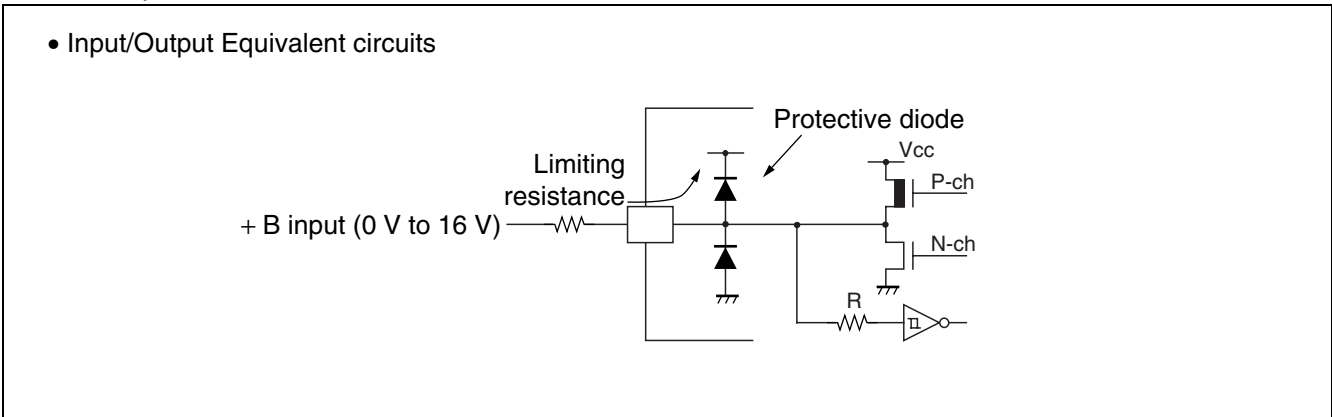
(Continued)

# MB95120MB Series

(Continued)

| Parameter             | Symbol         | Rating |       | Unit | Remarks |
|-----------------------|----------------|--------|-------|------|---------|
|                       |                | Min    | Max   |      |         |
| Power consumption     | Pd             | —      | 320   | mW   |         |
| Operating temperature | T <sub>A</sub> | - 40   | + 105 | °C   |         |
| Storage temperature   | Tstg           | - 55   | + 150 | °C   |         |

- \*1 : The parameter is based on AV<sub>SS</sub> = V<sub>SS</sub> = 0.0 V.
- \*2 : Apply equal potential to AV<sub>CC</sub> and V<sub>CC</sub>. AVR should not exceed AV<sub>CC</sub> + 0.3 V.
- \*3 : V<sub>0</sub> to V<sub>3</sub> should not exceed V<sub>CC</sub> + 0.3 V.
- \*4 : V<sub>I</sub> and V<sub>O</sub> should not exceed V<sub>CC</sub> + 0.3 V. V<sub>I</sub> must not exceed the rating voltage. However, if the maximum current to/from an input is limited by some means with external components, the I<sub>CLAMP</sub> rating supersedes the V<sub>I</sub> rating.
- \*5 : Applicable to pins : P00 to P07, P10 to P14, P20 to P24, P30 to P37, P40 to P43, P52, P53
  - Use within recommended operating conditions.
  - Use at DC voltage (current).
  - +B signal is an input signal that exceeds V<sub>CC</sub> voltage. The + B signal should always be applied a limiting resistance placed between the + B signal and the microcontroller.
  - The value of the limiting resistance should be set so that when the + B signal is applied the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
  - Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the V<sub>CC</sub> pin, and this affects other devices.
  - Note that if the + B signal is inputted when the microcontroller power supply is off (not fixed at 0 V), the power supply is provided from the pins, so that incomplete operation may result.
  - Note that if the + B input is applied during power-on, the power supply is provided from the pins and the resulting power supply voltage may not be sufficient to operate the power-on reset.
  - Care must be taken not to leave the + B input pin open.
  - Note that analog system input/output pins other than the A/D input pins (LCD drive pins, etc.) cannot accept +B signal input.
  - Sample recommended circuits :



**WARNING:** Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

# MB95120MB Series

## 2. Recommended Operating Conditions

( $AV_{SS} = V_{SS} = 0.0$  V)

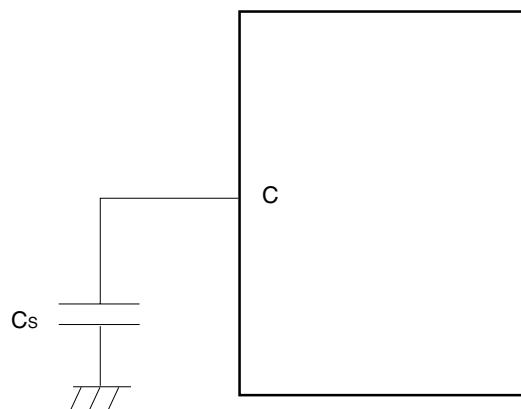
| Parameter                             | Symbol            | Condition | Value                 |                   | Unit        | Remarks   |                           |
|---------------------------------------|-------------------|-----------|-----------------------|-------------------|-------------|---|---------------------------|
|                                       |                   |           | Min                   | Max               |             |   |                           |
| Power supply voltage                  | $V_{CC}, AV_{CC}$ | —         | 2.42 <sup>*1,*2</sup> | 5.5 <sup>*1</sup> | V           | In normal operating   | Other than MB95FV100D-103 |
|                                       |                   |           | 2.3                   | 5.5               |             | Hold condition in STOP mode   |                           |
|                                       |                   |           | 2.7                   | 5.5               |             | In normal operating   | MB95FV100D-103            |
|                                       |                   |           | 2.3                   | 5.5               |             | Hold condition in STOP mode   |                           |
| Power supply voltage for LCD          | V0 to V3          | —         | $V_{SS}$              | $V_{CC}$          | V           | The range of liquid crystal power supply (The optimal value depends on liquid crystal display elements used.) |                           |
| A/D converter reference input voltage | AVR               | —         | 4.0                   | $AV_{CC}$         | V           |   |                           |
| Smoothing capacitor                   | $C_s$             | —         | 0.1                   | 1.0               | $\mu F$     | *3  |                           |
| Operating temperature                 | $T_A$             | —         | - 40                  | + 105             | $^{\circ}C$ | Other than MB95FV100D-103   |                           |
|                                       |                   |           | + 5                   | + 35              | $^{\circ}C$ | MB95FV100D-103  |                           |

\*1 : The values vary with the operating frequency, machine clock or analog guarantee range.

\*2 : The value is 2.88 V when the low voltage detection reset is used.

\*3 : Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. A bypass capacitor of  $V_{CC}$  pin must have a capacitor value higher than  $C_s$ . For connection of smoothing capacitor  $C_s$ , refer to the diagram below.

- C pin connection diagram



**WARNING:** The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

# MB95120MB Series

## 3. DC Characteristics

( $V_{CC} = AV_{CC} = 5.0\text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

| Parameter               | Symbol     | Pin name   | Condition | Value          |     |                | Unit | Remarks   |
|-------------------------|------------|--|-----------|----------------|-----|----------------|------|---|
|                         |            |  |           | Min            | Typ | Max            |      |   |
| "H" level input voltage | $V_{IH1}$  | P10 (selectable at UI0), P67 (selectable at SIN)   | —         | $0.7 V_{CC}$   | —   | $V_{CC} + 0.3$ | V    | Hysteresis input (When selecting CMOS input level)  |
|                         | $V_{IH2}$  | P50, P51 (selectable at I <sup>2</sup> C)  | —         | $0.7 V_{CC}$   | —   | $V_{SS} + 5.5$ | V    |   |
|                         | $V_{IHA}$  | P00 to P07, P10 to P14, P20 to P24, P30 to P37, P40 to P43, P50 to P53, P60 to P67, P70, P71, P90 to P95, PA0 to PA3, PB0 to PB7, PC0 to PC7, PD0 to PD7, PE0 to PE7 | —         | $0.8 V_{CC}$   | —   | $V_{CC} + 0.3$ | V    | Port inputs if Automotive input levels are selected |
|                         | $V_{IHS1}$ | P00 to P07, P10 to P14, P20 to P24, P30 to P37, P40 to P43, P50 to P53, P60 to P67, P70, P71, P90 to P95, PA0 to PA3, PB0 to PB7, PC0 to PC7, PD0 to PD7, PE0 to PE7 | —         | $0.8 V_{CC}$   | —   | $V_{CC} + 0.3$ | V    | Hysteresis input                                    |
|                         | $V_{IHS2}$ | P50, P51   | —         | $0.8 V_{CC}$   | —   | $V_{SS} + 5.5$ | V    |   |
|                         | $V_{IHM}$  | $\overline{\text{RST}}$ , MOD  | —         | $0.7 V_{CC}$   | —   | $V_{CC} + 0.3$ | V    | CMOS input (Flash memory product)                   |
| "L" level input voltage | $V_{IL}$   | P10 (selectable at UI0), P50, P51 (selectable at I <sup>2</sup> C) P67 (selectable at SIN)   | —         | $V_{SS} - 0.3$ | —   | $0.3 V_{CC}$   | V    | Hysteresis input (When selecting CMOS input level)  |
|                         | $V_{ILA}$  | P00 to P07, P10 to P14, P20 to P24, P30 to P37, P40 to P43, P50 to P53, P60 to P67, P70, P71, P90 to P95, PA0 to PA3, PB0 to PB7, PC0 to PC7, PD0 to PD7, PE0 to PE7 | —         | $V_{SS} - 0.3$ | —   | $0.5 V_{CC}$   | V    | Port inputs if Automotive input levels are selected |

(Continued)

# MB95120MB Series

( $V_{CC} = AV_{CC} = 5.0 \text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0 \text{ V}$ ,  $T_A = -40 \text{ }^\circ\text{C}$  to  $+105 \text{ }^\circ\text{C}$ )

| Parameter   | Symbol     | Pin name   | Condition                                      | Value          |     |                | Unit          | Remarks                                |
|---|------------|--|--|----------------|-----|----------------|---------------|--|
|   |            |  |  | Min            | Typ | Max            |               |  |
| “L” level input voltage                             | $V_{ILS}$  | P00 to P07<br>P10 to P14,<br>P20 to P24,<br>P30 to P37,<br>P40 to P43,<br>P50 to P53,<br>P60 to P67,<br>P70, P71,<br>P90 to P95,<br>PA0 to PA3,<br>PB0 to PB7,<br>PC0 to PC7,<br>PD0 to PD7,<br>PE0 to PE7 | —  | $V_{SS} - 0.3$ | —   | $0.2 V_{CC}$   | V             | Hysteresis input                       |
|   | $V_{ILM}$  | $\overline{RST}$ , MOD   | —  | $V_{SS} - 0.3$ | —   | $0.3 V_{CC}$   | V             | CMOS input<br>(Flash memory product)   |
|   |            |  | —  | $V_{SS} - 0.3$ | —   | $0.2 V_{CC}$   | V             | Hysteresis input<br>(MASK ROM product) |
| Open-drain output application voltage               | $V_{D1}$   | P50, P51   | —  | $V_{SS} - 0.3$ | —   | $V_{SS} + 5.5$ | V             |  |
| “H” level output voltage                            | $V_{OH1}$  | Output pin other than P00 to P07   | $I_{OH} = -4.0 \text{ mA}$                     | $V_{CC} - 0.5$ | —   | —              | V             |  |
|   | $V_{OH2}$  | P00 to P07   | $I_{OH} = -8.0 \text{ mA}$                     | $V_{CC} - 0.5$ | —   | —              | V             |  |
| “L” level output voltage                            | $V_{OL1}$  | Output pin other than P00 to P07, $\overline{RST}^{*1}$  | $I_{OL} = 4.0 \text{ mA}$                      | —              | —   | 0.4            | V             |  |
|   | $V_{OL2}$  | P00 to P07   | $I_{OL} = 12 \text{ mA}$                       | —              | —   | 0.4            | V             |  |
| Input leakage current (Hi-Z output leakage current) | $I_{LI}$   | Port other than P50, P51   | $0.0 \text{ V} < V_I < V_{CC}$                 | -5             | —   | +5             | $\mu\text{A}$ | When the pull-up prohibition setting   |
| Open-drain output leakage current                   | $I_{LIOD}$ | P50, P51   | $0.0 \text{ V} < V_I < V_{SS} + 5.5 \text{ V}$ | —              | —   | 5              | $\mu\text{A}$ |  |

(Continued)

# MB95120MB Series

( $V_{CC} = AV_{CC} = 5.0\text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

| Parameter              | Symbol     | Pin name  | Condition   | Value |      |      | Unit          | Remarks  |
|------------------------|------------|---|---|-------|------|------|---------------|--|
|                        |            |   |   | Min   | Typ  | Max  |               |  |
| Pull-up resistor       | $R_{PULL}$ | P10 to P14,<br>P20 to P24,<br>P30 to P37,<br>P40 to P43,<br>P52, P53,<br>P70, P71 | $V_i = 0.0\text{ V}$  | 25    | 50   | 100  | $k\Omega$     | When the pull-up permission setting                                      |
| Pull-down resistor     | $R_{MOD}$  | MOD   | $V_i = V_{CC}$  | 50    | 100  | 200  | $k\Omega$     | MASK ROM product only  |
| Input capacitance      | $C_{IN}$   | Other than $AV_{CC}$ ,<br>$AV_{SS}$ , AVR, $V_{CC}$ ,<br>$V_{SS}$                 | $f = 1\text{ MHz}$  | —     | 5    | 15   | $\mu\text{F}$ |  |
| Power supply current*2 | $I_{CC}$   | $V_{CC}$<br>(External clock operation)  | $F_{CH} = 20\text{ MHz}$<br>$F_{MP} = 10\text{ MHz}$<br>Main clock mode<br>(divided by 2) | —     | 9.5  | 12.5 | $\text{mA}$   | Flash memory product<br>(at other than Flash memory writing and erasing) |
|                        |            |   |   | —     | 30.0 | 35.0 | $\text{mA}$   | Flash memory product<br>(at Flash memory writing and erasing)            |
|                        |            |   |   | —     | 7.2  | 9.5  | $\text{mA}$   | MASK ROM product   |
|                        |            |   | $F_{CH} = 32\text{ MHz}$<br>$F_{MP} = 16\text{ MHz}$<br>Main clock mode<br>(divided by 2) | —     | 15.2 | 20.0 | $\text{mA}$   | Flash memory product<br>(at other than Flash memory writing and erasing) |
|                        |            |   |   | —     | 35.7 | 42.5 | $\text{mA}$   | Flash memory product<br>(at Flash memory writing and erasing)            |
|                        |            |   |   | —     | 11.6 | 15.2 | $\text{mA}$   | MASK ROM product   |

(Continued)

# MB95120MB Series

( $V_{CC} = AV_{CC} = 5.0\text{ V}$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

| Parameter              | Symbol              | Pin name                                      | Condition   | Value |      |      | Unit | Remarks              |
|------------------------|---------------------|---|---|-------|------|------|------|----------------------|
|                        |                     |   |   | Min   | Typ  | Max  |      |                      |
| Power supply current*2 | I <sub>CCS</sub>    | V <sub>CC</sub><br>(External clock operation) | F <sub>CH</sub> = 20 MHz<br>F <sub>MP</sub> = 10 MHz<br>Main Sleep mode<br>(divided by 2)     | —     | 4.5  | 7.5  | mA   |                      |
|                        |                     |   | F <sub>CH</sub> = 32 MHz<br>F <sub>MP</sub> = 16 MHz<br>Main Sleep mode<br>(divided by 2)     | —     | 7.2  | 12.0 | mA   |                      |
|                        | I <sub>CCCL</sub>   |   | F <sub>CL</sub> = 32 kHz<br>F <sub>MPL</sub> = 16 kHz<br>Sub clock mode<br>(divided by 2)     | —     | 45   | 100  | μA   |                      |
|                        | I <sub>CCLS</sub>   |   | F <sub>CL</sub> = 32 kHz<br>F <sub>MPL</sub> = 16 kHz<br>Sub sleep mode<br>(divided by 2)     | —     | 10   | 81   | μA   |                      |
|                        | I <sub>CCCT</sub>   |   | F <sub>CL</sub> = 32 kHz<br>Watch mode<br>Main stop mode<br>T <sub>A</sub> = +25 °C           | —     | 4.6  | 27.0 | μA   |                      |
|                        | I <sub>CCMPLL</sub> |   | F <sub>CH</sub> = 4 MHz<br>F <sub>MP</sub> = 10 MHz<br>Main PLL mode<br>(multiplied by 2.5)   | —     | 9.3  | 12.5 | mA   | Flash memory product |
|                        |                     |   |   | —     | 7.0  | 9.5  | mA   | MASK ROM product     |
|                        |                     |   | F <sub>CH</sub> = 6.4 MHz<br>F <sub>MP</sub> = 16 MHz<br>Main PLL mode<br>(multiplied by 2.5) | —     | 14.9 | 20.0 | mA   | Flash memory product |
|                        |                     |   |   | —     | 11.2 | 15.2 | mA   | MASK ROM product     |

(Continued)



# MB95120MB Series

(Continued)

( $V_{CC} = AV_{CC} = 5.0\text{ V}$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

| Parameter                        | Symbol              | Pin name                                      | Condition   | Value |      |      | Unit | Remarks |
|----------------------------------|---------------------|---|---|-------|------|------|------|---------|
|                                  |                     |   |   | Min   | Typ  | Max  |      |         |
| Power supply current*2           | I <sub>CCSPLL</sub> | V <sub>CC</sub><br>(External clock operation) | F <sub>CL</sub> = 32 kHz<br>F <sub>MPL</sub> = 128 kHz<br>Sub PLL mode<br>(multiplied by 4),<br>T <sub>A</sub> = +25 °C | —     | 160  | 400  | μA   |         |
|                                  | I <sub>CTS</sub>    |   | F <sub>CH</sub> = 10 MHz<br>Timebase timer mode<br>T <sub>A</sub> = +25 °C  | —     | 0.40 | 1.10 | mA   |         |
|                                  | I <sub>CCH</sub>    |   | Sub stop mode<br>T <sub>A</sub> = +25 °C  | —     | 3.5  | 20   | μA   |         |
|                                  | I <sub>A</sub>      | AV <sub>CC</sub>                              | F <sub>CH</sub> = 16 MHz<br>At operating of A/D conversion  | —     | 2.4  | 4.7  | mA   |         |
|                                  | I <sub>AH</sub>     |   | F <sub>CH</sub> = 16 MHz<br>At stopping of A/D conversion<br>T <sub>A</sub> = +25 °C                                    | —     | 1    | 5    | μA   |         |
| LCD internal division resistance | R <sub>LCD</sub>    | —   | Between V3 and V <sub>SS</sub>  | —     | 300  | —    | kΩ   |         |
| COM0 to COM3 output impedance    | R <sub>VCOM</sub>   | COM0 to COM3                                  | V1 to V3 = 3.6 V  | —     | —    | 5    | kΩ   |         |
| SEG00 to SEG39 output impedance  | R <sub>VSEG</sub>   | SEG00 to SEG39                                | —   | —     | —    | 7    | kΩ   |         |
| LCD leak current                 | I <sub>LCDL</sub>   | V0 to V3,<br>COM0 to COM3<br>SEG00 to SEG39   | —   | -1    | —    | +1   | μA   |         |

\*1 : Product without clock supervisor only.

\*2 : • The power-supply current is determined by the external clock. When both low voltage detection option and clock supervisor are selected, the power-supply current will be a value of adding current consumption of the low voltage detection circuit (I<sub>LVD</sub>) and current consumption of built-in CR oscillator (I<sub>CSV</sub>) to the specified value.

- Refer to “4. AC Characteristics (1) Clock Timing” for F<sub>CH</sub> and F<sub>CL</sub>.
- Refer to “4. AC Characteristics (2) Source Clock/Machine Clock” for F<sub>MP</sub> and F<sub>MPL</sub>.

# MB95120MB Series

## 4. AC Characteristics

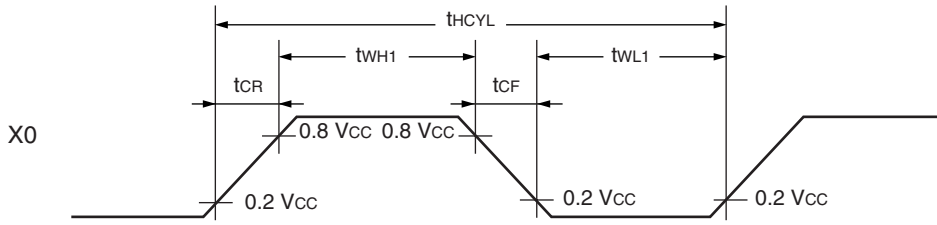
### (1) Clock Timing

( $V_{CC} = 2.42\text{ V to } 5.5\text{ V}$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C to } +105\text{ }^\circ\text{C}$ )

| Parameter                           | Symbol                               | Pin name | Condition | Value |        |       | Unit   | Remarks  |
|-------------------------------------|--------------------------------------|----------|-----------|-------|--------|-------|--|--|
|                                     |                                      |          |           | Min   | Typ    | Max   |  |  |
| Clock frequency                     | F <sub>CH</sub>                      | X0, X1   | —         | 1.00  | —      | 16.25 | MHz  | When using main oscillation circuit                            |
|                                     |                                      |          |           | 1.00  | —      | 32.50 | MHz  | When using external clock                                      |
|                                     |                                      |          |           | 3.00  | —      | 10.00 | MHz  | Main PLL multiplied by 1                                       |
|                                     |                                      |          |           | 3.00  | —      | 8.13  | MHz  | Main PLL multiplied by 2                                       |
|                                     |                                      |          |           | 3.00  | —      | 6.50  | MHz  | Main PLL multiplied by 2.5                                     |
|                                     |                                      |          |           | 3.00  | —      | 4.06  | MHz  | Main PLL multiplied by 4                                       |
|                                     | F <sub>CL</sub>                      | X0A, X1A |           | —     | 32.768 | —     | kHz  | When using sub oscillation circuit                             |
|                                     |                                      |          |           | —     | 32.768 | —     | kHz  | When using sub PLL<br>$V_{CC} = 2.3\text{ V to } 3.6\text{ V}$ |
| Clock cycle time                    | t <sub>H CYL</sub>                   | X0, X1   | 61.5      | —     | 1000   | ns    | When using main oscillation circuit                          |  |
|                                     |                                      |          | 30.8      | —     | 1000   | ns    | When using external clock                                    |  |
|                                     | t <sub>L CYL</sub>                   | X0A, X1A | —         | 30.5  | —      | μs    | When using sub oscillation circuit                           |  |
| Input clock pulse width             | t <sub>WH1</sub><br>t <sub>WL1</sub> | X0       | 61.5      | —     | —      | ns    | When using external clock<br>Duty ratio is about 30% to 70%. |  |
|                                     | t <sub>WH2</sub><br>t <sub>WL2</sub> | X0A      | —         | 15.2  | —      | μs    |  |  |
| Input clock rise time and fall time | t <sub>CR</sub><br>t <sub>CF</sub>   | X0, X0A  | —         | —     | 5      | ns    | When using external clock                                    |  |

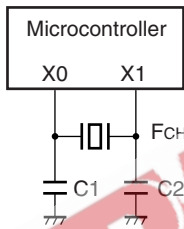
# MB95120MB Series

- Input wave form for using external clock (main clock)

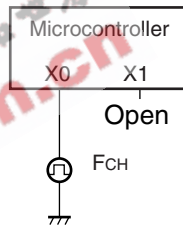


- Figure of Main Clock Input Port External Connection

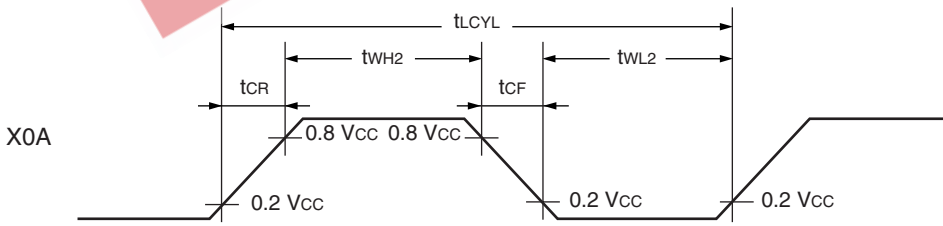
When using a crystal or ceramic oscillator



When using external clock

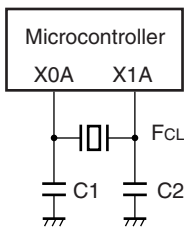


- Input wave form for using external clock (sub clock)

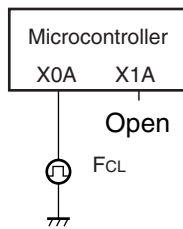


- Figure of Sub clock Input Port External Connection

When using a crystal or ceramic oscillator



When using external clock



# MB95120MB Series

## (2) Source Clock/Machine Clock

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

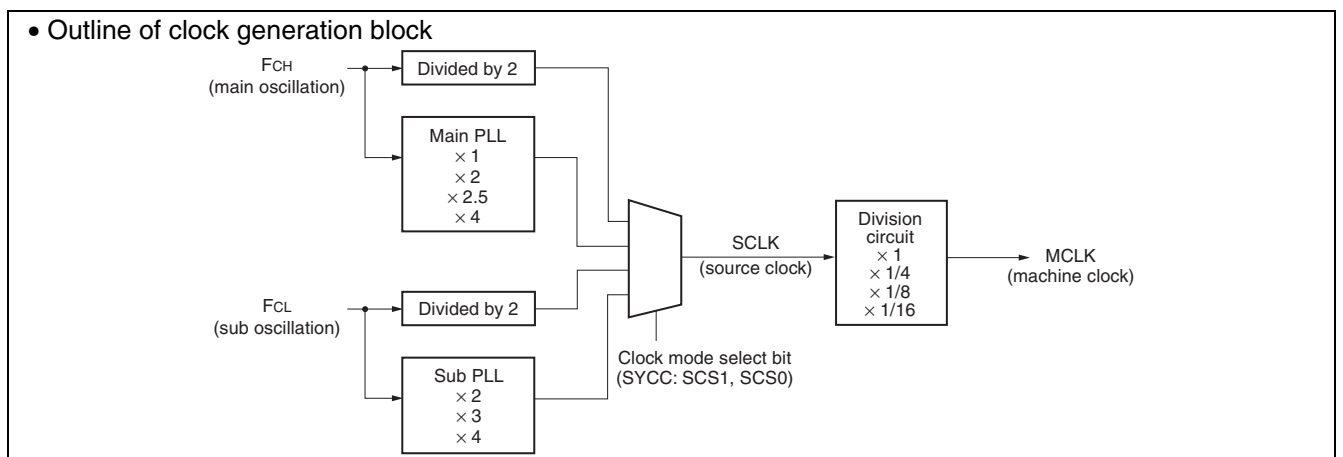
| Parameter  | Symbol     | Condition | Value  |         | Unit          | Remarks   |
|--|------------|-----------|--------|---------|---------------|---|
|  |            |           | Min    | Max     |               |   |
| Source clock cycle time*1<br>(Clock before setting division)       | $t_{SCLK}$ | —         | 61.5   | 2000    | ns            | When using main clock<br>Min : $F_{CH} = 8.125\text{ MHz}$ ,<br>PLL multiplied by 2<br>Max : $F_{CH} = 1\text{ MHz}$ , divided by 2 |
|  |            |           | 7.6    | 61.0    | $\mu\text{s}$ | When using sub clock<br>Min : $F_{CL} = 32\text{ kHz}$ ,<br>PLL multiplied by 4<br>Max : $F_{CL} = 32\text{ kHz}$ , divided by 2    |
| Source clock frequency   | $F_{SP}$   | —         | 0.50   | 16.25   | MHz           | When using main clock   |
|  | $F_{SPL}$  |           | 16.384 | 131.072 | kHz           | When using sub clock  |
| Machine clock cycle time*2<br>(Minimum instruction execution time) | $t_{MCLK}$ | —         | 61.5   | 32000   | ns            | When using main clock<br>Min : $F_{SP} = 16.25\text{ MHz}$ , no division<br>Max : $F_{SP} = 0.5\text{ MHz}$ , divided by 16         |
|  |            |           | 7.6    | 976.5   | $\mu\text{s}$ | When using sub clock<br>Min : $F_{SPL} = 131\text{ kHz}$ , no division<br>Max : $F_{SPL} = 16\text{ kHz}$ , divided by 16           |
| Machine clock frequency  | $F_{MP}$   | —         | 0.031  | 16.250  | MHz           | When using main clock   |
|  | $F_{MPL}$  |           | 1.024  | 131.072 | kHz           | When using sub clock  |

\*1 : Clock before setting division due to machine clock division ratio selection bit (SYCC : DIV1 and DIV0) . This source clock is divided by the machine clock division ratio selection bit (SYCC : DIV1 and DIV0) , and it becomes the machine clock. Further, the source clock can be selected as follows.

- Main clock divided by 2
- PLL multiplication of main clock (select from 1, 2, 2.5, 4 multiplication)
- Sub clock divided by 2
- PLL multiplication of sub clock (select from 2, 3, 4 multiplication)

\*2 : Operation clock of the microcontroller. Machine clock can be selected as follows.

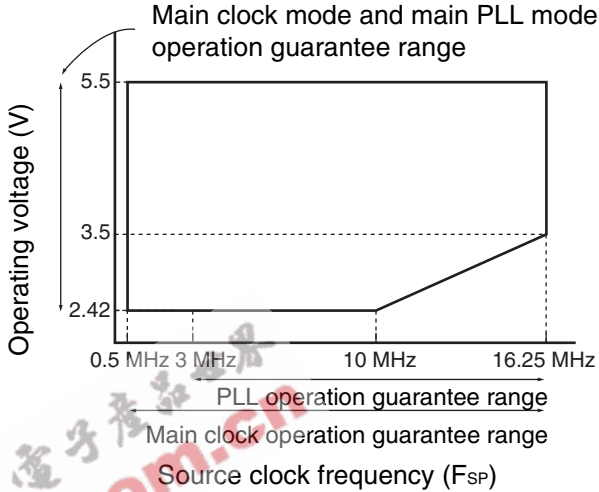
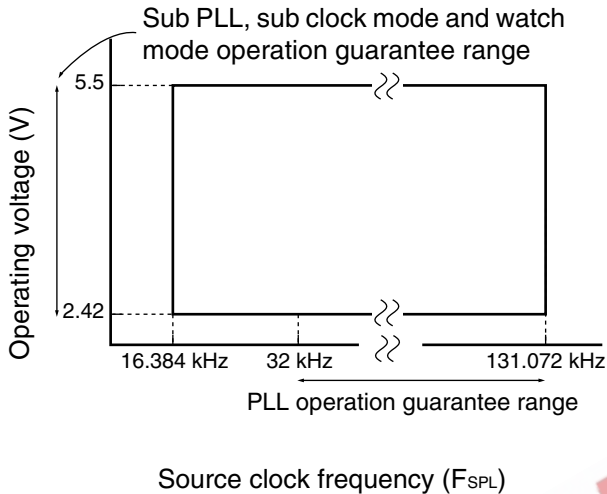
- Source clock (no division)
- Source clock divided by 4
- Source clock divided by 8
- Source clock divided by 16



# MB95120MB Series

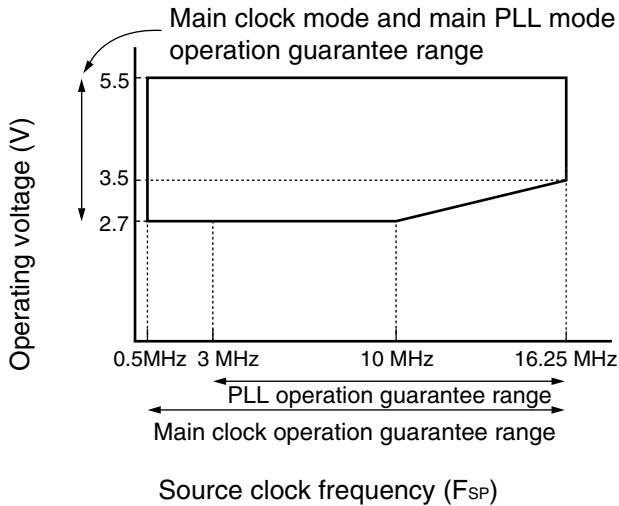
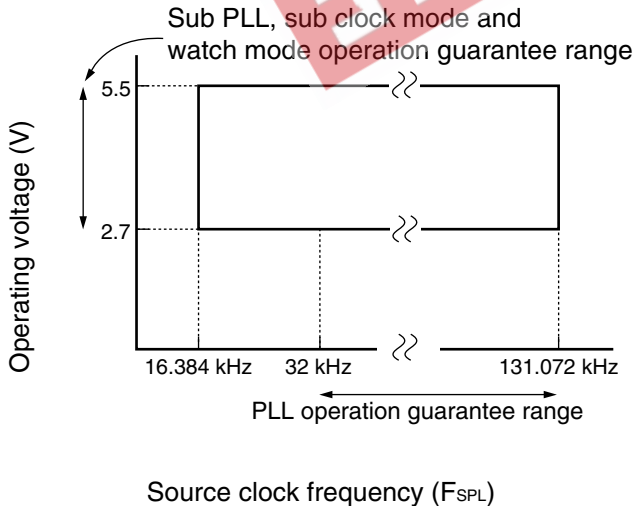
**• Operating voltage - Operating frequency ( $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )**

- MB95F124MB/F124NB/F124JB/F126MB/F126NB/F126JB/F128MB/F128NB/F128JB

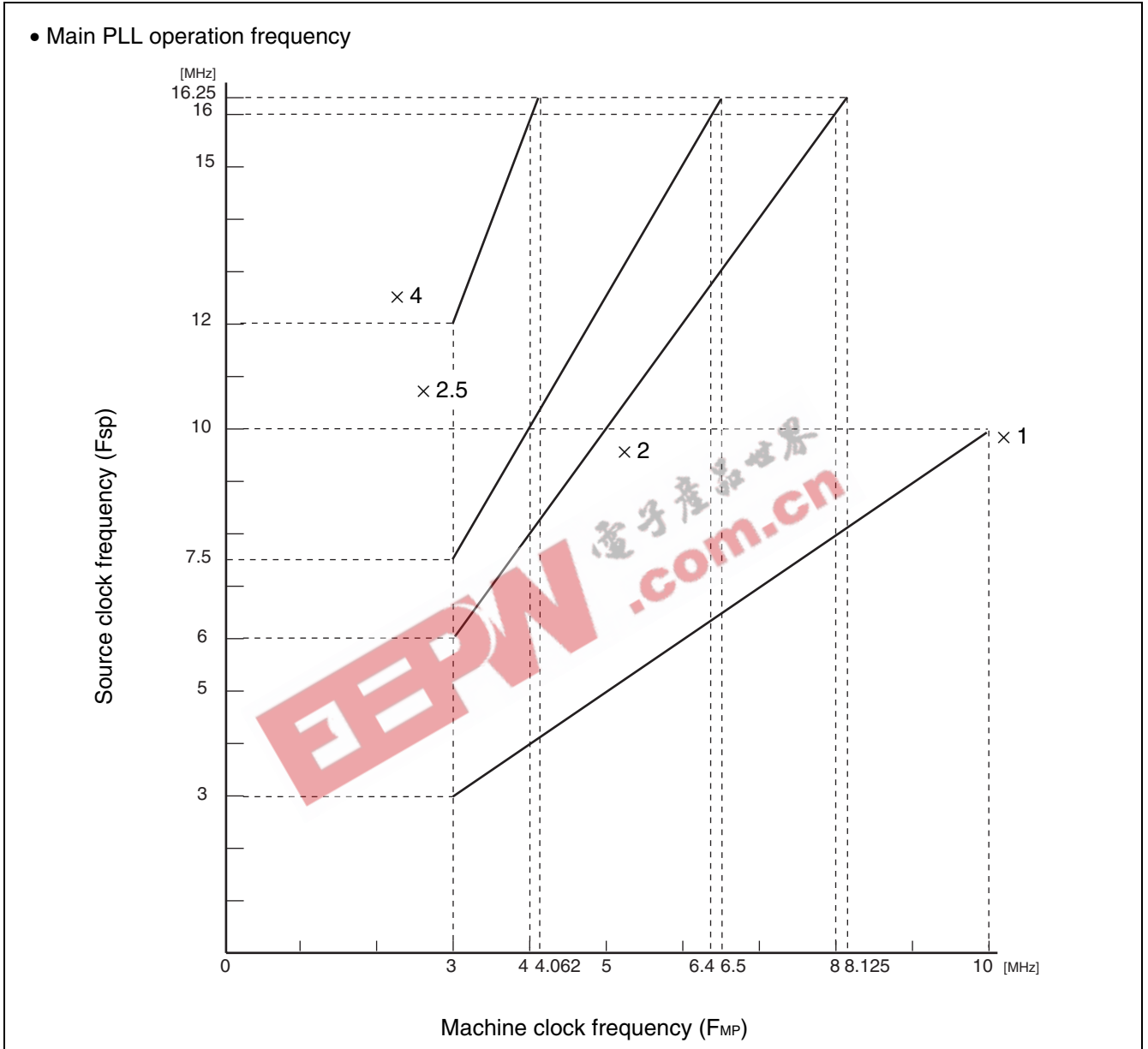


**• Operating voltage - Operating frequency ( $T_A = +5\text{ }^\circ\text{C}$  to  $+35\text{ }^\circ\text{C}$ )**

- MB95FV100D-103



# MB95120MB Series



# MB95120MB Series

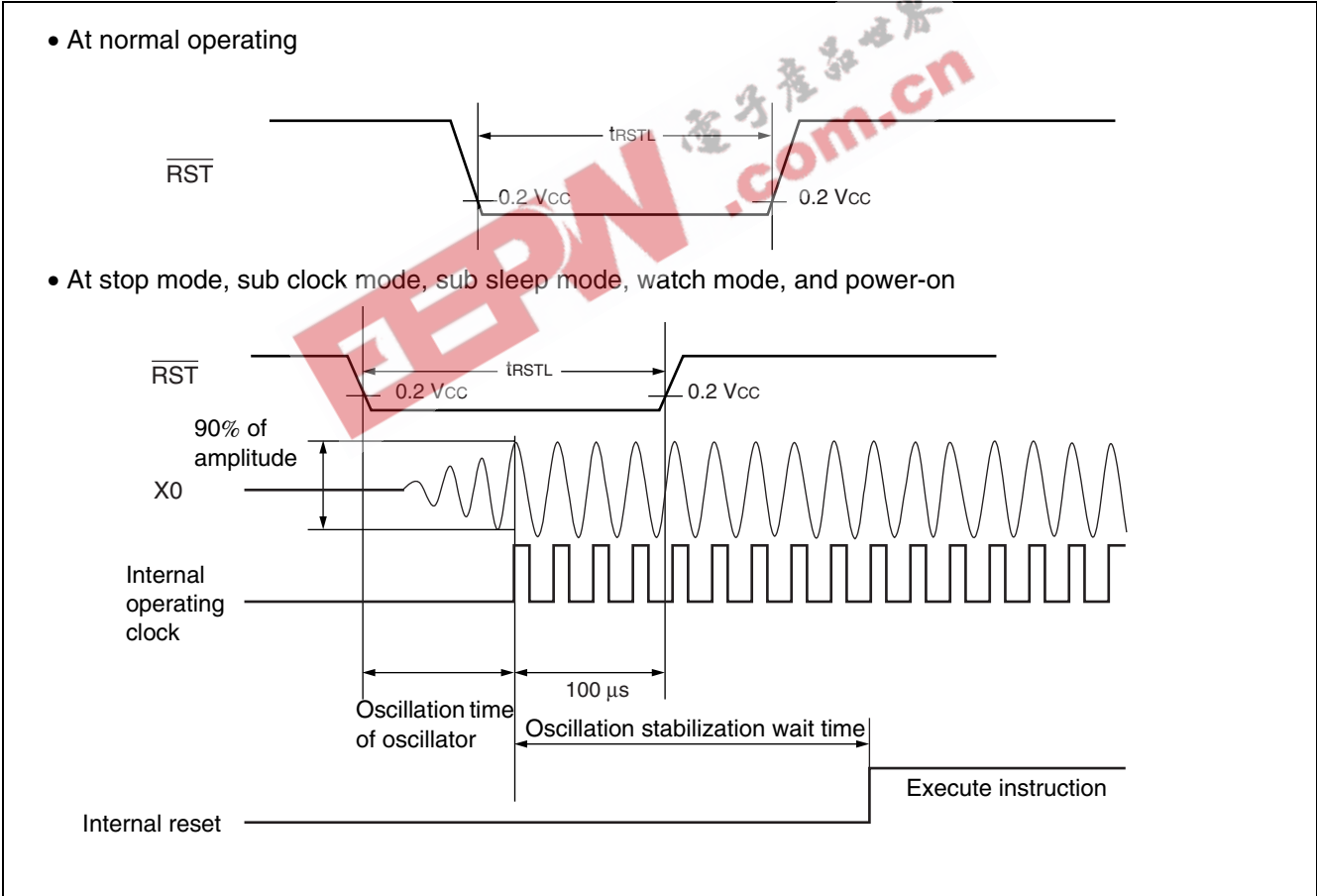
**(3) External Reset**

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

| Parameter                                     | Symbol            | Pin name                | Condition | Value  |     | Unit          | Remarks  |
|---|-------------------|-------------------------|-----------|--|-----|---------------|--|
|   |                   |                         |           | Min  | Max |               |  |
| $\overline{\text{RST}}$ "L" level pulse width | $t_{\text{RSTL}}$ | $\overline{\text{RST}}$ | —         | $2 t_{\text{MCLK}}^{*1}$                           | —   | ns            | At normal operating  |
|   |                   |                         |           | Oscillation time of oscillator <sup>*2</sup> + 100 | —   | $\mu\text{s}$ | At stop mode, sub clock mode, sub sleep mode, and watch mode |
|   |                   |                         |           | 100  | —   |               | At timebase timer mode                                       |

\*1 : Refer to “ (2) Source Clock/Machine Clock” for  $t_{\text{MCLK}}$ .

\*2 : Oscillation start time of oscillator is the time that the amplitude reaches 90 %. In the crystal oscillator, the oscillation time is between several ms and tens of ms. In ceramic oscillators, the oscillation time is between hundreds of  $\mu\text{s}$  and several ms. In the external clock, the oscillation time is 0 ms.

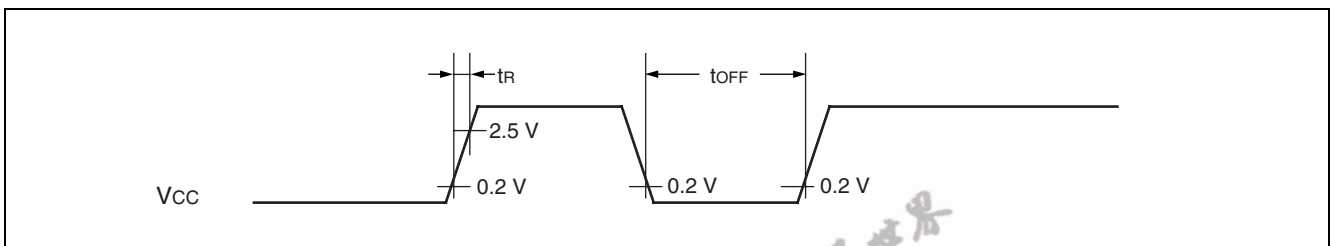


# MB95120MB Series

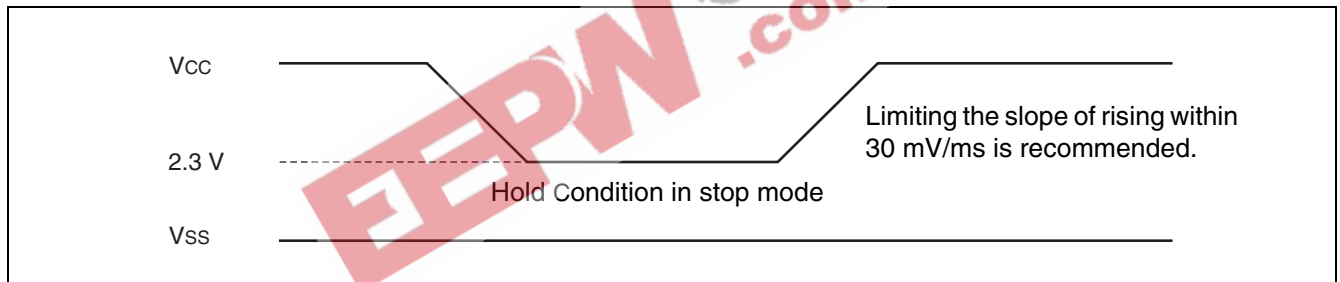
## (4) Power-on Reset

( $V_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

| Parameter                | Symbol    | Pin name | Condition | Value |     | Unit | Remarks                     |
|--------------------------|-----------|----------|-----------|-------|-----|------|-----------------------------|
|                          |           |          |           | Min   | Max |      |                             |
| Power supply rising time | $t_R$     | $V_{CC}$ | —         | —     | 50  | ms   |                             |
| Power supply cutoff time | $t_{OFF}$ |          | —         | 1     | —   | ms   | Waiting time until power-on |



Note : Sudden change of power supply voltage may activate the power-on reset function. When changing power supply voltages during operation, set the slope of rising within 30 mV/ms as shown below.





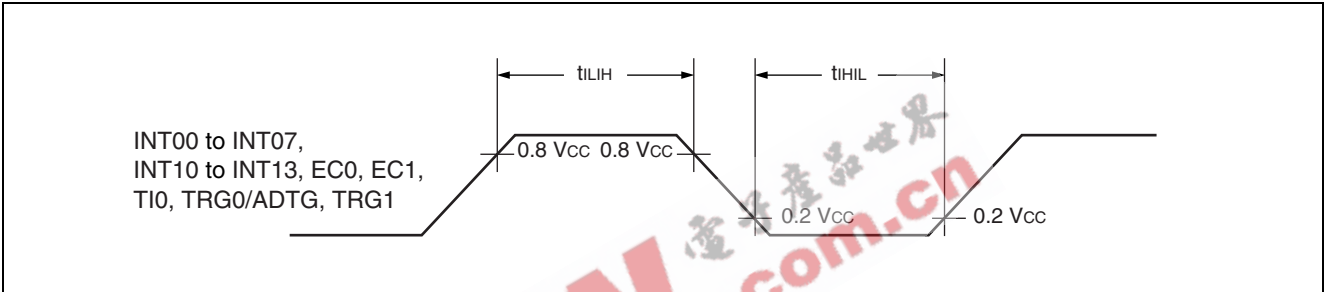
# MB95120MB Series

## (5) Peripheral Input Timing

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

| Parameter                        | Symbol    | Pin name   | Condition | Value          |     | Unit |
|----------------------------------|-----------|--|-----------|----------------|-----|------|
|                                  |           |  |           | Min            | Max |      |
| Peripheral input "H" pulse width | $t_{LIH}$ | INT00 to INT07,<br>INT10 to INT13,<br>EC0, EC1, TI0,<br>TRG0/ADTG,<br>TRG1 | —         | $2 t_{MCLK}^*$ | —   | ns   |
| Peripheral input "L" pulse width | $t_{HIL}$ |  |           | $2 t_{MCLK}^*$ | —   | ns   |

\* : Refer to "(2) Source Clock/Machine Clock" for  $t_{MCLK}$ .



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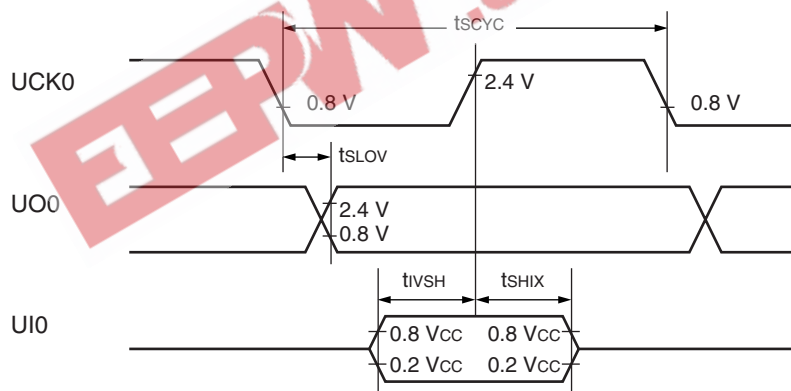
## (6) UART/SIO, Serial I/O Timing

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

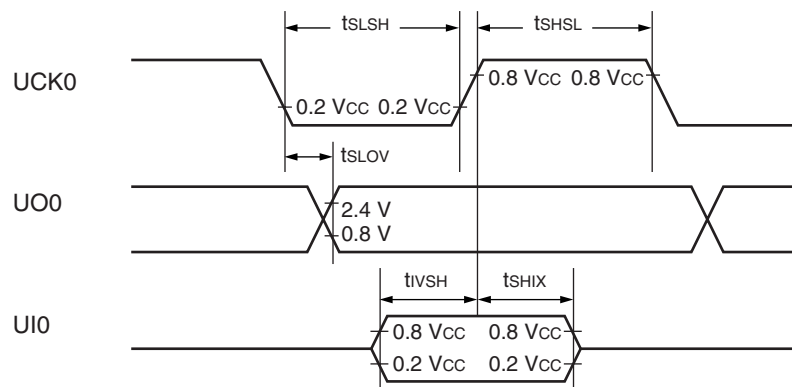
| Parameter                    | Symbol     | Pin name  | Condition   | Value          |      | Unit |
|------------------------------|------------|-----------|---|----------------|------|------|
|                              |            |           |   | Min            | Max  |      |
| Serial clock cycle time      | $t_{SCYC}$ | UCK0      | Internal clock operation output pin : $C_L = 80\text{ pF} + 1\text{ TTL}$ . | $4 t_{MCLK}^*$ | —    | ns   |
| UCK ↓ → UO time              | $t_{SLOV}$ | UCK0, UO0 |   | - 190          | +190 | ns   |
| Valid UI → UCK ↑             | $t_{IVSH}$ | UCK0, UI0 |   | $2 t_{MCLK}^*$ | —    | ns   |
| UCK ↑ → valid UI hold time   | $t_{SHIX}$ | UCK0, UI0 |   | $2 t_{MCLK}^*$ | —    | ns   |
| Serial clock "H" pulse width | $t_{SHSL}$ | UCK0      | External clock operation output pin : $C_L = 80\text{ pF} + 1\text{ TTL}$ . | $4 t_{MCLK}^*$ | —    | ns   |
| Serial clock "L" pulse width | $t_{SLSH}$ | UCK0      |   | $4 t_{MCLK}^*$ | —    | ns   |
| UCK ↓ → UO time              | $t_{SLOV}$ | UCK0, UO0 |   | 0              | 190  | ns   |
| Valid UI → UCK ↑             | $t_{IVSH}$ | UCK0, UI0 |   | $2 t_{MCLK}^*$ | —    | ns   |
| UCK ↑ → valid UI hold time   | $t_{SHIX}$ | UCK0, UI0 |   | $2 t_{MCLK}^*$ | —    | ns   |

\* : Refer to "(2) Source Clock/Machine Clock" for  $t_{MCLK}$ .

### • Internal shift clock mode



### • External shift clock mode



# MB95120MB Series

## (7) LIN-UART Timing

Sampling at the rising edge of sampling clock\*1 and prohibited serial clock delay\*2  
(ESCR register : SCES bit = 0, ECCR register : SCDE bit = 0)

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

| Parameter                    | Symbol      | Pin name | Condition   | Value                   |                        | Unit |
|------------------------------|-------------|----------|---|-------------------------|------------------------|------|
|                              |             |          |   | Min                     | Max                    |      |
| Serial clock cycle time      | $t_{SCYC}$  | SCK      | Internal clock<br>operation output pin :<br>$C_L = 80\text{ pF} + 1\text{ TTL}$ . | $5 t_{MCLK}^{*3}$       | —                      | ns   |
| SCK ↓ → SOT delay time       | $t_{SLOVI}$ | SCK, SOT |   | -95                     | +95                    | ns   |
| Valid SIN → SCK ↑            | $t_{IVSHI}$ | SCK, SIN |   | $t_{MCLK}^{*3} + 190$   | —                      | ns   |
| SCK ↑ → valid SIN hold time  | $t_{SHIXI}$ | SCK, SIN |   | 0                       | —                      | ns   |
| Serial clock "L" pulse width | $t_{SLSH}$  | SCK      | External clock<br>operation output pin :<br>$C_L = 80\text{ pF} + 1\text{ TTL}$ . | $3 t_{MCLK}^{*3} - t_R$ | —                      | ns   |
| Serial clock "H" pulse width | $t_{SHSL}$  | SCK      |   | $t_{MCLK}^{*3} + 95$    | —                      | ns   |
| SCK ↓ → SOT delay time       | $t_{SLOVE}$ | SCK, SOT |   | —                       | $2 t_{MCLK}^{*3} + 95$ | ns   |
| Valid SIN → SCK ↑            | $t_{IVSHE}$ | SCK, SIN |   | 190                     | —                      | ns   |
| SCK ↑ → valid SIN hold time  | $t_{SHIXE}$ | SCK, SIN |   | $t_{MCLK}^{*3} + 95$    | —                      | ns   |
| SCK fall time                | $t_F$       | SCK      |   | —                       | 10                     | ns   |
| SCK rise time                | $t_R$       | SCK      |   | —                       | 10                     | ns   |

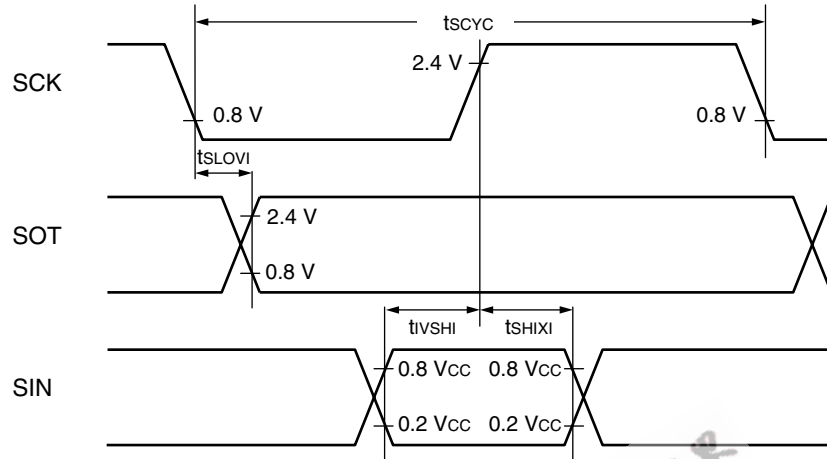
\*1 : Provide switch function whether sampling of reception data is performed at rising edge or falling edge of the serial clock.

\*2 : Serial clock delay function is used to delay half clock for the output signal of serial clock.

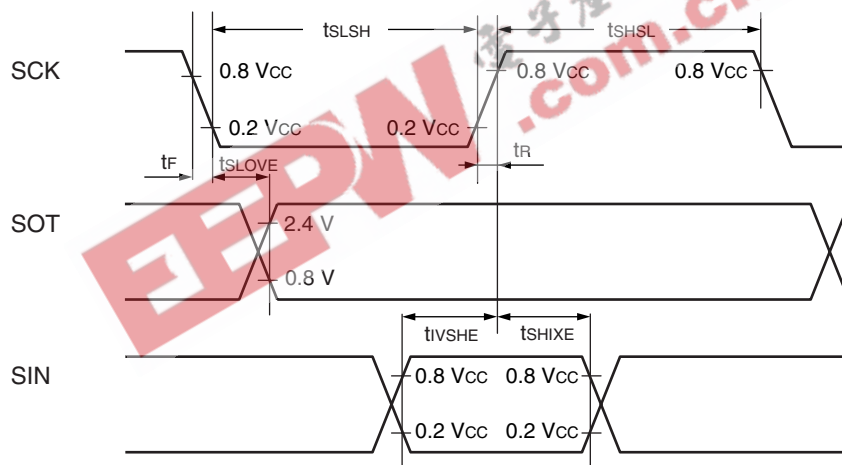
\*3 : Refer to " (2) Source Clock/Machine Clock" for  $t_{MCLK}$ .

# MB95120MB Series

- Internal shift clock mode



- External shift clock mode



# MB95120MB Series

Sampling at the falling edge of sampling clock\*1 and prohibited serial clock delay\*2  
(ESCR register : SCES bit = 1, ECCR register : SCDE bit = 0)

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

| Parameter  | Symbol      | Pin name | Condition   | Value                   |                        | Unit |
|--|-------------|----------|---|-------------------------|------------------------|------|
|  |             |          |   | Min                     | Max                    |      |
| Serial clock cycle time                            | $t_{SCYC}$  | SCK      | Internal clock<br>operation output pin :<br>$C_L = 80\text{ pF} + 1\text{ TTL}$ . | $5 t_{MCLK}^{*3}$       | —                      | ns   |
| SCK $\uparrow$ $\rightarrow$ SOT delay time        | $t_{SHOVI}$ | SCK, SOT |   | -95                     | +95                    | ns   |
| Valid SIN $\rightarrow$ SCK $\downarrow$           | $t_{IVSLI}$ | SCK, SIN |   | $t_{MCLK}^{*3} + 190$   | —                      | ns   |
| SCK $\downarrow$ $\rightarrow$ valid SIN hold time | $t_{SLIXI}$ | SCK, SIN |   | 0                       | —                      | ns   |
| Serial clock "H" pulse width                       | $t_{SHSL}$  | SCK      | External clock<br>operation output pin :<br>$C_L = 80\text{ pF} + 1\text{ TTL}$ . | $3 t_{MCLK}^{*3} - t_R$ | —                      | ns   |
| Serial clock "L" pulse width                       | $t_{SLSH}$  | SCK      |   | $t_{MCLK}^{*3} + 95$    | —                      | ns   |
| SCK $\uparrow$ $\rightarrow$ SOT delay time        | $t_{SHOVE}$ | SCK, SOT |   | —                       | $2 t_{MCLK}^{*3} + 95$ | ns   |
| Valid SIN $\rightarrow$ SCK $\downarrow$           | $t_{IVSLE}$ | SCK, SIN |   | 190                     | —                      | ns   |
| SCK $\downarrow$ $\rightarrow$ valid SIN hold time | $t_{SLIXE}$ | SCK, SIN |   | $t_{MCLK}^{*3} + 95$    | —                      | ns   |
| SCK fall time                                      | $t_F$       | SCK      |   | —                       | 10                     | ns   |
| SCK rise time                                      | $t_R$       | SCK      |   | —                       | 10                     | ns   |

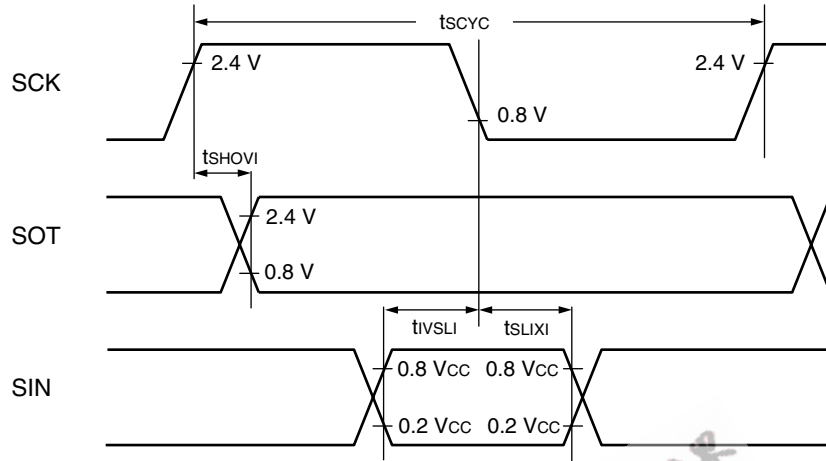
\*1 : Provide switch function whether sampling of reception data is performed at rising edge or falling edge of the serial clock.

\*2 : Serial clock delay function is used to delay half clock for the output signal of serial clock.

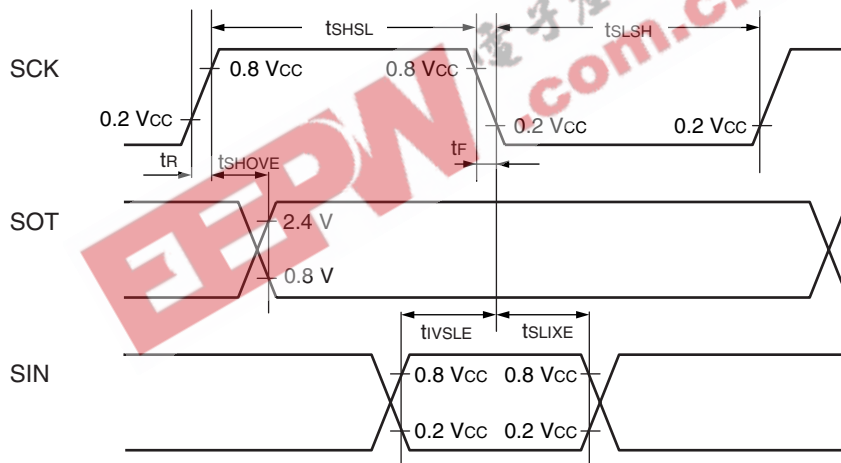
\*3 : Refer to "(2) Source Clock/Machine Clock" for  $t_{MCLK}$ .

# MB95120MB Series

- Internal shift clock mode



- External shift clock mode



# MB95120MB Series

Sampling at the rising edge of sampling clock\*1 and enabled serial clock delay\*2  
 (ESCR register : SCES bit = 0, ECCR register : SCDE bit = 1)

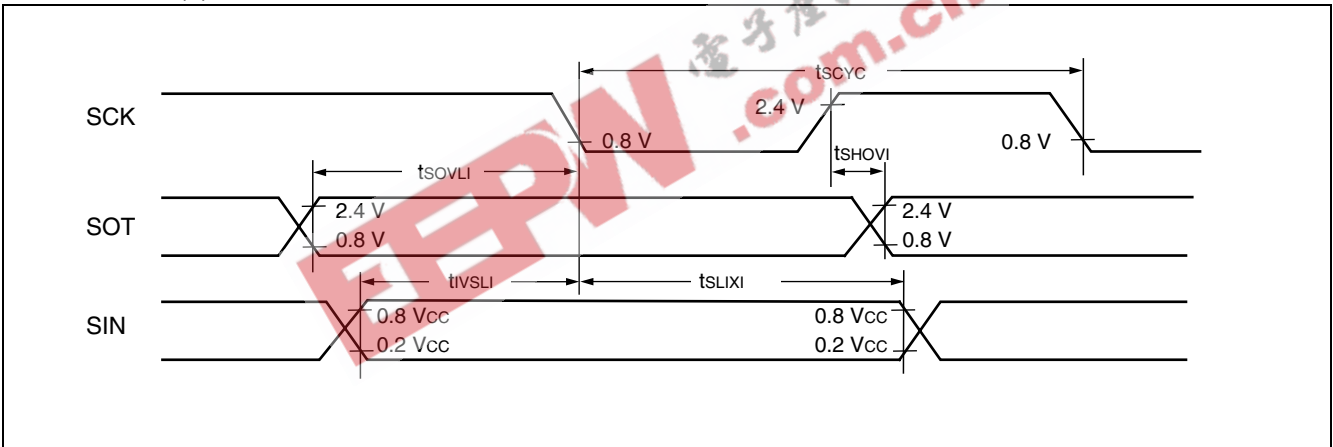
( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

| Parameter  | Symbol      | Pin name | Condition  | Value                 |                   | Unit |
|--|-------------|----------|--|-----------------------|-------------------|------|
|  |             |          |  | Min                   | Max               |      |
| Serial clock cycle time                            | $t_{SCYC}$  | SCK      | Internal clock<br>operation output pin :<br>$C_L = 80\text{ pF} + 1\text{ TTL.}$ | $5 t_{MCLK}^{*3}$     | —                 | ns   |
| SCK $\uparrow$ $\rightarrow$ SOT delay time        | $t_{SHOVI}$ | SCK, SOT |  | -95                   | +95               | ns   |
| Valid SIN $\rightarrow$ SCK $\downarrow$           | $t_{IVSLI}$ | SCK, SIN |  | $t_{MCLK}^{*3} + 190$ | —                 | ns   |
| SCK $\downarrow$ $\rightarrow$ valid SIN hold time | $t_{SLIXI}$ | SCK, SIN |  | 0                     | —                 | ns   |
| SOT $\rightarrow$ SCK $\downarrow$ delay time      | $t_{SOVLI}$ | SCK, SOT |  | —                     | $4 t_{MCLK}^{*3}$ | ns   |

\*1 : Provide switch function whether sampling of reception data is performed at rising edge or falling edge of the serial clock.

\*2 : Serial clock delay function is used to delay half clock for the output signal of serial clock.

\*3 : Refer to “(2) Source Clock/Machine Clock” for  $t_{MCLK}$ .



# MB95120MB Series

Sampling at the falling edge of sampling clock\*1 and enabled serial clock delay\*2  
 (ESCR register : SCES bit = 1, ECCR register : SCDE bit = 1)

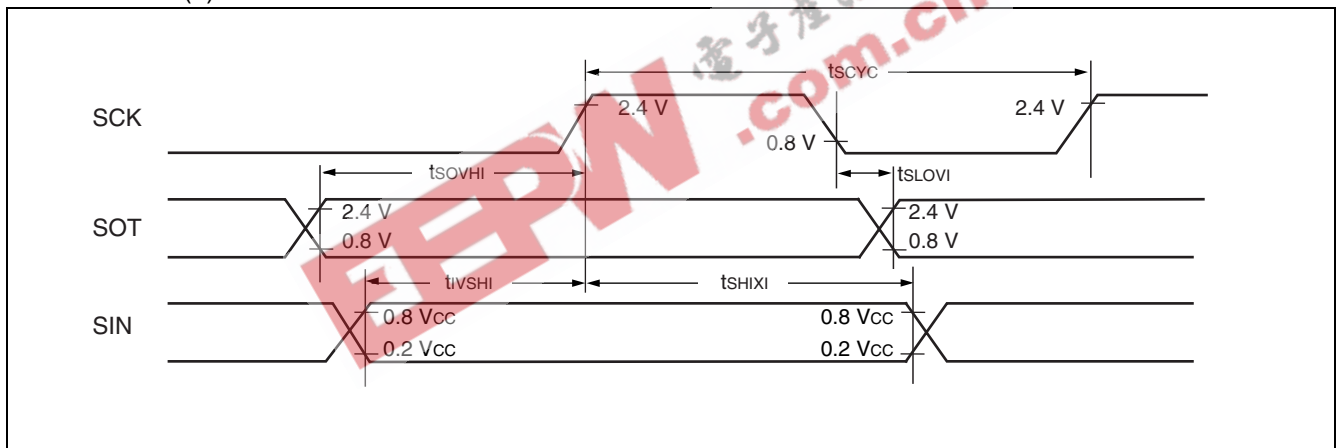
( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

| Parameter                   | Symbol      | Pin name | Condition   | Value                 |                   | Unit |
|-----------------------------|-------------|----------|---|-----------------------|-------------------|------|
|                             |             |          |   | Min                   | Max               |      |
| Serial clock cycle time     | $t_{SCYC}$  | SCK      | Internal clock<br>operating output pin :<br>$C_L = 80\text{ pF} + 1\text{ TTL}$ . | $5 t_{MCLK}^{*3}$     | —                 | ns   |
| SCK ↓ → SOT delay time      | $t_{SLOVI}$ | SCK, SOT |   | -95                   | +95               | ns   |
| Valid SIN → SCK ↑           | $t_{IVSHI}$ | SCK, SIN |   | $t_{MCLK}^{*3} + 190$ | —                 | ns   |
| SCK ↑ → valid SIN hold time | $t_{SHIXI}$ | SCK, SIN |   | 0                     | —                 | ns   |
| SOT → SCK ↑ delay time      | $t_{SOVHI}$ | SCK, SOT |   | —                     | $4 t_{MCLK}^{*3}$ | ns   |

\*1 : Provide switch function whether sampling of reception data is performed at rising edge or falling edge of the serial clock.

\*2 : Serial clock delay function is used to delay half clock for the output signal of serial clock.

\*3 : Refer to “(2) Source Clock/Machine Clock” for  $t_{MCLK}$ .





# MB95120MB Series

## (8) I<sup>2</sup>C Timing

(V<sub>CC</sub> = 5.0 V ± 10%, AV<sub>SS</sub> = V<sub>SS</sub> = 0.0 V, T<sub>A</sub> = - 40 °C to + 105 °C)

| Parameter   | Symbol              | Pin name     | Condition                  | Value         |        |           |       | Unit |
|---|---------------------|--------------|----------------------------|---------------|--------|-----------|-------|------|
|   |                     |              |                            | Standard-mode |        | Fast-mode |       |      |
|   |                     |              |                            | Min           | Max    | Min       | Max   |      |
| SCL clock frequency   | f <sub>SCL</sub>    | SCL0         | R = 1.7 kΩ,<br>C = 50 pF*1 | 0             | 100    | 0         | 400   | kHz  |
| (Repeat) Start condition hold time<br>SDA ↓ → SCL ↓         | t <sub>HD;STA</sub> | SCL0<br>SDA0 |                            | 4.0           | —      | 0.6       | —     | μs   |
| SCL clock "L" width   | t <sub>LOW</sub>    | SCL0         |                            | 4.7           | —      | 1.3       | —     | μs   |
| SCL clock "H" width   | t <sub>HIGH</sub>   | SCL0         |                            | 4.0           | —      | 0.6       | —     | μs   |
| (Repeat) Start condition setup time<br>SCL ↑ → SDA ↓        | t <sub>SU;STA</sub> | SCL0<br>SDA0 |                            | 4.7           | —      | 0.6       | —     | μs   |
| Data hold time SCL ↓ → SDA ↓ ↑                              | t <sub>HD;DAT</sub> | SCL0<br>SDA0 |                            | 0             | 3.45*2 | 0         | 0.9*3 | μs   |
| Data setup time SDA ↓ ↑ → SCL ↑                             | t <sub>SU;DAT</sub> | SCL0<br>SDA0 |                            | 0.25*4        | —      | 0.1*4     | —     | μs   |
| Stop condition setup time SCL ↑ →<br>SDA ↑                  | t <sub>SU;STO</sub> | SCL0<br>SDA0 |                            | 4.0           | —      | 0.6       | —     | μs   |
| Bus free time between stop<br>condition and start condition | t <sub>BUF</sub>    | SCL0<br>SDA0 |                            | 4.7           | —      | 1.3       | —     | μs   |

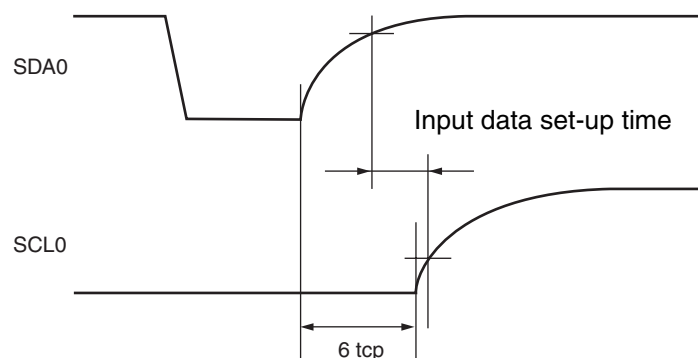
\*1 : R, C : Pull-up resistor and load capacitor of the SCL and SDA lines.

\*2 : The maximum t<sub>HD;DAT</sub> have only to be met if the device dose not stretch the "L" width (t<sub>LOW</sub>) of the SCL signal.

\*3 : A fast-mode I<sup>2</sup>C-bus device can be used in a standard-mode I<sup>2</sup>C-bus system, but the requirement t<sub>SU;DAT</sub> ≥ 250 ns must then be met.

\*4 : Refer to "• Note of SDA and SCL set-up time".

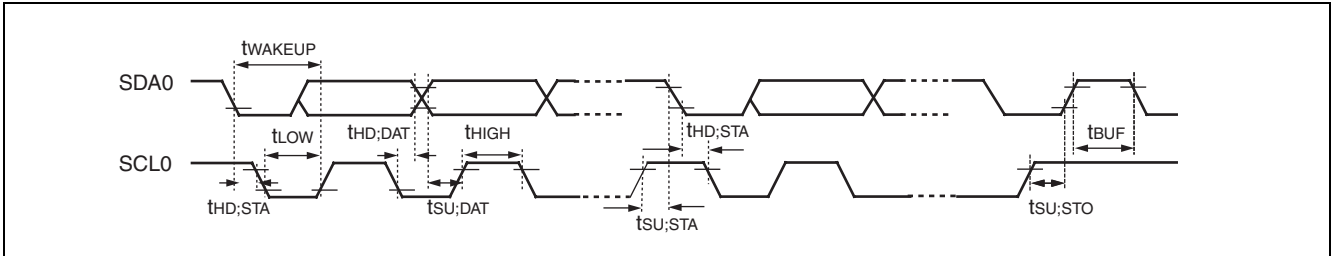
### • Note of SDA and SCL set-up time



Note : The rating of the input data set-up time in the device connected to the bus cannot be satisfied depending on the load capacitance or pull-up resistor.

Be sure to adjust the pull-up resistor of SDA and SCL if the rating of the input data set-up time cannot be satisfied.

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( $V_{CC} = 5.0 \text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0 \text{ V}$ ,  $T_A = -40 \text{ }^\circ\text{C}$  to  $+105 \text{ }^\circ\text{C}$ )

| Parameter  | Symbol       | Pin name     | Condition                           | Value*2                       |                               | Unit | Remarks  |
|--|--------------|--------------|-------------------------------------|-------------------------------|-------------------------------|------|--|
|  |              |              |                                     | Min                           | Max                           |      |  |
| SCL clock "L" width                                      | $t_{LOW}$    | SCL0         |                                     | $(2 + nm / 2) t_{MCLK} - 20$  | —                             | ns   | Master mode  |
| SCL clock "H" width                                      | $t_{HIGH}$   | SCL0         |                                     | $(nm / 2) t_{MCLK} - 20$      | $(nm / 2) t_{MCLK} + 20$      | ns   | Master mode  |
| Start condition hold time                                | $t_{HD;STA}$ | SCL0<br>SDA0 |                                     | $(-1 + nm / 2) t_{MCLK} - 20$ | $(-1 + nm) t_{MCLK} + 20$     | ns   | Master mode<br>Maximum value is applied when m, n = 1, 8. Otherwise, the minimum value is applied.   |
| Stop condition setup time                                | $t_{SU;STO}$ | SCL0<br>SDA0 |                                     | $(1 + nm / 2) t_{MCLK} - 20$  | $(1 + nm / 2) t_{MCLK} + 20$  | ns   | Master mode  |
| Start condition setup time                               | $t_{SU;STA}$ | SCL0<br>SDA0 |                                     | $(1 + nm / 2) t_{MCLK} - 20$  | $(1 + nm / 2) t_{MCLK} + 20$  | ns   | Master mode  |
| Bus free time between stop condition and start condition | $t_{BUF}$    | SCL0<br>SDA0 |                                     | $(2 nm + 4) t_{MCLK} - 20$    | —                             | ns   |  |
| Data hold time   | $t_{HD;DAT}$ | SCL0<br>SDA0 |                                     | $3 t_{MCLK} - 20$             | —                             | ns   | Master mode  |
| Data setup time  | $t_{SU;DAT}$ | SCL0<br>SDA0 | R = 1.7 k $\Omega$ ,<br>C = 50 pF*1 | $(-2 + nm / 2) t_{MCLK} - 20$ | $(-1 + nm / 2) t_{MCLK} + 20$ | ns   | Master mode<br>When assuming that "L" of SCL is not extended, the minimum value is applied to first bit of continuous data. Otherwise, the maximum value is applied. |
| Setup time between clearing interrupt and SCL rising     | $t_{SU;INT}$ | SCL0         |                                     | $(nm / 2) t_{MCLK} - 20$      | $(1 + nm / 2) t_{MCLK} + 20$  | ns   | Minimum value is applied to interrupt at 9th SCL $\downarrow$ .<br>Maximum value is applied to interrupt at 8th SCL $\downarrow$ .                                   |
| SCL clock "L" width                                      | $t_{LOW}$    | SCL0         |                                     | $4 t_{MCLK} - 20$             | —                             | ns   | At reception   |
| SCL clock "H" width                                      | $t_{HIGH}$   | SCL0         |                                     | $4 t_{MCLK} - 20$             | —                             | ns   | At reception   |
| Start condition detection                                | $t_{HD;STA}$ | SCL0<br>SDA0 |                                     | $2 t_{MCLK} - 20$             | —                             | ns   | Undetected when 1 $t_{MCLK}$ is used at reception  |

(Continued)

# MB95120MB Series

(Continued)

( $V_{CC} = 5.0 \text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0 \text{ V}$ ,  $T_A = -40 \text{ }^\circ\text{C}$  to  $+105 \text{ }^\circ\text{C}$ )

| Parameter  | Symbol        | Pin name     | Condition                           | Value*2   |     | Unit | Remarks   |
|--|---------------|--------------|-------------------------------------|---|-----|------|---|
|  |               |              |                                     | Min   | Max |      |   |
| Stop condition detection                                 | $t_{SU;STO}$  | SCL0<br>SDA0 | R = 1.7 k $\Omega$ ,<br>C = 50 pF*1 | $2 t_{MCLK} - 20$                                       | —   | ns   | Undetected when 1 $t_{MCLK}$ is used at reception |
| Restart condition detection condition                    | $t_{SU;STA}$  | SCL0<br>SDA0 |                                     | $2 t_{MCLK} - 20$                                       | —   | ns   | Undetected when 1 $t_{MCLK}$ is used at reception |
| Bus free time  | $t_{BUF}$     | SCL0<br>SDA0 |                                     | $2 t_{MCLK} - 20$                                       | —   | ns   | At reception                                      |
| Data hold time   | $t_{HD;DAT}$  | SCL0<br>SDA0 |                                     | $2 t_{MCLK} - 20$                                       | —   | ns   | At slave transmission mode                        |
| Data setup time  | $t_{SU;DAT}$  | SCL0<br>SDA0 |                                     | $t_{LOW} - 3 t_{MCLK} - 20$                             | —   | ns   | At slave transmission mode                        |
| Data hold time   | $t_{HD;DAT}$  | SCL0<br>SDA0 |                                     | —   | —   | ns   | At reception                                      |
| Data setup time  | $t_{SU;DAT}$  | SCL0<br>SDA0 |                                     | $t_{MCLK} - 20$   | —   | ns   | At reception                                      |
| SDA $\downarrow$ →SCL $\uparrow$<br>(at wakeup function) | $t_{WAKE-UP}$ | SCL0<br>SDA0 |                                     | Oscillation stabilization wait time + $2 t_{MCLK} - 20$ | —   | ns   |   |

\*1 : R, C : Pull-up resistor and load capacitor of the SCL and SDA lines.

\*2 : • Refer to “(2) Source Clock/Machine Clock” for  $t_{MCLK}$ .

- m is CS4 bit and CS3 bit (bit 4 and bit 3) of I<sup>2</sup>C clock control register (ICCR) .
- n is CS2 bit to CS0 bit (bit 2 to bit 0) of I<sup>2</sup>C clock control register (ICCR) .
- Actual timing of I<sup>2</sup>C is determined by m and n values set by the machine clock ( $t_{MCLK}$ ) and CS4 to CS0 of ICCR0 register.
- Standard-mode :  
m and n can be set at the range :  $0.9 \text{ MHz} < t_{MCLK} \text{ (machine clock)} < 10 \text{ MHz}$ .  
Setting of m and n determines the machine clock that can be used below.
 

|  |  |
|--|--|
| (m, n) = (1, 8)                                  | : $0.9 \text{ MHz} < t_{MCLK} \leq 1 \text{ MHz}$  |
| (m, n) = (1, 22), (5, 4), (6, 4), (7, 4), (8, 4) | : $0.9 \text{ MHz} < t_{MCLK} \leq 2 \text{ MHz}$  |
| (m, n) = (1, 38), (5, 8), (6, 8), (7, 8), (8, 8) | : $0.9 \text{ MHz} < t_{MCLK} \leq 4 \text{ MHz}$  |
| (m, n) = (1, 98)                                 | : $0.9 \text{ MHz} < t_{MCLK} \leq 10 \text{ MHz}$ |
- Fast-mode :  
m and n can be set at the range :  $3.3 \text{ MHz} < t_{MCLK} \text{ (machine clock)} < 10 \text{ MHz}$ .  
Setting of m and n determines the machine clock that can be used below.
 

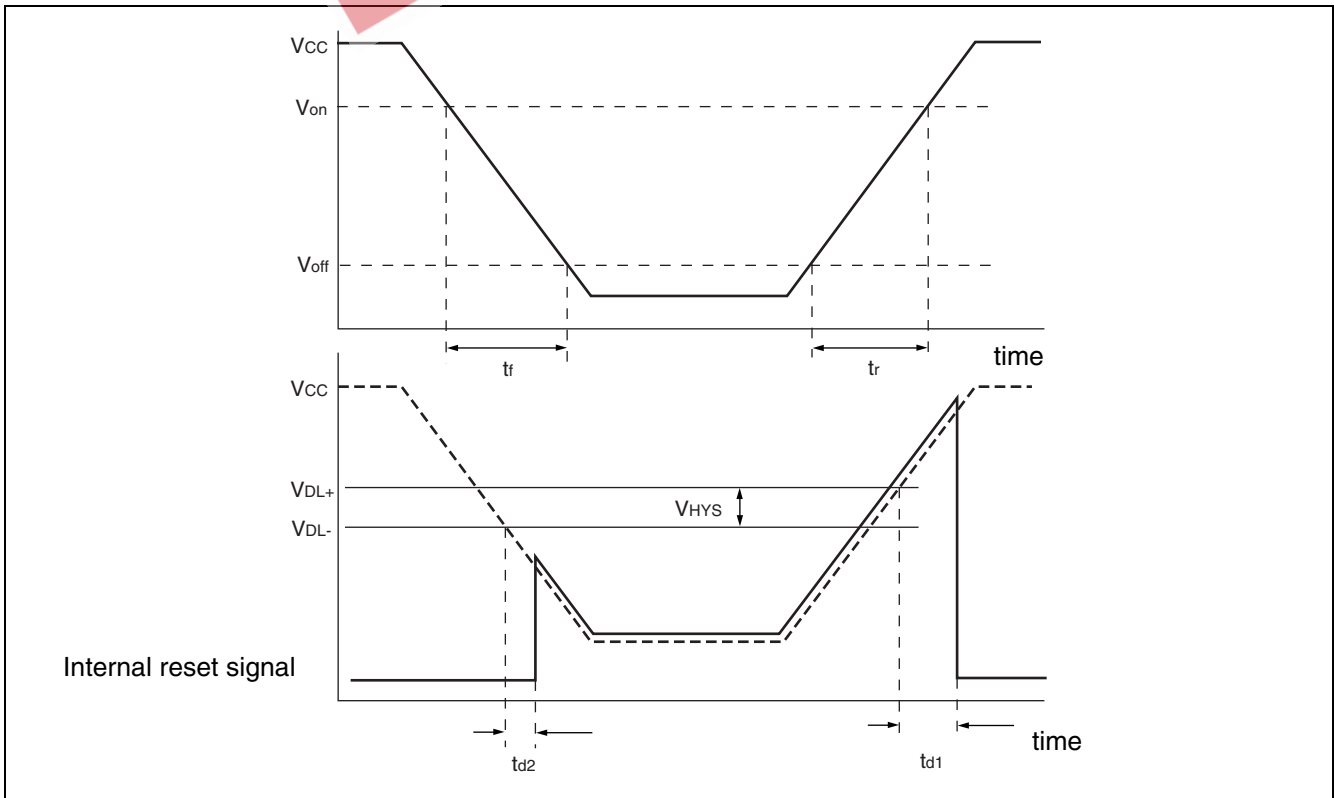
|                          |  |
|--------------------------|--|
| (m, n) = (1, 8)          | : $3.3 \text{ MHz} < t_{MCLK} \leq 4 \text{ MHz}$  |
| (m, n) = (1, 22), (5, 4) | : $3.3 \text{ MHz} < t_{MCLK} \leq 8 \text{ MHz}$  |
| (m, n) = (6, 4)          | : $3.3 \text{ MHz} < t_{MCLK} \leq 10 \text{ MHz}$ |

# MB95120MB Series

**(9) Low Voltage Detection**

(AV<sub>SS</sub> = V<sub>SS</sub> = 0.0 V, T<sub>A</sub> = -40 °C to +105 °C)

| Parameter   | Symbol           | Condition | Value |      |      | Unit  | Remarks   |
|---|------------------|-----------|-------|------|------|---|---|
|   |                  |           | Min   | Typ  | Max  |   |   |
| Release voltage   | V <sub>DL+</sub> | —         | 2.52  | 2.70 | 2.88 | V   | At power-supply rise  |
| Detection voltage                                       | V <sub>DL-</sub> |           | 2.42  | 2.60 | 2.78 | V   | At power-supply fall  |
| Hysteresis width  | V <sub>HYS</sub> |           | 70    | 100  | —    | mV  |   |
| Power-supply start voltage                              | V <sub>off</sub> |           | —     | —    | 2.3  | V   |   |
| Power-supply end voltage                                | V <sub>on</sub>  |           | 4.9   | —    | —    | V   |   |
| Power-supply voltage change time (at power supply rise) | t <sub>r</sub>   |           | 0.3   | —    | —    | μs  | Slope of power supply that reset release signal generates                                     |
|   |                  |           | —     | 3000 | —    | μs  | Slope of power supply that reset release signal generates within rating (V <sub>DL+</sub> )   |
| Power-supply voltage change time (at power supply fall) | t <sub>r</sub>   |           | 300   | —    | —    | μs  | Slope of power supply that reset detection signal generates                                   |
|   |                  |           | —     | 300  | —    | μs  | Slope of power supply that reset detection signal generates within rating (V <sub>DL-</sub> ) |
| Reset release delay time                                | t <sub>d1</sub>  |           | —     | —    | 400  | μs  |   |
| Reset detection delay time                              | t <sub>d2</sub>  | —         | —     | 30   | μs   |   |   |
| Current consumption                                     | I <sub>LVD</sub> | —         | 38    | 50   | μA   | Current consumption of low voltage detection circuit only |   |



# MB95120MB Series

## (10) Clock Supervisor Clock

( $V_{CC} = AV_{CC} = 5\text{ V} \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C}$  to  $+105\text{ }^\circ\text{C}$ )

| Parameter              | Symbol    | Condition | Value |     |     | Unit          | Remarks   |
|------------------------|-----------|-----------|-------|-----|-----|---------------|---|
|                        |           |           | Min   | Typ | Max |               |   |
| Oscillation frequency  | $f_{OUT}$ | —         | 50    | 100 | 200 | kHz           |   |
| Oscillation start time | $t_{WK}$  |           | —     | —   | 10  | $\mu\text{s}$ |   |
| Current consumption    | $I_{CSV}$ |           | —     | 20  | 36  | $\mu\text{A}$ | Current consumption of built-in CR oscillator, at 100 kHz oscillation |

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# MB95120MB Series

## 5. A/D Converter

### (1) A/D Converter Electrical Characteristics

( $AV_{CC} = V_{CC} = 4.0\text{ V to } 5.5\text{ V}$ ,  $AV_{SS} = V_{SS} = 0.0\text{ V}$ ,  $T_A = -40\text{ }^\circ\text{C to } +105\text{ }^\circ\text{C}$ )

| Parameter                        | Symbol    | Condition | Value                      |                            |                            | Unit          | Remarks   |
|----------------------------------|-----------|-----------|----------------------------|----------------------------|----------------------------|---------------|---|
|                                  |           |           | Min                        | Typ                        | Max                        |               |   |
| Resolution                       | —         | —         | —                          | —                          | 10                         | bit           |   |
| Total error                      |           |           | -3.0                       | —                          | +3.0                       | LSB           |   |
| Linearity error                  |           |           | -2.5                       | —                          | +2.5                       | LSB           |   |
| Differential linear error        |           |           | -1.9                       | —                          | +1.9                       | LSB           |   |
| Zero transition voltage          | $V_{OT}$  | —         | $AV_{SS} - 1.5\text{ LSB}$ | $AV_{SS} + 0.5\text{ LSB}$ | $AV_{SS} + 2.5\text{ LSB}$ | V             |   |
| Full-scale transition voltage    | $V_{FST}$ | —         | $AVR - 3.5\text{ LSB}$     | $AVR - 1.5\text{ LSB}$     | $AVR + 0.5\text{ LSB}$     | V             |   |
| Compare time                     | —         | —         | 0.9                        | —                          | 16500                      | $\mu\text{s}$ | $4.5\text{ V} \leq AV_{CC} \leq 5.5\text{ V}$   |
|                                  |           |           | 1.8                        | —                          | 16500                      | $\mu\text{s}$ | $4.0\text{ V} \leq AV_{CC} < 4.5\text{ V}$  |
| Sampling time                    | —         | —         | 0.6                        | —                          | $\infty$                   | $\mu\text{s}$ | $4.5\text{ V} \leq AV_{CC} \leq 5.5\text{ V}$ ,<br>At external impedance $< 5.4\text{ k}\Omega$ |
|                                  |           |           | 1.2                        | —                          | $\infty$                   | $\mu\text{s}$ | $4.0\text{ V} \leq AV_{CC} < 4.5\text{ V}$ ,<br>At external impedance $< 2.4\text{ k}\Omega$    |
| Analog input current             | $I_{AIN}$ | —         | -0.3                       | —                          | +0.3                       | $\mu\text{A}$ |   |
| Analog input voltage             | $V_{AIN}$ | —         | $AV_{SS}$                  | —                          | AVR                        | V             |   |
| Reference voltage                | —         | —         | $AV_{SS} + 4.0$            | —                          | $AV_{CC}$                  | V             | AVR pin   |
| Reference voltage supply current | $I_R$     | —         | —                          | 600                        | 900                        | $\mu\text{A}$ | AVR pin,<br>During A/D operation  |
|                                  | $I_{RH}$  | —         | —                          | —                          | 5                          | $\mu\text{A}$ | AVR pin,<br>At stop mode  |

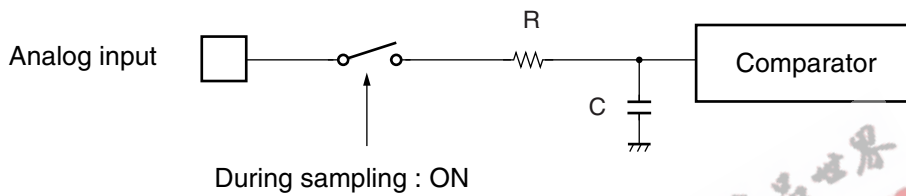
# MB95120MB Series

## (2) Notes on Using A/D Converter

### • About the external impedance of analog input and its sampling time

A/D converter with sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting A/D conversion precision. Therefore to satisfy the A/D conversion precision standard, consider the relationship between the external impedance and minimum sampling time and either adjust the register value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value. Also, if the sampling time cannot be sufficient, connect a capacitor of about 0.1  $\mu\text{F}$  to the analog input pin.

#### • Analog input equivalent circuit

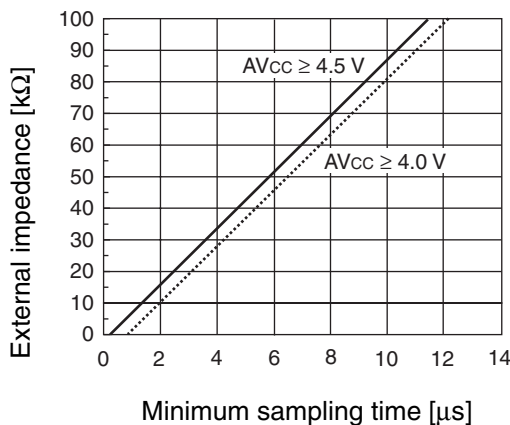


|   | R                    | C           |
|---|----------------------|-------------|
| $4.5 \text{ V} \leq AV_{CC} \leq 5.5 \text{ V}$ | 2.0 k $\Omega$ (Max) | 16 pF (Max) |
| $4.0 \text{ V} \leq AV_{CC} < 4.5 \text{ V}$    | 8.2 k $\Omega$ (Max) | 16 pF (Max) |

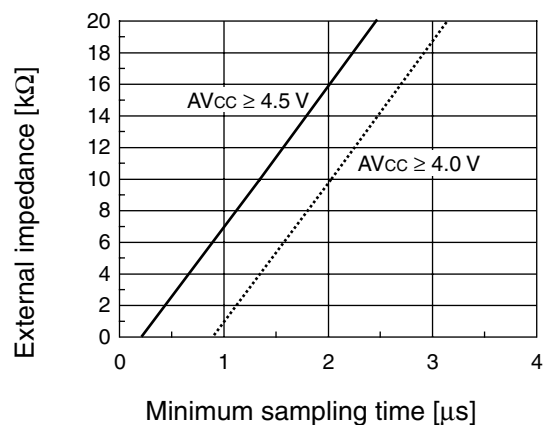
Note : The values are reference values.

#### • The relationship between external impedance and minimum sampling time

(External impedance = 0 k $\Omega$  to 100 k $\Omega$ )



(External impedance = 0 k $\Omega$  to 20 k $\Omega$ )



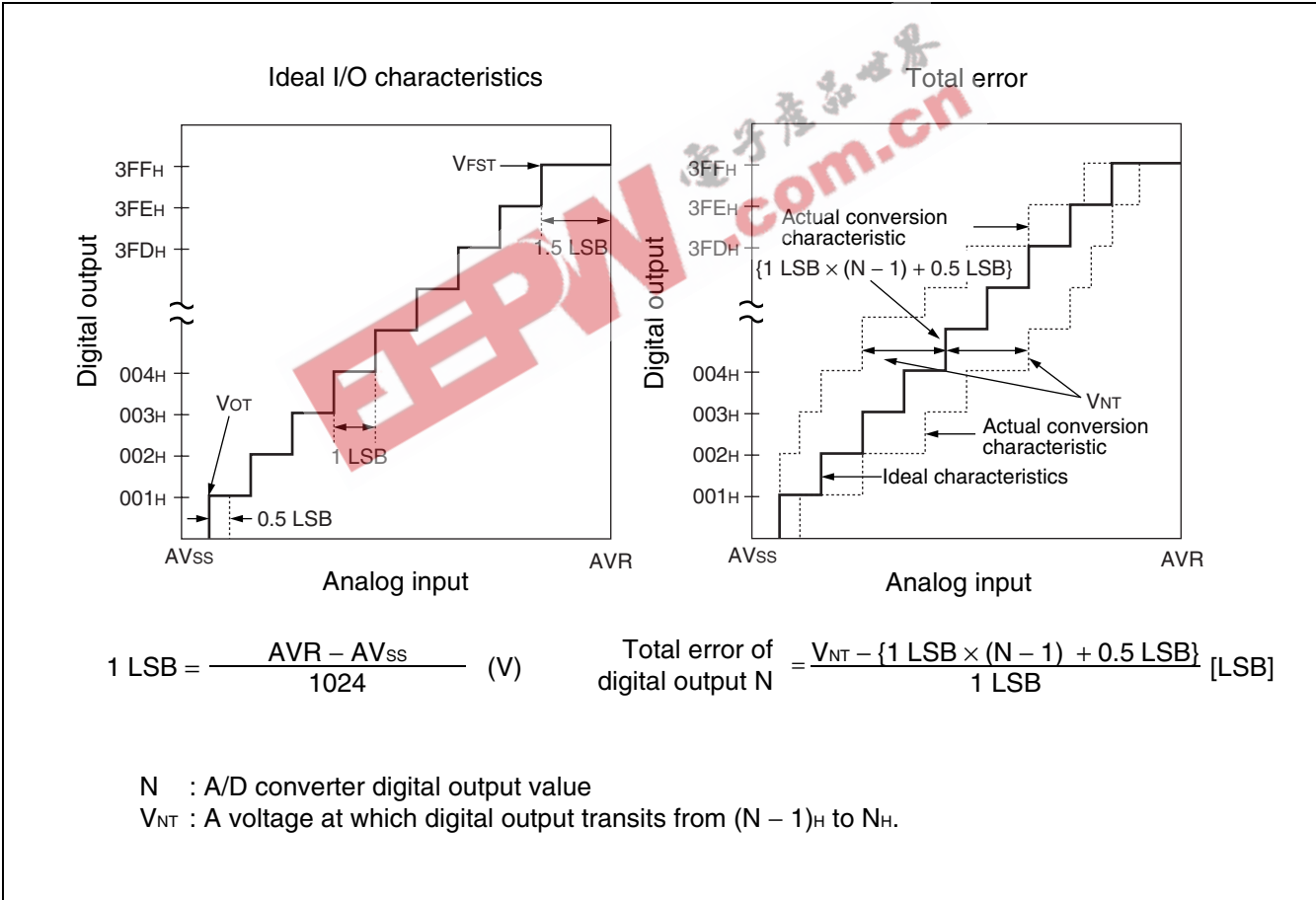
### • About errors

As  $|AV_{CC} - AV_{SS}|$  becomes smaller, values of relative errors grow larger.



**(3) Definition of A/D Converter Terms**

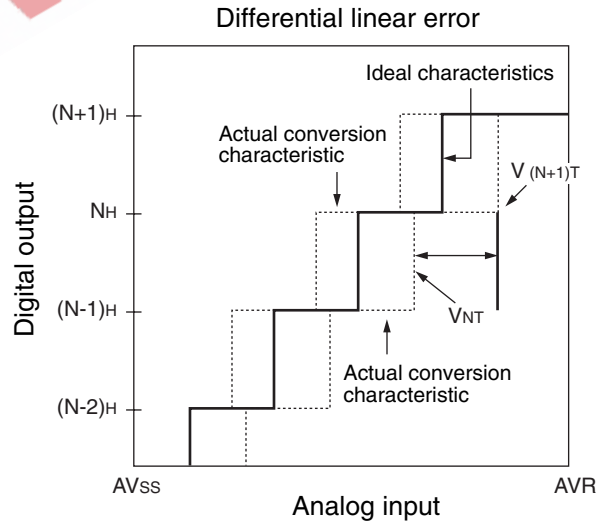
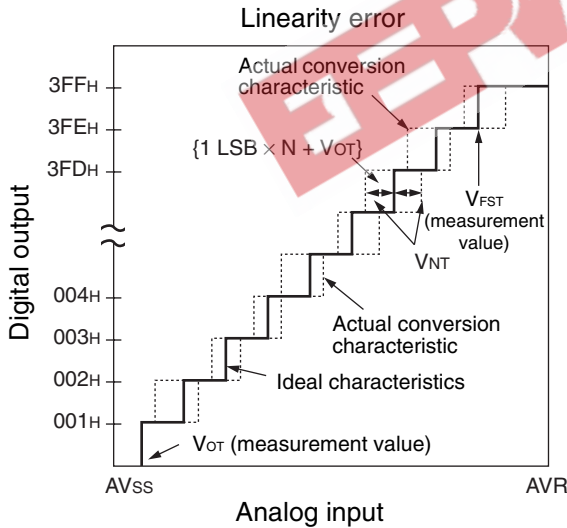
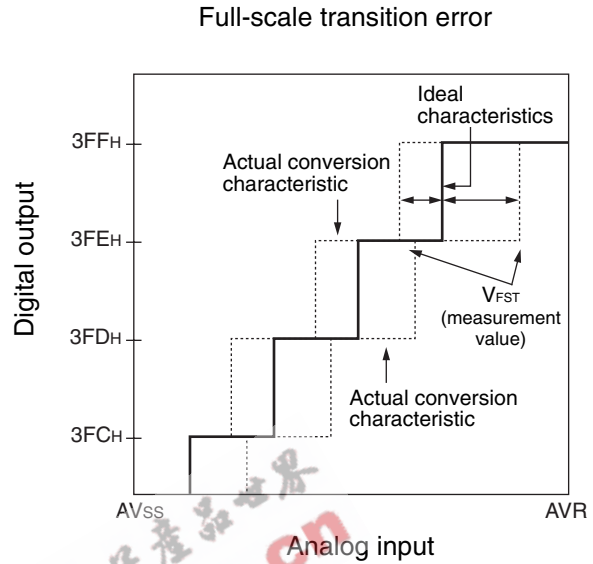
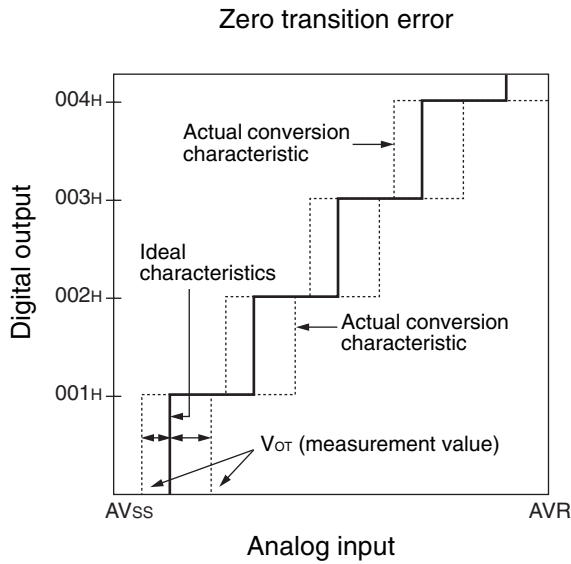
- Resolution  
The level of analog variation that can be distinguished by the A/D converter.  
When the number of bits is 10, analog voltage can be divided into  $2^{10} = 1024$ .
- Linearity error (unit : LSB)  
The deviation between the value along a straight line connecting the zero transition point (“00 0000 0000” ← → “00 0000 0001”) of a device and the full-scale transition point (“11 1111 1111” ← → “11 1111 1110”) compared with the actual conversion values obtained.
- Differential linear error (Unit : LSB)  
Deviation of input voltage, which is required for changing output code by 1 LSB, from an ideal value.
- Total error (unit: LSB)  
Difference between actual and theoretical values, caused by a zero transition error, full-scale transition error, linearity error, quantum error, and noise.



(Continued)

# MB95120MB Series

(Continued)



$$\text{Linear error in digital output } N = \frac{V_{NT} - \{1 \text{ LSB} \times N + V_{OT}\}}{1 \text{ LSB}}$$

$$\text{Differential linear error in digital output } N = \frac{V_{(N+1)T} - V_{NT}}{1 \text{ LSB}} - 1$$

N : A/D Converter digital output value

$V_{NT}$  : A voltage at which digital output transits from  $(N - 1)_H$  to  $N_H$ .

$V_{OT}$  (Ideal value) =  $AV_{SS} + 0.5 \text{ LSB}$  [V]

$V_{FST}$  (Ideal value) =  $AVR - 1.5 \text{ LSB}$  [V]

# MB95120MB Series

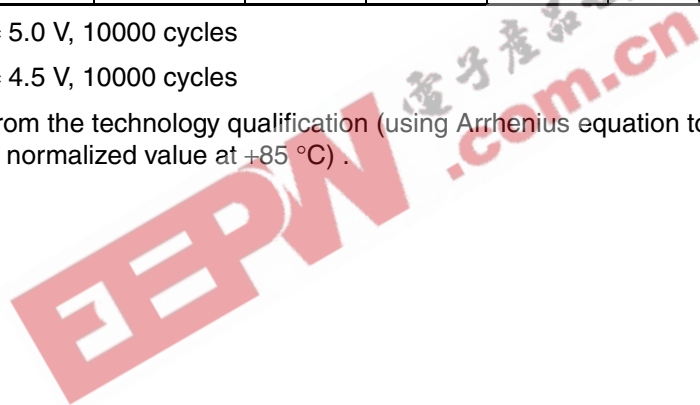
## 6. Flash Memory Program/Erase Characteristics

| Parameter                               | Condition | Value            |                   |                   | Unit  | Remarks   |
|---|-----------|------------------|-------------------|-------------------|-------|---|
|   |           | Min              | Typ               | Max               |       |   |
| Sector erase time<br>(4 Kbytes sector)  | —         | —                | 0.2* <sup>1</sup> | 0.5* <sup>2</sup> | s     | Excludes 00 <sub>H</sub> programming prior erasure. |
| Sector erase time<br>(16 Kbytes sector) |           | —                | 0.5* <sup>1</sup> | 7.5* <sup>2</sup> | s     | Excludes 00 <sub>H</sub> programming prior erasure. |
| Byte programming time                   |           | —                | 32                | 3600              | μs    | Excludes system-level overhead.                     |
| Program/erase cycle                     |           | 10000            | —                 | —                 | cycle |   |
| Power supply voltage at program/erase   |           | 4.5              | —                 | 5.5               | V     |   |
| Flash memory data retention time        |           | 20* <sup>3</sup> | —                 | —                 | year  | Average T <sub>A</sub> = +85 °C                     |

\*1 : T<sub>A</sub> = + 25 °C, V<sub>CC</sub> = 5.0 V, 10000 cycles

\*2 : T<sub>A</sub> = + 85 °C, V<sub>CC</sub> = 4.5 V, 10000 cycles

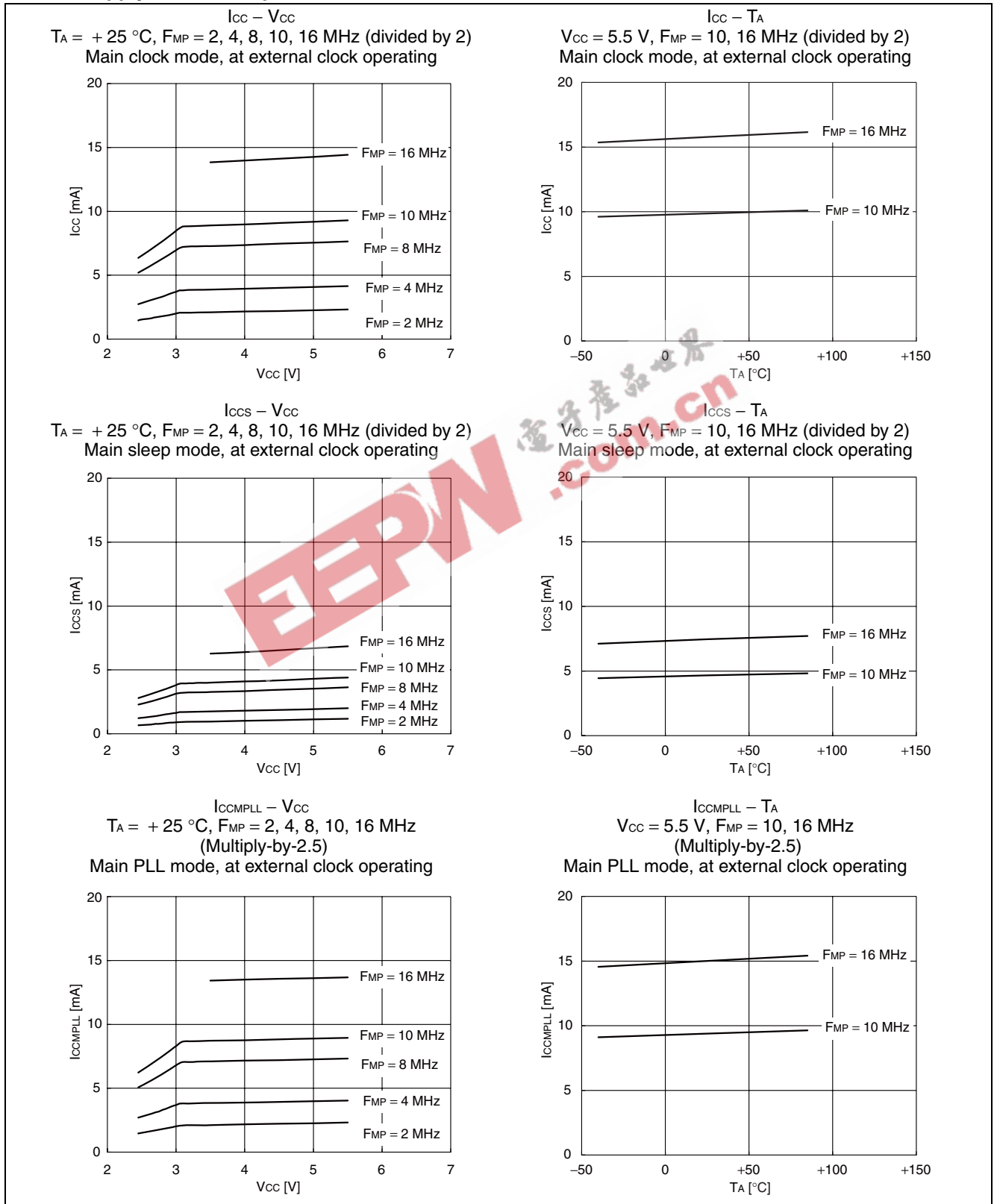
\*3 : This value comes from the technology qualification (using Arrhenius equation to translate high temperature measurements into normalized value at +85 °C) .



# MB95120MB Series

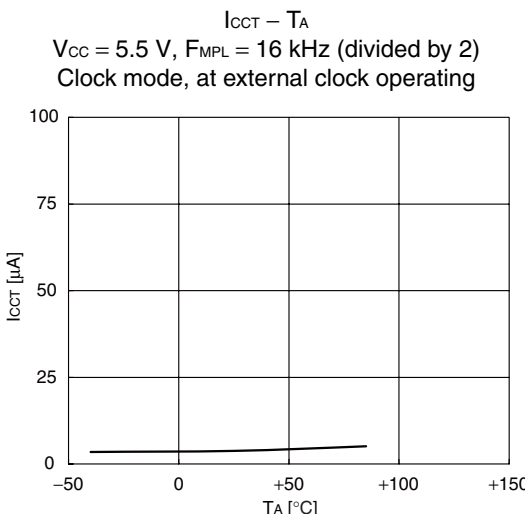
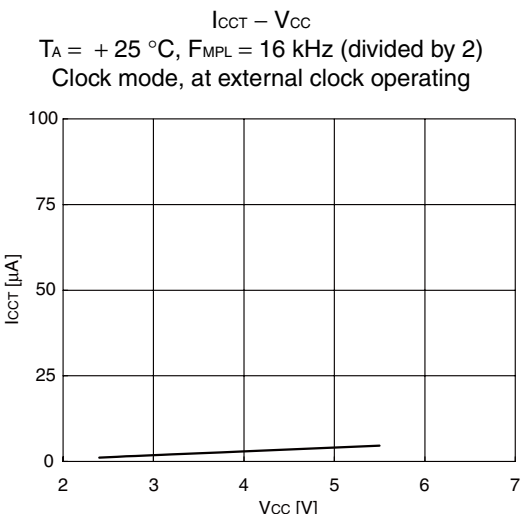
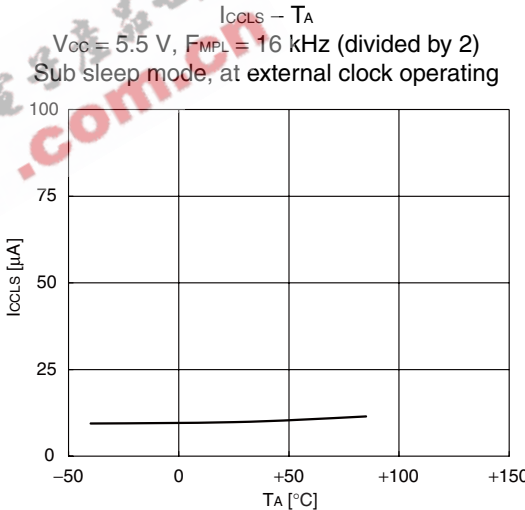
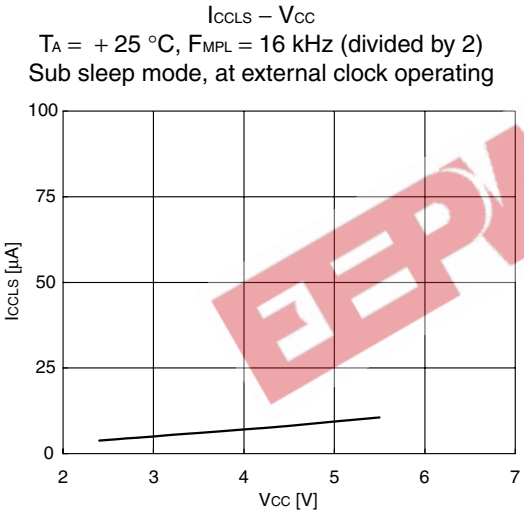
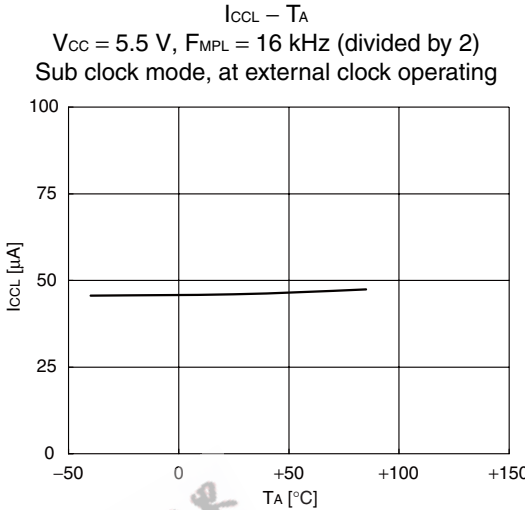
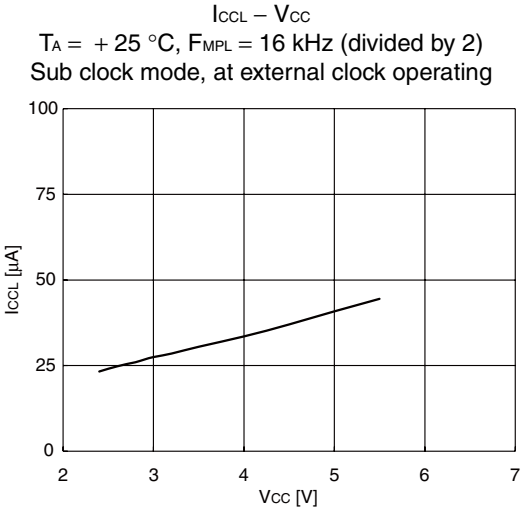
## EXAMPLE CHARACTERISTICS

### Power supply current temperature



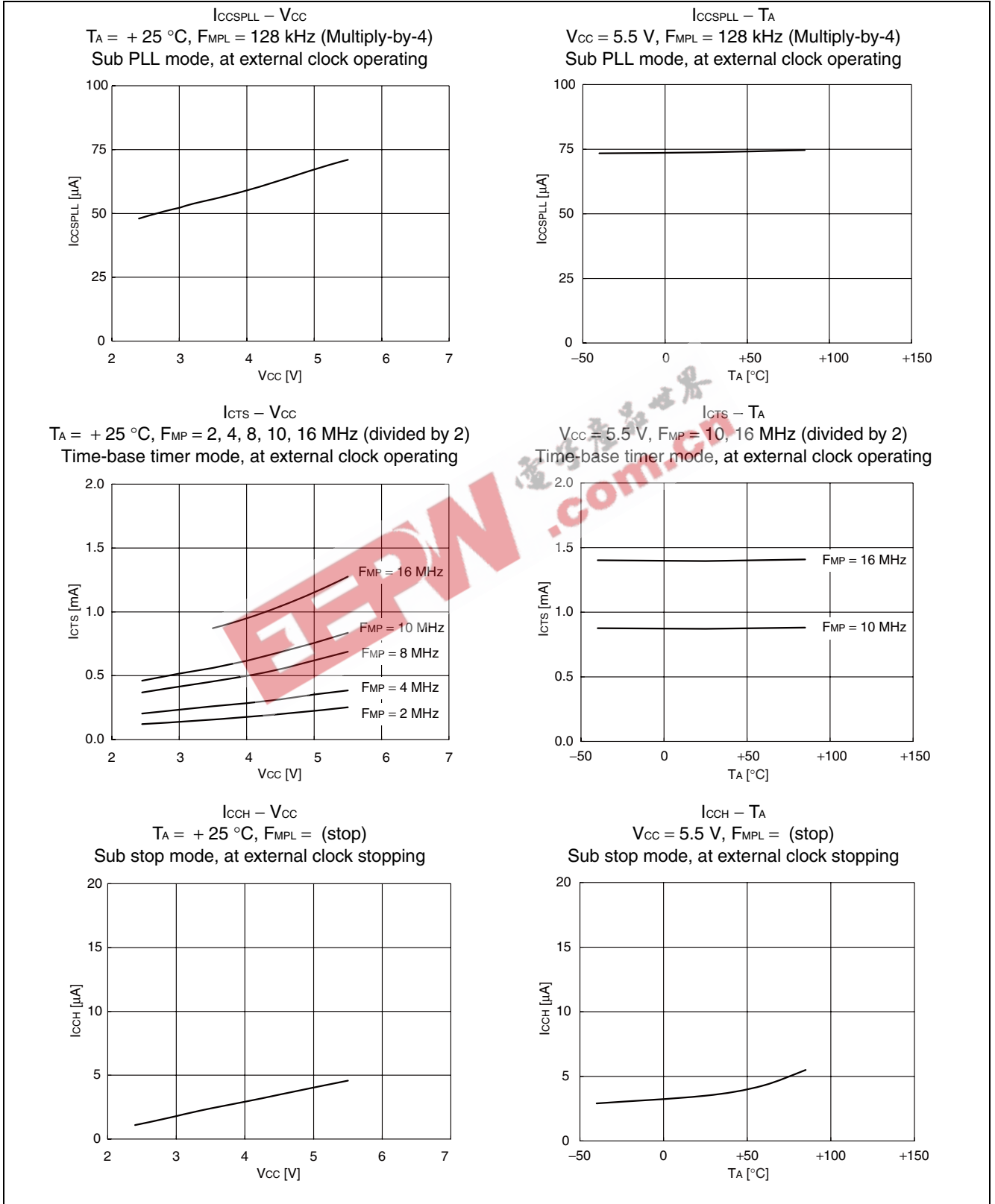
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# MB95120MB Series



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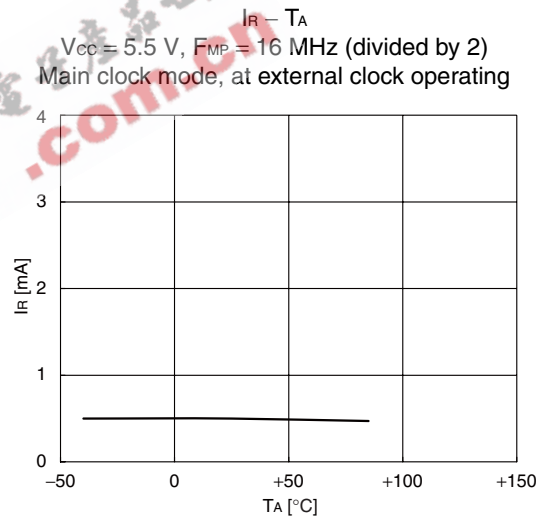
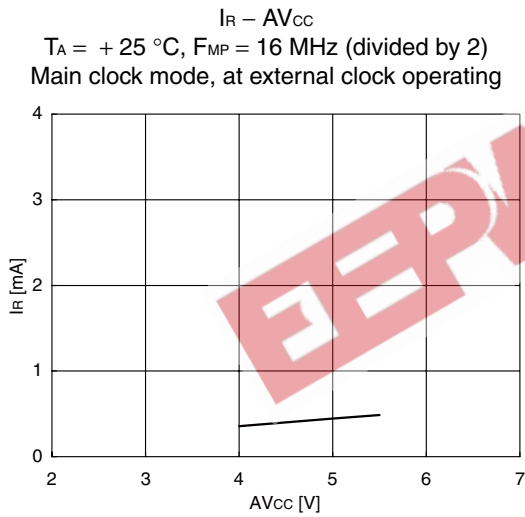
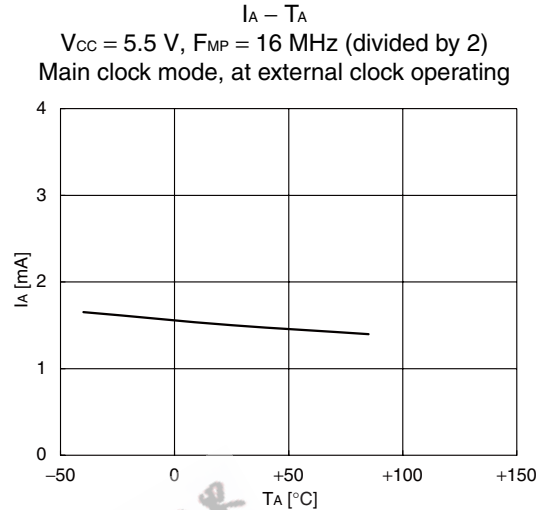
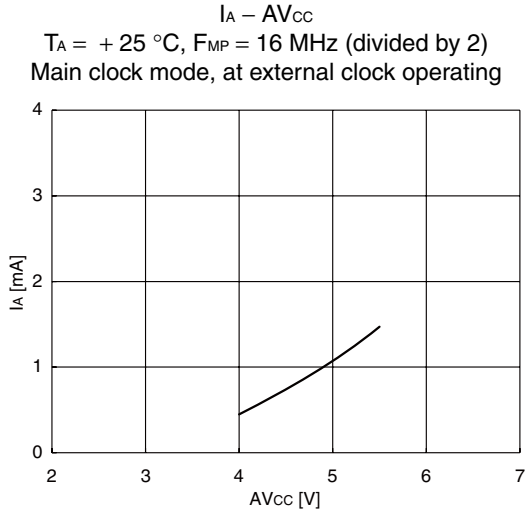
# MB95120MB Series



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# MB95120MB Series

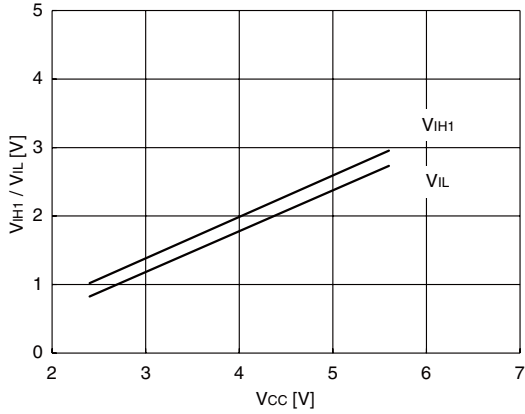
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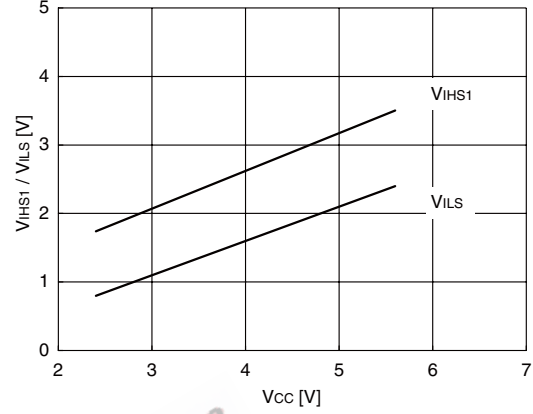
# MB95120MB Series

## • Input voltage

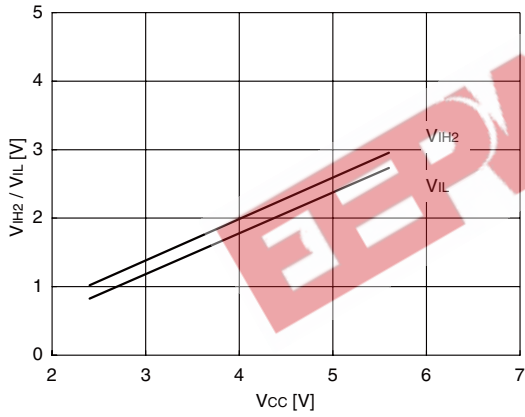
$V_{IH1} - V_{CC}$  and  $V_{IL} - V_{CC}$   
 $T_A = +25\text{ }^\circ\text{C}$



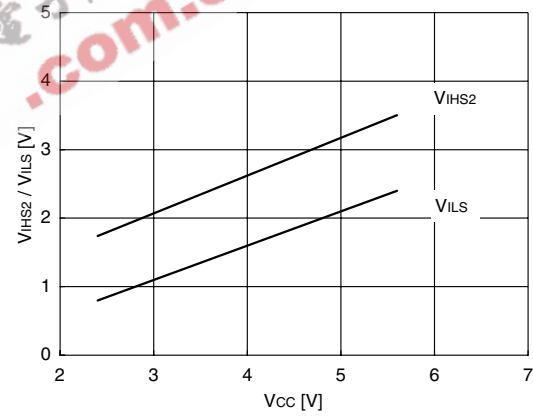
$V_{IHS1} - V_{CC}$  and  $V_{ILS} - V_{CC}$   
 $T_A = +25\text{ }^\circ\text{C}$



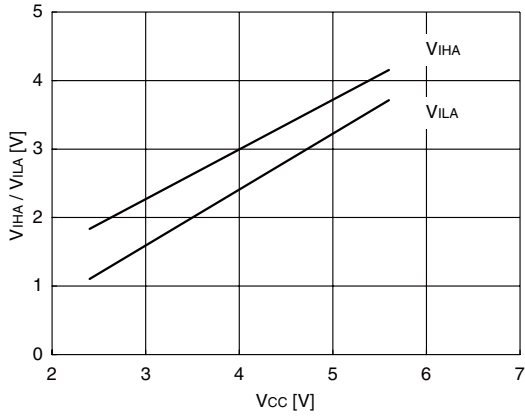
$V_{IH2} - V_{CC}$  and  $V_{IL} - V_{CC}$   
 $T_A = +25\text{ }^\circ\text{C}$



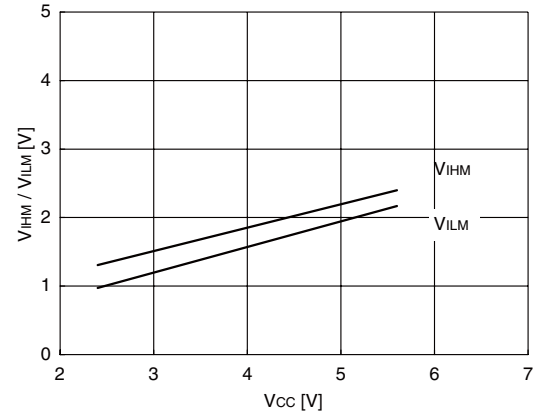
$V_{IHS2} - V_{CC}$  and  $V_{ILS} - V_{CC}$   
 $T_A = +25\text{ }^\circ\text{C}$



$V_{IHA} - V_{CC}$  and  $V_{ILA} - V_{CC}$   
 $T_A = +25\text{ }^\circ\text{C}$



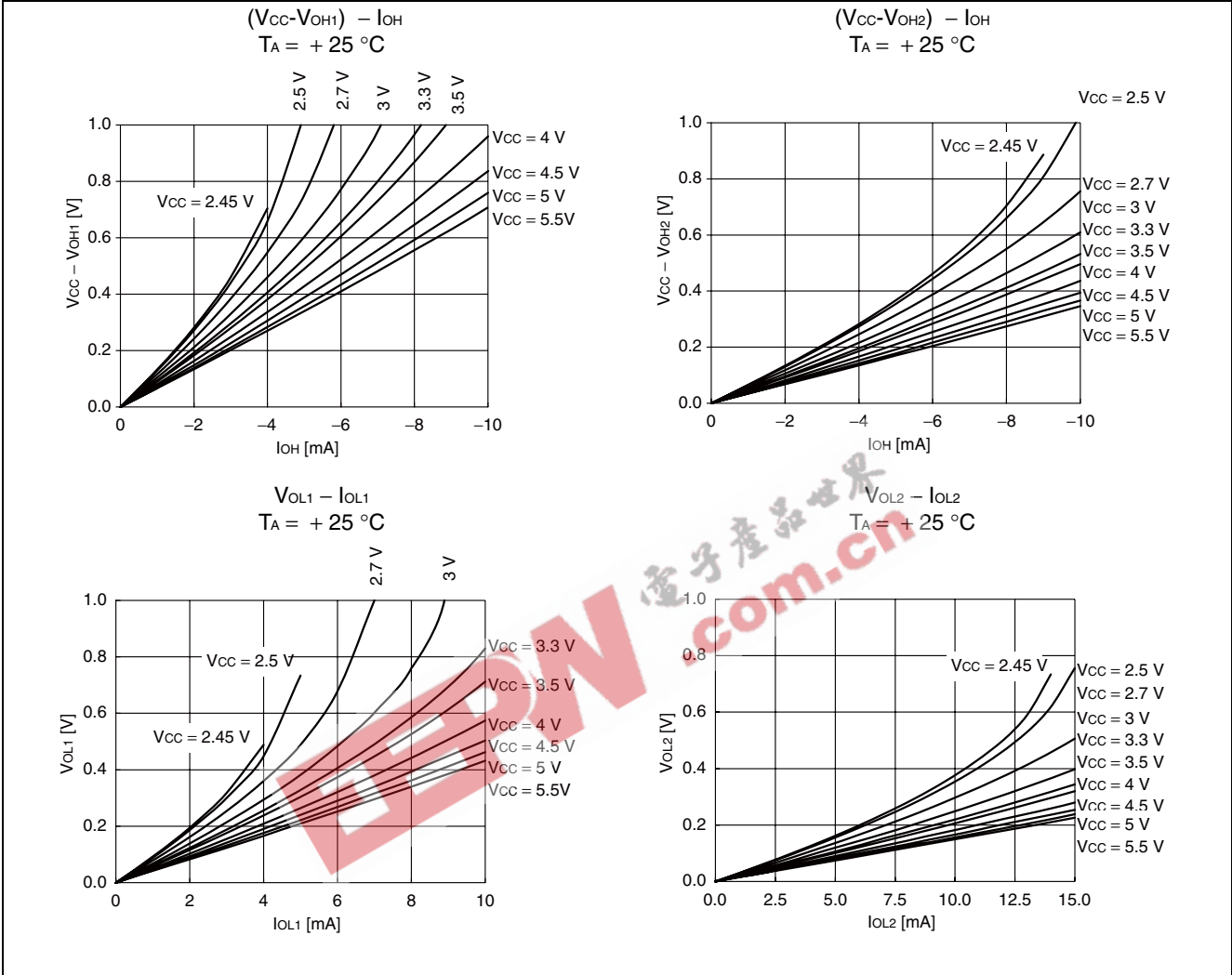
$V_{IHM} - V_{CC}$  and  $V_{ILM} - V_{CC}$   
 $T_A = +25\text{ }^\circ\text{C}$



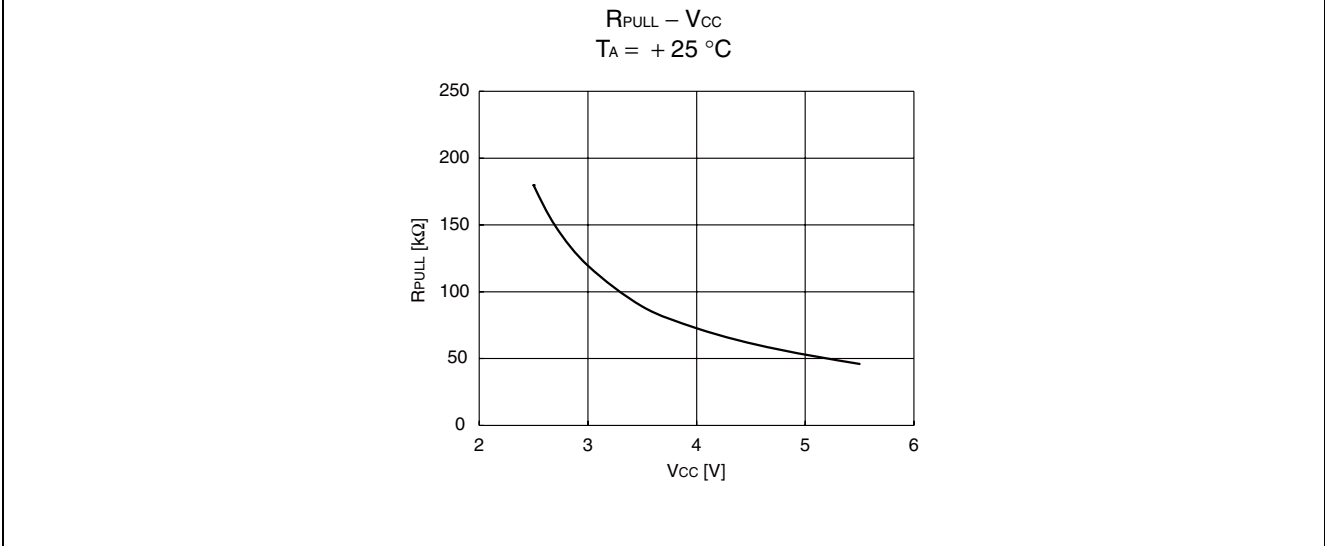


# MB95120MB Series

• Output voltage



• Pull-up



# MB95120MB Series

## ■ MASK OPTION

| No. | Part number   | MB95128MB   | MB95F124MB/F124NB/F124JB<br>MB95F126MB/126NB/F126JB<br>MB95F128MB/F128NB/F128JB | MB95FV100D-103  |
|-----|---|---|---|---|
|     | Specifying procedure  | Specify when ordering MASK  | Setting disabled  | Setting disabled  |
| 1   | Clock mode select<br>• Single-system clock mode<br>• Dual-system clock mode                                 | Dual-system clock mode  | Dual-system clock mode  | Changing by the switch on MCU board   |
| 2   | Low voltage detection reset*<br>• With low voltage detection reset<br>• Without low voltage detection reset | Specify when ordering MASK  | Specified by part number  | Changing by the switch on MCU board   |
| 3   | Clock supervisor*<br>• With clock supervisor<br>• Without clock supervisor                                  | Specify when ordering MASK  | Specified by part number  | Changing by the switch on MCU board   |
| 4   | Reset output*<br>• With reset output<br>• Without reset output  | Specify when ordering MASK  | Specified by part number  | MCU board switch set as following ;<br>• With supervisor :<br>Without reset output<br>• Without supervisor :<br>With reset output |
| 5   | Oscillation stabilization wait time   | Fixed to oscillation stabilization wait time of $(2^{14}-2) / F_{CH}$ | Fixed to oscillation stabilization wait time of $(2^{14}-2) / F_{CH}$           | Fixed to oscillation stabilization wait time of $(2^{14}-2) / F_{CH}$   |

\* : Refer to table below about clock mode select, low voltage detection reset, clock supervisor select and reset output.

# MB95120MB Series

| Part number    | Clock mode select | Low voltage detection reset | Clock supervisor | Reset output |
|----------------|-------------------|-----------------------------|------------------|--------------|
| MB95128MB      | Dual-system       | No                          | No               | Yes          |
|                |                   | Yes                         | No               | Yes          |
|                |                   | Yes                         | Yes              | No           |
| MB95F124MB     |                   | No                          | No               | Yes          |
| MB95F124NB     |                   | Yes                         | No               | Yes          |
| MB95F124JB     |                   | Yes                         | Yes              | No           |
| MB95F126MB     |                   | No                          | No               | Yes          |
| MB95F126NB     |                   | Yes                         | No               | Yes          |
| MB95F126JB     |                   | Yes                         | Yes              | No           |
| MB95F128MB     |                   | No                          | No               | Yes          |
| MB95F128NB     |                   | Yes                         | No               | Yes          |
| MB95F128JB     |                   | Yes                         | Yes              | No           |
| MB95FV100D-103 | Single-system     | No                          | No               | Yes          |
|                |                   | Yes                         | No               | Yes          |
|                |                   | Yes                         | Yes              | No           |
|                | Dual-system       | No                          | No               | Yes          |
|                |                   | Yes                         | No               | Yes          |
|                |                   | Yes                         | Yes              | No           |

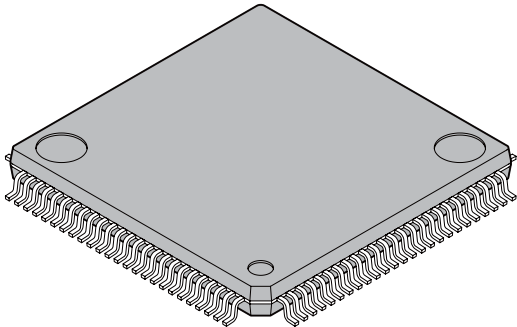
# MB95120MB Series

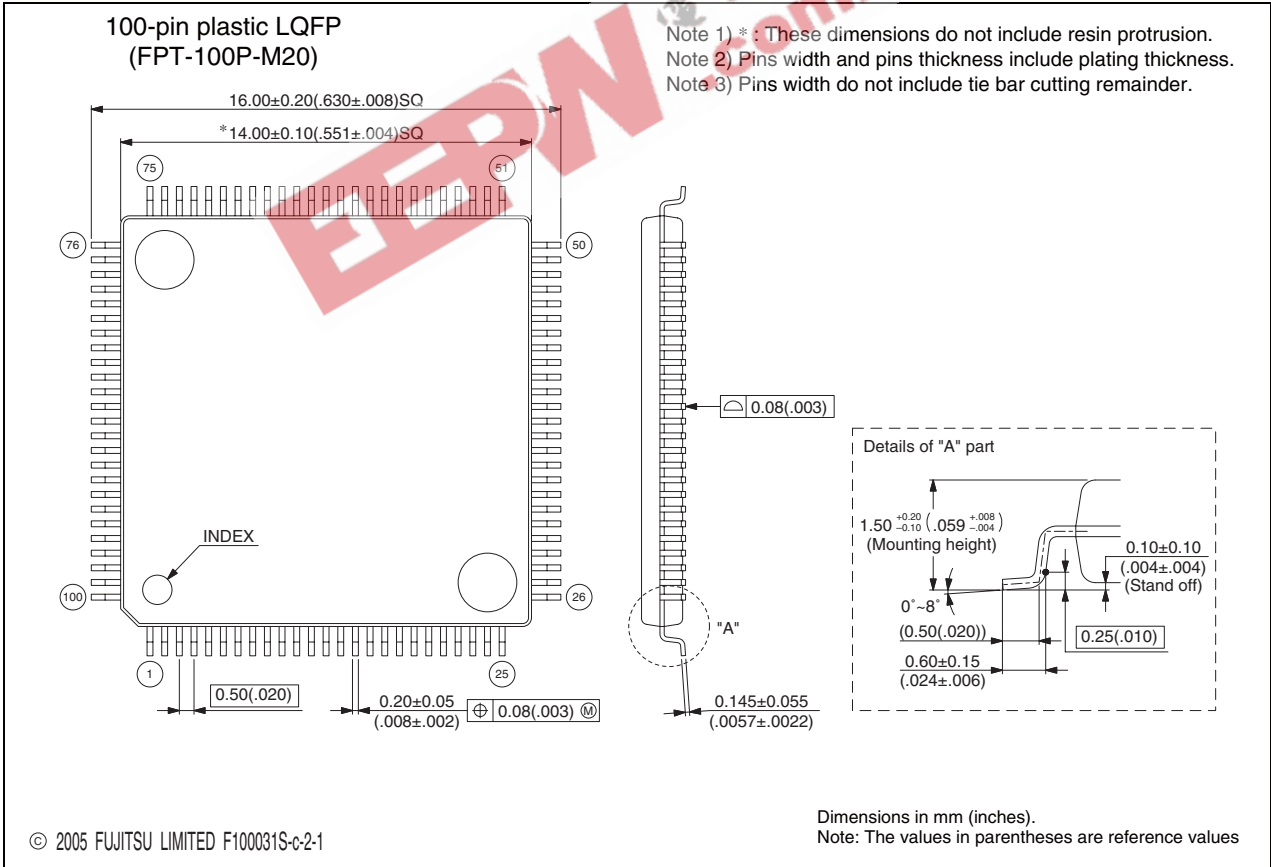
## ■ ORDERING INFORMATION

| Part number   | Package  |
|---|--|
| MB95128MBPMC<br>MB95F124MBPMC<br>MB95F124NBPMC<br>MB95F124JBPMC<br>MB95F126MBPMC<br>MB95F126NBPMC<br>MB95F126JBPMC<br>MB95F128MBPMC<br>MB95F128NBPMC<br>MB95F128JBPMC | 100-pin plastic LQFP<br>(FPT-100P-M20)                   |
| MB95128MBPF<br>MB95F124MBPF<br>MB95F124NBPF<br>MB95F124JBPF<br>MB95F126MBPF<br>MB95F126NBPF<br>MB95F126JBPF<br>MB95F128MBPF<br>MB95F128NBPF<br>MB95F128JBPF           | 100-pin plastic QFP<br>(FPT-100P-M06)                    |
| MB2146-303A<br>(MB95FV100D-103PBT)  | MCU board<br>( 224-pin plastic PFBGA )<br>(BGA-224P-M08) |

# MB95120MB Series

## PACKAGE DIMENSIONS

|   |                                |                       |
|---|--------------------------------|-----------------------|
| <p>100-pin plastic LQFP</p>  <p>(FPT-100P-M20)</p> | Lead pitch                     | 0.50 mm               |
|   | Package width × package length | 14.0 mm × 14.0 mm     |
|   | Lead shape                     | Gullwing              |
|   | Sealing method                 | Plastic mold          |
|   | Mounting height                | 1.70 mm Max           |
|   | Weight                         | 0.65 g                |
|   | Code (Reference)               | P-LFQFP100-14×14-0.50 |

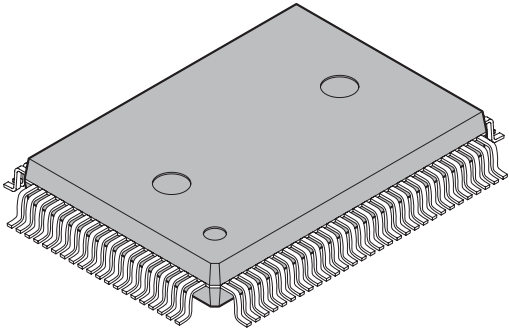


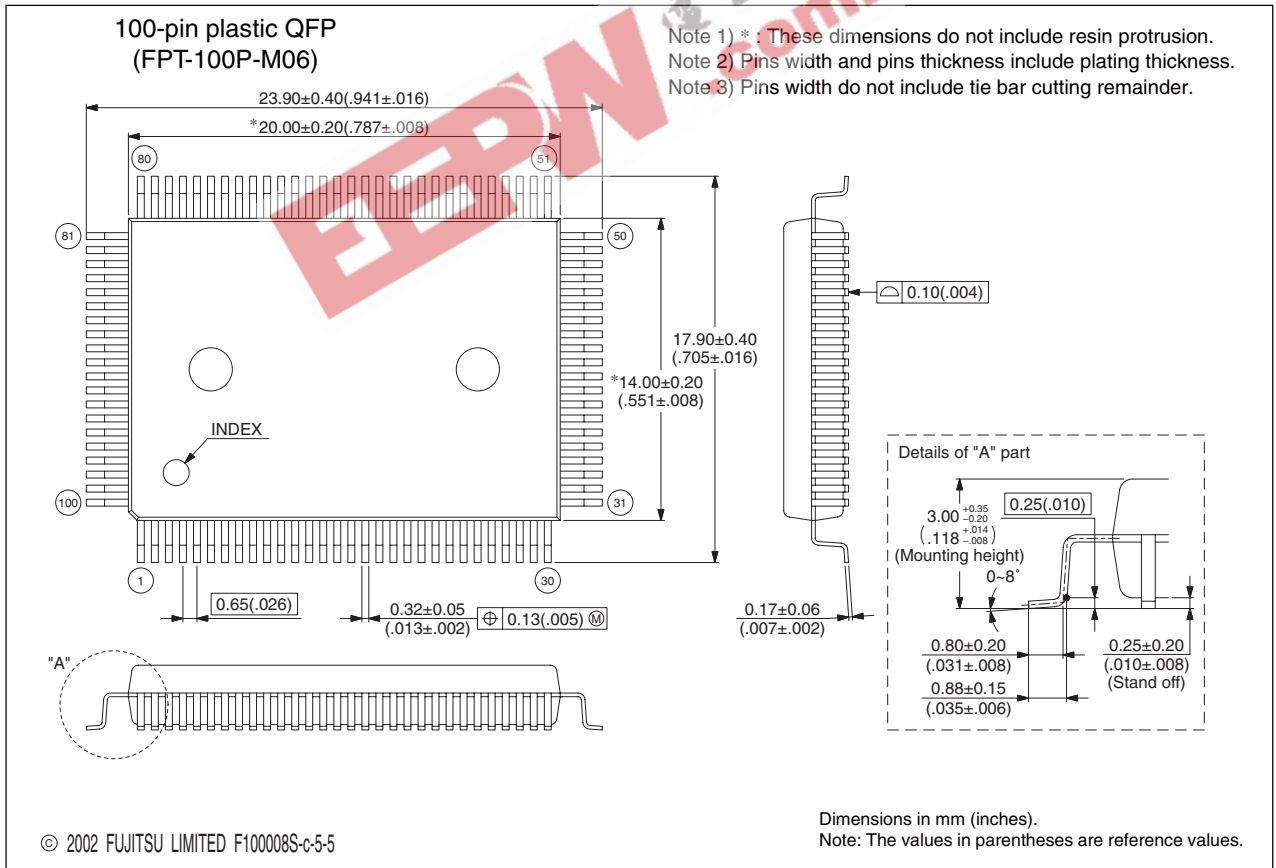
Please confirm the latest Package dimension by following URL.  
<http://edevice.fujitsu.com/package/en-search/>

(Continued)

# MB95120MB Series

(Continued)

|  |                                |                     |
|--|--------------------------------|---------------------|
|  <p>100-pin plastic QFP</p> <p>(FPT-100P-M06)</p> | Lead pitch                     | 0.65 mm             |
|  | Package width × package length | 14.00 × 20.00 mm    |
|  | Lead shape                     | Gullwing            |
|  | Sealing method                 | Plastic mold        |
|  | Mounting height                | 3.35 mm MAX         |
|  | Code (Reference)               | P-QFP100-14×20-0.65 |
|  |                                |                     |



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# MB95120MB Series

## ■ MAIN CHANGES IN THIS EDITION

| Page  | Section  | Change Results  |
|---|--|---|
| —   | —  | Added the MB95128MB (MASK ROM product)  |
| 26  | ■ I/O MAP  | Changed as follows for R/W of Reset source register<br>R → R/W  |
| 35  | ■ ELECTRICAL CHARACTERISTICS<br>1. Absolute Maximum Ratings            | For the operating temperature, the max rating is changed;<br>+ 85 °C → + 105 °C   |
| 37 to 42, 44,<br>47 to 51, 53,<br>55 to 57,<br>59 to 63 | Temperature conditions on table  | Changed as follows<br>$T_A = -40\text{ °C to }+85\text{ °C} \rightarrow T_A = -40\text{ °C to }+105\text{ °C}$  |
| 42  | ■ ELECTRICAL CHARACTERISTICS<br>4. AC Characteristics (1) Clock Timing | Added “Main PLL multiplied by 4” in the Clock frequency   |
| 44  | (2) Source Clock/Machine Clock   | <ul style="list-style-type: none"> <li>• Changed in the remarks of source clock cycle time (when using main clock)<br/>Min : <math>F_{CH} = 16.25\text{ MHz}</math>, PLL multiplied by 1<br/>→ Min : <math>F_{CH} = 8.125\text{ MHz}</math>, PLL multiplied by 2</li> <li>• Changed the footnote of *1;<br/>PLL multiplication of main clock (select from 1, 2, 2.5 multiplication) →<br/>PLL multiplication of main clock (select from 1, 2, 2.5, 4 multiplication)</li> <li>• Added “× 4” in the Main PLL of “• Outline of clock generation block”</li> </ul> |
| 45  |  | Changed as follows <ul style="list-style-type: none"> <li>• Operating voltage – Operating frequency (<math>T_A = -40\text{ °C to }+85\text{ °C}</math>) →</li> <li>• Operating voltage – Operating frequency (<math>T_A = -40\text{ °C to }+105\text{ °C}</math>)</li> </ul>  |
| 46  |  | Changed the figure of • Main PLL operation frequency  |
| 57  | (8) I <sup>2</sup> C Timing  | Added the *4  |
| 68 to 73  | ■ EXAMPLE CHARACTERISTICS  | Added the ■ EXAMPLE CHARACTERISTICS   |

The vertical lines marked in the left side of the page show the changes.

# FUJITSU MICROELECTRONICS LIMITED

Shinjuku Dai-Ichi Seimei Bldg. 7-1, Nishishinjuku 2-chome, Shinjuku-ku,  
Tokyo 163-0722, Japan Tel: +81-3-5322-3347 Fax: +81-3-5322-3387  
<http://jp.fujitsu.com/fml/en/>

*For further information please contact:*

## North and South America

FUJITSU MICROELECTRONICS AMERICA, INC.  
1250 E. Arques Avenue, M/S 333  
Sunnyvale, CA 94085-5401, U.S.A.  
Tel: +1-408-737-5600 Fax: +1-408-737-5999  
<http://www.fma.fujitsu.com/>

## Asia Pacific

FUJITSU MICROELECTRONICS ASIA PTE LTD.  
151 Lorong Chuan, #05-08 New Tech Park,  
Singapore 556741  
Tel: +65-6281-0770 Fax: +65-6281-0220  
<http://www.fujitsu.com/sg/services/micro/semiconductor/>

## Europe

FUJITSU MICROELECTRONICS EUROPE GmbH  
Pittlerstrasse 47, 63225 Langen,  
Germany  
Tel: +49-6103-690-0 Fax: +49-6103-690-122  
<http://emea.fujitsu.com/microelectronics/>

FUJITSU MICROELECTRONICS SHANGHAI CO., LTD.  
Rm.3102, Bund Center, No.222 Yan An Road(E),  
Shanghai 200002, China  
Tel: +86-21-6335-1560 Fax: +86-21-6335-1605  
<http://cn.fujitsu.com/fmc/>

## Korea

FUJITSU MICROELECTRONICS KOREA LTD.  
206 KOSMO TOWER, 1002 Daechi-Dong,  
Kangnam-Gu, Seoul 135-280  
Korea  
Tel: +82-2-3484-7100 Fax: +82-2-3484-7111  
<http://www.fmk.fujitsu.com/>

FUJITSU MICROELECTRONICS PACIFIC ASIA LTD.  
10/F., World Commerce Centre, 11 Canton Road  
Tsimshatsui, Kowloon  
Hong Kong  
Tel: +852-2377-0226 Fax: +852-2376-3269  
<http://cn.fujitsu.com/fmc/tw>

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